

# Low Power, 3-Channel, 24-Bit Analog Front End for Biopotential Measurements

Check for Samples: [ADS1293](#)

## FEATURES

- 3 High Resolution Digital ECG Channels with Simultaneous Pace Output
- EMI Hardened Inputs
- Low Power: 0.3mW/channel
- Input-Referred Noise: 7 $\mu$ Vpp (40Hz BW)
- Input Bias Current: 175pA
- Data Rate: Up to 25.6ksps
- Differential Input Voltage Range:  $\pm 400$ mV
- Analog Supply Voltage: 2.7V to 5.5V
- Digital I/O Supply Voltage: 1.65V to 3.6V
- Right Leg Drive Amplifier
- AC and DC Lead-Off Detection
- Wilson and Goldberger Terminals
- ALARM Pin for Interrupt Driven Diagnostics
- Battery Voltage Monitoring
- Built-In Oscillator and Reference
- Flexible Power-Down and Standby Modes

## APPLICATIONS

- Portable 1/2/3/5/6/7/8/12-Lead ECG
- Patient vital sign monitoring: holter, event, stress, and telemedicine
- Automated External Defibrillator
- Sports and fitness (heart rate and ECG)

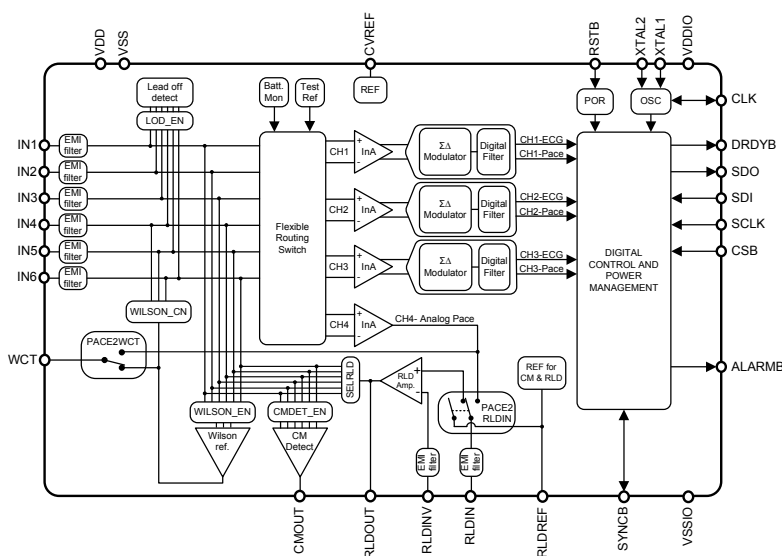
## DESCRIPTION

The ADS1293 incorporates all features commonly required in portable, low-power medical, sports and fitness electrocardiogram (ECG) applications. With high levels of integration and exceptional performance, the ADS1293 enables the creation of scalable medical instrumentation systems at significantly reduced size, power, and overall cost.

The ADS1293 features three high-resolution channels capable of operating up to 25.6ksps. Each channel can be independently programmed for a specific sample rate and bandwidth allowing users to optimize the configuration for performance and power. All input pins incorporate an EMI filter and can be routed to any channel via a flexible routing switch. Flexible routing also allows independent lead-off detection, right leg drive, and Wilson/Goldberger reference terminal generation without the need to reconnect leads externally. A fourth channel allows external analog pace detection for applications that do not utilize digital pace detection.

The ADS1293 incorporates a self-diagnostics alarm system to detect when the system is out of the operating conditions range. Such events are reported to error flags. The overall status of the error flags is available as a signal on a dedicated ALARMB pin.

The device is packaged in a 5-mm  $\times$  5-mm  $\times$  0.8-mm, 28-pin LLP. Operating temperature ranges from  $-20^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

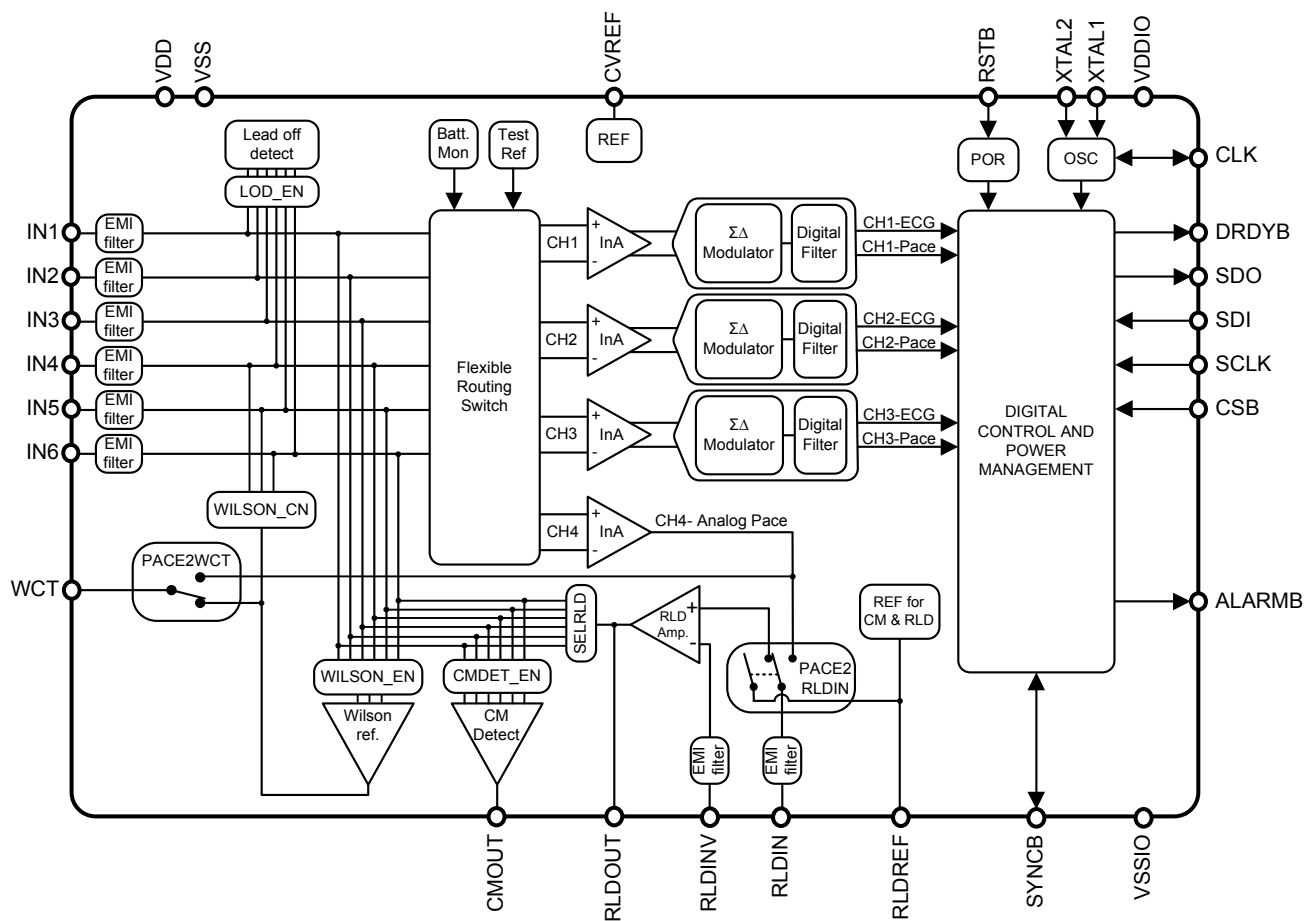


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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

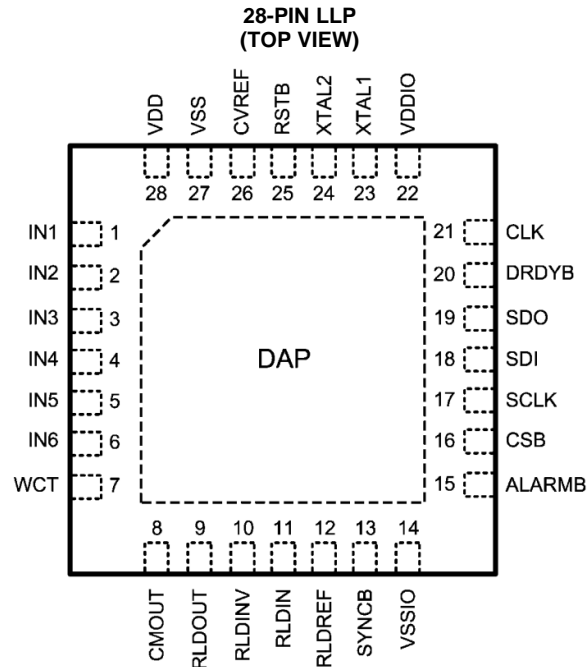
## BLOCK DIAGRAM



**Table 1. ORDERING INFORMATION**

PACKAGE	PART NUMBER	PACKAGE MARKING	TRANSPORT MEDIA	TI DRAWING
28-Pin LLP	ADS1293CISQ	U2XYTT	1k Units Tape and Reel	SQA28A
	ADS1293CISQx		4.5k Units Tape and Reel	

## CONNECTION DIAGRAM



**Table 2. PIN DESCRIPTIONS**

PIN		TYPE	FUNCTION
NO.	NAME		
1 - 6	IN1 - IN6	Analog Input	Electrode input signals
7	WCT	Analog Output	Wilson reference output or analog pace channel output
8	CMOUT	Output	Common-mode detector output
9	RLDOUT	Analog Output	Right leg drive amplifier output
10	RLDINV	Analog Input	Right leg drive amplifier negative input
11	RLDIN	Analog I/O	Right leg drive amplifier positive input or analog pace channel output
12	RLDREF	Analog Output	Internal right leg drive reference
13	SYNCB	Digital I/O	Sync bar; multiple-chip synchronization signal input or output
14	VSSIO	Digital Supply	Digital input/output supply ground
15	ALARMB	Digital Output	Alarm bar
16	CSB	Digital Input	Chip select bar
17	SCLK	Digital Input	Serial clock
18	SDI	Digital Input	Serial data input
19	SDO	Digital Output	Serial data output
20	DRDYB	Digital Output	Data ready bar
21	CLK	Digital I/O	Internal clock output or external clock input
22	VDDIO	Digital Supply	Digital input/output supply
23	XTAL1	Digital Input	External crystal for clock oscillator
24	XTAL2	Digital Input	External crystal for clock oscillator
25	RSTB	Digital Input	Reset bar
26	CVREF	Analog I/O	External cap for internal reference voltage
27	VSS	Analog Supply	Power supply ground
28	VDD	Analog Supply	Positive power supply
	DAP		No connect

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/Distributors for availability and specifications.

		VALUES		UNITS
		MIN	MAX	
ESD Tolerance <sup>(2)</sup>	Human Body Model (HBM) For input pins only		1000	V
	Charge Device Model (CDM)		500	V
Analog Supply Voltage, VDD		–0.3	6.0	V
Digital Supply Voltage, VDDIO		–0.3	6.0	V
Voltage on any Input Pin		–0.3 to (VDD + 0.3)		V
Input Current at Any Pin			±10	mA
Storage Temperature Range		–60	150	°C
Max Junction Temperature <sup>(3)</sup>			150	°C

- (1) “Absolute Maximum Ratings” indicate limits beyond which damage to the device may occur, including inoperability and degradation of the device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified.
- (2) Human Body Model per MIL-STD-883, Method 3015.7. Machine Model, per JESD22-A115-A. Field-Induced Charge-Device Model, per JESD22-C101-C.
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{J(MAX)}$ ,  $\theta_{JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation  $P_{DMAX} = (T_{J(MAX)} - T_A) / \theta_{JA}$  or the number given in Absolute Maximum Ratings, whichever is lower.

## RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	Units
Analog Supply Voltage, VDD		2.7	5.5	V
Digital I/O Supply Voltage	VDD > 3.6V	1.65	3.6	V
	VDD ≤ 3.6V	1.65	VDD	V
Supply Ground		VSS = VSSIO		
Full Scale Differential Input Voltage Range, DIVR			±400	mV
Temperature Range <sup>(1)</sup>		–20	85	°C
Typical Package Thermal Resistance <sup>(1)</sup> , 28-Pin LLP ( $\theta_{JA}$ )		29		°C/W

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## ELECTRICAL CHARACTERISTICS<sup>(1)</sup>

Unless otherwise noted, all limits are specified at  $T_A = +25^\circ\text{C}$ ,  $+2.7\text{V} \leq \text{VDD} \leq +5.5\text{V}$ ,  $+1.65\text{V} \leq \text{VDDIO} \leq \text{MIN}(+3.6\text{V}, \text{VDD})$ ,  $\text{VREF} = +2.4\text{V}$ ,  $f_{\text{OSC}} = 409.6\text{kHz}$ ,  $1\mu\text{F}$  low ESR capacitor between CVREF and GND,  $0.1\mu\text{F}$  capacitor between RLDREF and GND. **Boldface** limits apply for  $T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$ .

PARAMETER		TEST CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
<b>POWER SUPPLY (VDD, VDDIO)</b>						
VDD	Analog Supply Voltage		<b>2.7</b>		<b>5.5</b>	V
IVDD	Analog Supply Current	Power-down mode		80	<b>125</b>	$\mu\text{A}$
		Stand-by mode		120	<b>175</b>	$\mu\text{A}$
		1 chan, WILSON OFF, RLD OFF, CMDET OFF, LOD OFF, low power		205	<b>290</b>	$\mu\text{A}$
		1 chan, WILSON OFF, RLD OFF, CMDET OFF, LOD OFF, high-res		335	<b>490</b>	
		3 chan, WILSON OFF, RLD OFF, CMDET OFF, LOD OFF, low power		350	<b>520</b>	
		3 chan, WILSON ON, RLD ON, CMDET ON, LOD ON, low power, low cap-drive		440	<b>595</b>	
		3 chan, WILSON ON, RLD ON, CMDET ON, LOD ON, high-res, low cap-drive		835	<b>1120</b>	
		3 chan, WILSON ON, RLD ON, CMDET ON, LOD ON, high-res, high cap-drive		960	<b>1300</b>	
VDDIO	IO Supply Voltage	$\text{VDD} > 3.6\text{V}$	<b>1.65</b>		<b>3.6</b>	V
		$\text{VDD} \leq 3.6\text{V}$	<b>1.65</b>		<b>VDD</b>	V
IVDDIO	Quiescent Current IO Supply			0.6		$\mu\text{A}$
<b>ANALOG INPUTS (IN1-IN6)</b>						
$I_B$	Input Bias Current	$T_A = 25^\circ\text{C}$ , LOD OFF			$\pm 175$	pA
		$T_A = 85^\circ\text{C}$ , LOD OFF			<b><math>\pm 13</math></b>	nA
RIN	Differential Input Resistance			500		M $\Omega$

- (1) The Electrical Characteristics table lists specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.
- (2) Datasheet min/max specification limits are specified by test, unless otherwise noted.
- (3) Typical values represent the most likely parameter norms at  $T_A = 25^\circ\text{C}$  and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

**ELECTRICAL CHARACTERISTICS<sup>(1)</sup> (continued)**

Unless otherwise noted, all limits are specified at  $T_A = +25^\circ\text{C}$ ,  $+2.7\text{V} \leq \text{VDD} \leq +5.5\text{V}$ ,  $+1.65\text{V} \leq \text{VDDIO} \leq \text{MIN}(+3.6\text{V}, \text{VDD})$ ,  $\text{VREF} = +2.4\text{V}$ ,  $f_{\text{OSC}} = 409.6\text{kHz}$ ,  $1\mu\text{F}$  low ESR capacitor between CVREF and GND,  $0.1\mu\text{F}$  capacitor between RLDREF and GND. **Boldface** limits apply for  $T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$ .

PARAMETER		TEST CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
<b>ANALOG FRONT END</b>						
DIVR	Differential Input Voltage Range		<b>-400</b>		<b>400</b>	mV
CMVR	Common-Mode Voltage Range for full DIVR		<b>0.95</b>		<b>VDD-0.95</b>	V
V <sub>OS</sub>	Input-Referred Offset Voltage			$\pm 16$	<b><math>\pm 87</math></b>	$\mu\text{V}$
CMRR	Common-Mode Rejection Ratio	50 / 60Hz, $\text{VCM}_{\text{DC}} = \text{RLDREF}$ , $\text{VCM}_{\text{AC}} = 1.2\text{V}_{\text{PP}}$		100		dB
V <sub>e</sub> -ECG	Input-Referred Voltage Noise for ECG <sup>(4)</sup>	0.1 - 215Hz, low power mode		23	<b>30.5</b>	$\mu\text{V}_{\text{PP}}$
		0.1 - 215Hz, high resolution mode		15	<b>23.95</b>	
		0.1 - 40Hz, low power mode		10	<b>23.1</b>	
		0.1 - 40Hz, high resolution mode		7	<b>10.3</b>	
V <sub>e</sub> -PACE	Input-Referred Voltage Noise for Pace	1 - 1280Hz, high resolution mode, double pace data rate		0.4		$\text{mV}_{\text{PP}}$
N <sub>e</sub>	Input-Referred Noise Density	0.1 - 215Hz, low power mode		240	<b>315</b>	$\text{nV}/\sqrt{\text{Hz}}$
		0.1 - 215Hz, high resolution mode		155	<b>250</b>	
PSRR	Power Supply Rejection Ratio	50 / 60Hz		94		dB
XTLK	Crosstalk between channels	Crosstalk from driven channel to zero input channel		-105		dB
ENOB-ECG	Effective Number of Bits for ECG	215Hz bandwidth, low power mode	<b>17.4</b>	17.8		bits
		215Hz bandwidth, high resolution mode	<b>17.8</b>	18.4		bits
ENOB-PACE	Effective Number of Bits for Pace	1280Hz bandwidth, high resolution mode, double pace data rate		13.7		bits
RS-ECG	Sample Rate ECG Channel	See <a href="#">Table 5</a> , <a href="#">Table 6</a> , <a href="#">Table 7</a> and <a href="#">Table 8</a>	<b>25</b>		<b>6400</b>	sps
RS-PACE	Sample Rate PACE Channel		<b>3.2</b>		<b>25.6</b>	ksps
TSKEW	Sample Time Skew Between Channels	Multichip simultaneous sampling architecture		0		$\mu\text{s}$
<b>INTERNAL REFERENCE (REF)</b>						
V <sub>REF</sub>	Internal Reference Voltage			2.4		V
	Internal Reference Accuracy			$\pm 0.5$		%
	Internal Reference Drift			$\pm 11$		$\text{ppm}/^\circ\text{C}$
	Internal Reference Start-up Time			5		ms
<b>BATTERY MONITOR</b>						
Division	$(\text{VDD}-\text{V}_{\text{REF}})/\text{factor}$			3.246		V/V
	Division Accuracy			$\pm 0.25$		%
<b>TEST REFERENCE</b>						
	$(\text{V}_{\text{REF}}-\text{VSS})/\text{factor}$			12		V/V
	Division Accuracy			$\pm 0.1$		%
	Current Consumption			3.5		$\mu\text{A}$

(4) At least 1000 consecutive readings are used to calculate the peak-to-peak noise in production.

## ELECTRICAL CHARACTERISTICS<sup>(1)</sup> (continued)

Unless otherwise noted, all limits are specified at  $T_A = +25^{\circ}\text{C}$ ,  $+2.7\text{V} \leq \text{VDD} \leq +5.5\text{V}$ ,  $+1.65\text{V} \leq \text{VDDIO} \leq \text{MIN}(+3.6\text{V}, \text{VDD})$ ,  $\text{VREF} = +2.4\text{V}$ ,  $f_{\text{OSC}} = 409.6\text{kHz}$ ,  $1\mu\text{F}$  low ESR capacitor between CVREF and GND,  $0.1\mu\text{F}$  capacitor between RLDREF and GND. **Boldface** limits apply for  $T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$ .

PARAMETER		TEST CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
RIGHT LEG DRIVE AMPLIFIER (RLD Amp)						
V <sub>OS</sub>	Input-Referred Offset Voltage			±5		mV
CMVR	Common-Mode Voltage Range		0.5		VDD-0.5	V
GBW	Programmable Gain Bandwidth	Low bandwidth mode		50		kHz
		High bandwidth mode		200		kHz
SR	Slew Rate	Low bandwidth mode		25		mV/μs
		High bandwidth mode		90		mV/μs
C <sub>I</sub> MAX	Programmable Capacitive Load Driving Capability	High bandwidth, Low cap-drive mode (see <a href="#">Table 11</a> )		400		pF
		Low bandwidth, High cap-drive mode (see <a href="#">Table 11</a> )		8		nF
IVDD	Quiescent Power Consumption	Low bandwidth, Low cap-drive mode		20	36	μA
		High bandwidth, High cap-drive mode		60	91	μA
RIGHT LEG DRIVE REFERENCE						
RLD <sub>REF</sub>	Output Voltage	Unloaded		(VDD-VSS)/2.2		V
COMMON-MODE DETECTOR AMPLIFIER (CMDET Amp)						
CMVR	Common-Mode Voltage Range		0.5		VDD-0.5	V
BW	Programmable Bandwidth	Low bandwidth mode		50		kHz
		High bandwidth mode		150		kHz
SR	Slew Rate	Low bandwidth mode		25		mV/μs
		High bandwidth mode		90		mV/μs
C <sub>I</sub> MAX	Programmable Capacitive Load Driving Capability	High bandwidth mode, Low capdrive mode (see <a href="#">Table 10</a> )		400		pF
		Low bandwidth mode, High cap- drive mode (see <a href="#">Table 10</a> )		8		nF
IVDD	Power Consumption (Selected Leads)	N leads, low bandwidth mode, low cap-drive mode		21+3*N		μA
		N leads, high bandwidth mode, high cap-drive mode		61+3*N		μA
WILSON REFERENCE CIRCUIT						
IVR	Input Voltage Range		0.5		VDD-0.5	V
BW	Bandwidth	3 buffers ON		50		kHz
SR	Slew Rate	3 buffers ON		45		mV/μs
N <sub>e</sub>	Noise Density	At 10Hz		60		nV/√Hz
V <sub>e</sub>	Input-Referred Noise for Wilson Reference Amp	0.1 - 200Hz, 3 buffers ON		5.5		μV <sub>PP</sub>
IVDD	Power Consumption (Selected Leads)	N leads, low power mode		7*N		μA
LEAD OFF DETECTION						
IEXC	Excitation Current	Programmable: Min. code 0x01 (See <a href="#">LEAD-OFF DETECTION (LOD)</a> )		8		nA
		Programmable: Max. code 0xFF (See <a href="#">LEAD-OFF DETECTION (LOD)</a> )		2040		nA
IEXC <sub>TOL</sub>	Excitation Current Accuracy			25		%
FEXC	Excitation Frequency	AC LOD mode, programmable, minimum (see <a href="#">Analog AC Lead-Off Detect</a> )		6.1		Hz
		AC LOD mode, programmable, maximum (see <a href="#">Analog AC Lead-Off Detect</a> )		12.5		kHz
VTH <sub>DC</sub>	DC Lead Off Comparator Threshold			VDD - 0.5		V
V <sub>HYST</sub>	Comparator Hysteresis	DC lead off mode		55		mV
IVDD	Current Consumption	Programmed excl. excitation current		25		μA

**ELECTRICAL CHARACTERISTICS<sup>(1)</sup> (continued)**

Unless otherwise noted, all limits are specified at  $T_A = +25^\circ\text{C}$ ,  $+2.7\text{V} \leq \text{VDD} \leq +5.5\text{V}$ ,  $+1.65\text{V} \leq \text{VDDIO} \leq \text{MIN}(+3.6\text{V}, \text{VDD})$ ,  $\text{VREF} = +2.4\text{V}$ ,  $f_{\text{OSC}} = 409.6\text{kHz}$ ,  $1\mu\text{F}$  low ESR capacitor between CVREF and GND,  $0.1\mu\text{F}$  capacitor between RLDREF and GND. **Boldface** limits apply for  $T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$ .

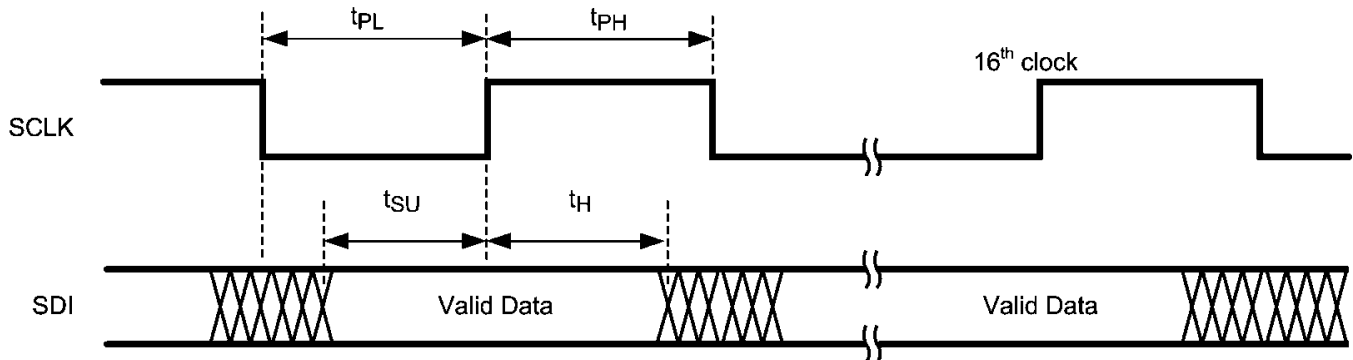
PARAMETER		TEST CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
<b>ANALOG PACE CHANNEL</b>						
	Gain			3.5		V/V
BW	-3dB Bandwidth			50		kHz
	Output Reference			RLDREF		V
$V_{\text{OS}}$	Input-Referred Offset Voltage			$\pm 1.3$		mV
DIVR	Differential Input Voltage Range	$2.7\text{V} \leq \text{VDD} < 3.3\text{V}$	<b>-330</b>		<b>330</b>	mV
		$3.3\text{V} \leq \text{VDD}$	<b>-400</b>		<b>400</b>	mV
CMVR	Common-Mode Voltage Range for full DIVR		<b>0.95</b>		<b>VDD - 1.1</b>	V
CMRR	Common-Mode Rejection Ratio	$0.5\text{V} \leq \text{VCM} \leq \text{VDD} - 1.5\text{V}$		85		dB
PSRR	Power Supply Rejection Ratio	$3\text{V} \leq \text{VDD} \leq 5\text{V}$ , $\text{VCM} = \text{RLDREF}$		80		dB
SR	Slew Rate			35		mV/ $\mu\text{s}$
	Overload Recovery			100		$\mu\text{s}$
$V_{\text{e-APACE}}$	Input-Referred Noise for Analog Pace	$\text{VCM} = \text{RLDREF}$ , $0.1\text{kHz} - 20\text{kHz}$		105		$\mu\text{V}_{\text{PP}}$
IVDD	Current Consumption			29		$\mu\text{A}$
<b>CLOCK</b>						
$f_{\text{OSC}}$	Internal Clock Frequency	$f_{\text{CRYSTAL}} = 4.096\text{MHz}$		409.6		kHz
	Internal Clock Duty Cycle			50		%
TSTART	Internal Clock Start up Time	$f_{\text{CRYSTAL}} = 4.096\text{MHz}$		15		ms
IVDD	Internal Clock Power Consumption			83		$\mu\text{A}$
$f_{\text{EXT}}$	External Clock Frequency <sup>(5)</sup>		<b>370</b>	409.6	<b>450</b>	kHz
	External Clock Duty Cycle <sup>(5)</sup>		<b>40%</b>	50%	<b>60%</b>	
<b>DIGITAL INPUT/OUTPUT CHARACTERISTICS</b>						
$V_{\text{IH}}$	Logical "1" Input Voltage		<b>0.8x VDDIO</b>			V
$V_{\text{IL}}$	Logical "0" Input Voltage			<b>0.2x VDDIO</b>		V
$V_{\text{OH}}$	Logical "1" Output Voltage	$I_{\text{SOURCE}} = 400\mu\text{A}$ , Digital output high drive mode	<b>VDDIO - 0.075</b>			V
		$I_{\text{SOURCE}} = 400\mu\text{A}$ , Digital output low drive mode	<b>VDDIO - 0.15</b>			
$V_{\text{OL}}$	Logical "0" Output Voltage	$I_{\text{SINK}} = 400\mu\text{A}$ Digital output high drive mode		<b>VSSIO + 0.075</b>		V
		$I_{\text{SINK}} = 400\mu\text{A}$ Digital output low drive mode		<b>VSSIO + 0.15</b>		V
$I_{\text{IOHL}}$	Digital IO Leakage Current	SYNCB and RESETB pins, with $1\text{M}\Omega$ internal pull-up resistor		$\pm 1$		$\mu\text{A}$
		Other digital I/O pins		<b><math>\pm 500</math></b>		nA

(5) Specified by design; not production tested.



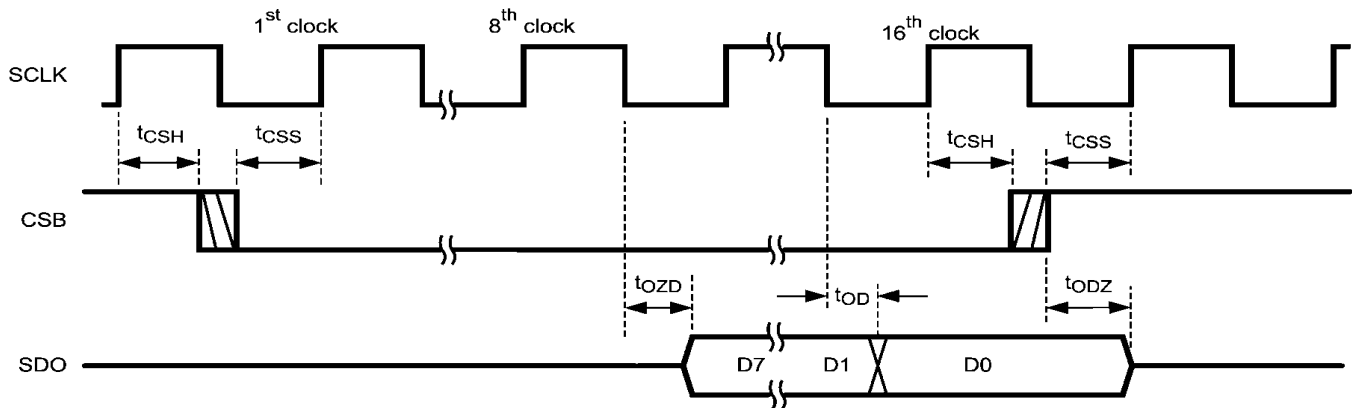
## TIMING DIAGRAMS

Unless otherwise noted, all limits specified at  $T_A = 25^\circ\text{C}$ ,  $+2.7\text{V} \leq V_{DD} \leq +5.5\text{V}$ ,  $+1.65 \leq V_{DDIO} \leq \text{MIN}(+3.6\text{V}, V_{DD})$ ,  $V_{REF} = +2.4\text{V}$ ,  $f_{OSC} = 409.6\text{kHz}$  and a  $10\text{pF}$  capacitive load in parallel with a  $10\text{k}\Omega$  load on SDO.



**Figure 1. Write Timing Diagram**

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNITS
$F_{SCLK}$	Serial Clock Frequency				20	MHz
$t_{PH}$	SCLK Pulse Width - High	$F_{SCLK} = 20\text{MHz}$	$0.4/F_{SCLK}$			s
$t_{PL}$	SCLK Pulse Width - Low	$F_{SCLK} = 20\text{MHz}$	$0.4/F_{SCLK}$			s
$t_{SU}$	SDI Setup Time		5			ns
$t_H$	SDI Hold Time		5			ns



**Figure 2. Read Timing Diagram**

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNITS
$t_{ODZ}$	SDO Driven-to-Tristate Time	Measured at 10% / 90% point			15	ns
$t_{OZD}$	SDO Tristate-to-Driven Time	Measured at 10% / 90% point			15	ns
$t_{OD}$	SDO Output Delay Time				10	ns
$t_{CSS}$	CSB Setup Time		5			ns
$t_{CSH}$	CSB Hold Time		5			ns
$t_{IAG}$	Inter-Access Gap		10			ns
$t_{DRDYB}$	Data Ready Bar at every 1/ODR second, see <a href="#">Figure 25</a>			$4/f_{OSC}$		s

## TYPICAL CHARACTERISTICS

All plots at  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = +3.3\text{V}$ ,  $V_{DDIO} = +1.8\text{V}$ ,  $V_{SS} = V_{SSIO} = 0\text{V}$ , internal  $V_{REF} = +2.4\text{V}$ ,  $V_{CM} = \text{RLDREF}$ , internal  $f_{OSC} = 409.6\text{kHz}$ , data rate = 1067sps, and High-Resolution mode, unless otherwise noted.

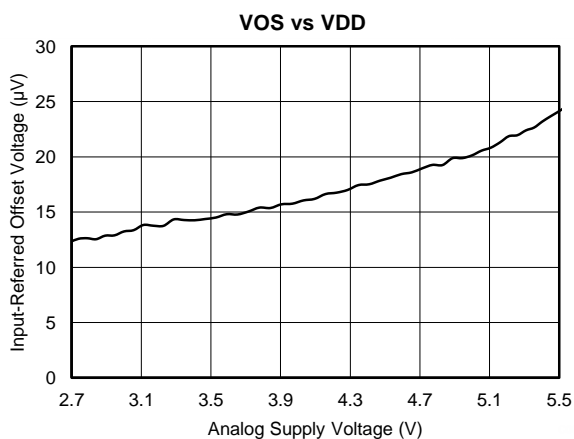


Figure 3.

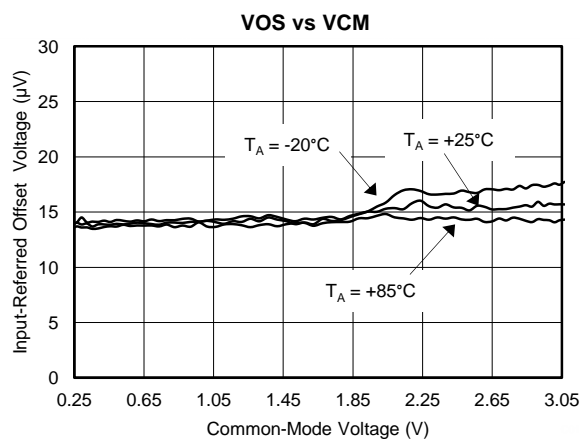


Figure 4.

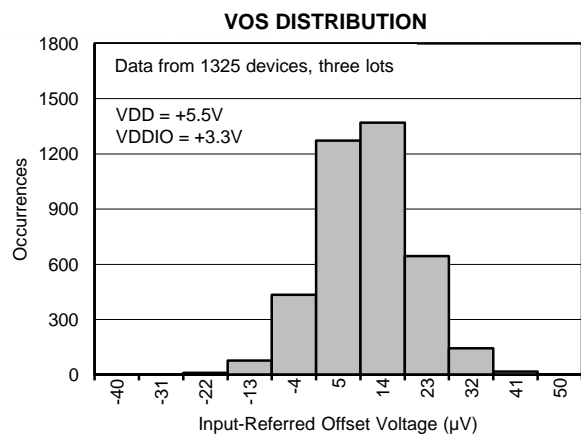


Figure 5.

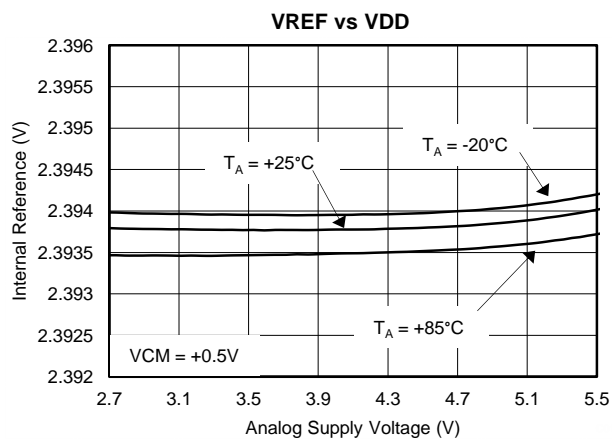


Figure 6.

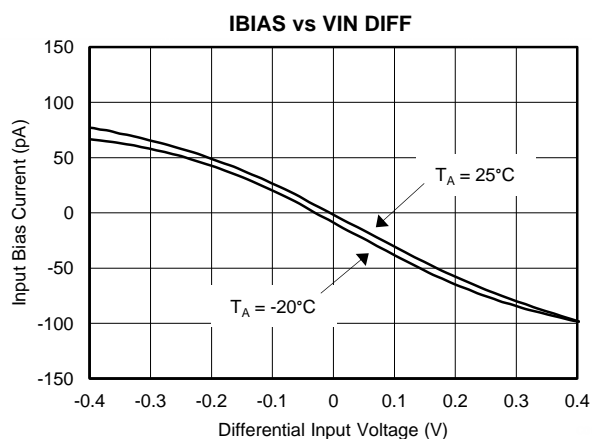


Figure 7.

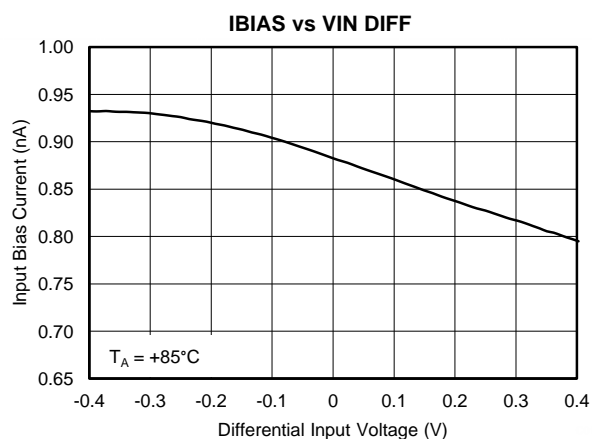


Figure 8.

## TYPICAL CHARACTERISTICS (continued)

All plots at  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = +3.3\text{V}$ ,  $V_{DDIO} = +1.8\text{V}$ ,  $V_{SS} = V_{SSIO} = 0\text{V}$ , internal  $V_{REF} = +2.4\text{V}$ ,  $V_{CM} = \text{RLDREF}$ , internal  $f_{\text{OSC}} = 409.6\text{kHz}$ , data rate = 1067sps, and High-Resolution mode, unless otherwise noted.

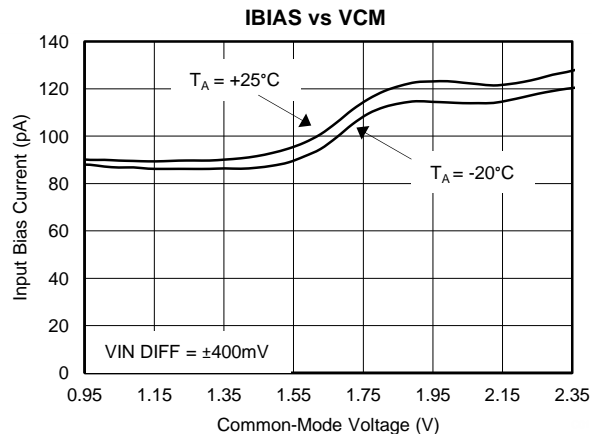


Figure 9.

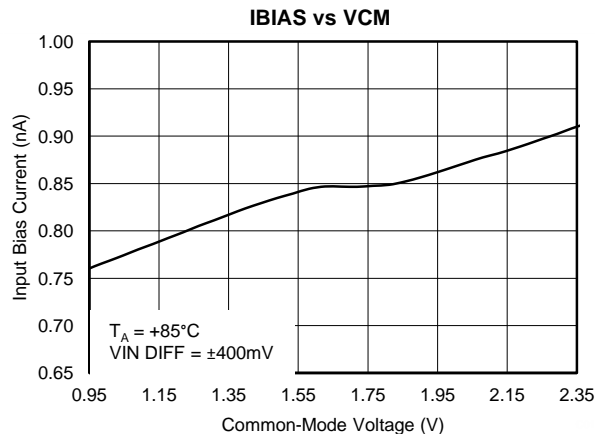


Figure 10.

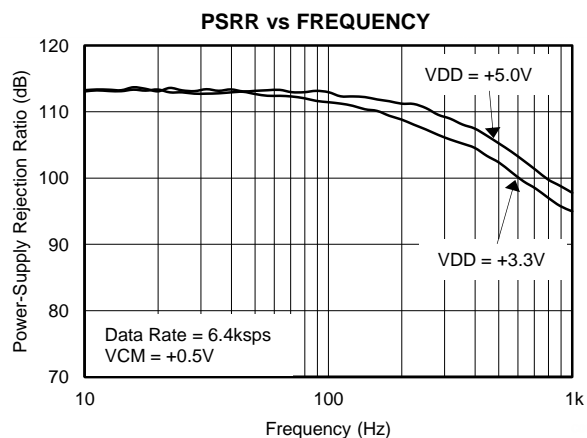


Figure 11.

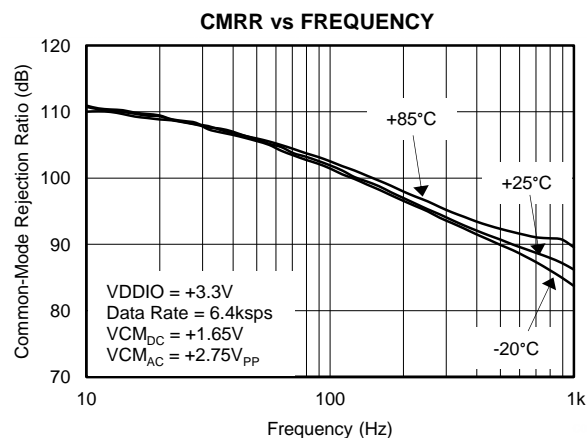


Figure 12.

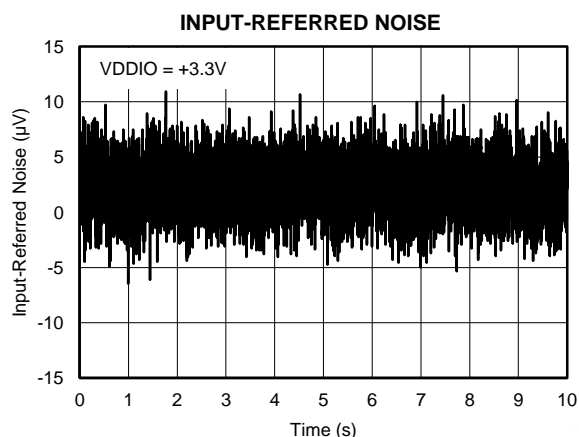


Figure 13.

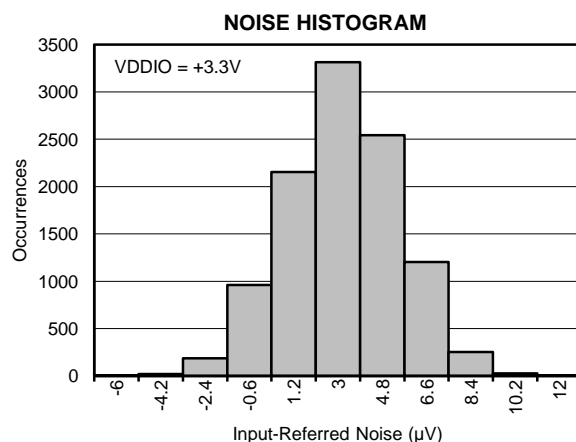


Figure 14.

### TYPICAL CHARACTERISTICS (continued)

All plots at  $T_A = +25^\circ\text{C}$ ,  $V_{DD} = +3.3\text{V}$ ,  $V_{DDIO} = +1.8\text{V}$ ,  $V_{SS} = V_{SSIO} = 0\text{V}$ , internal  $V_{REF} = +2.4\text{V}$ ,  $V_{CM} = \text{RLDREF}$ , internal  $f_{\text{OSC}} = 409.6\text{kHz}$ , data rate = 1067sps, and High-Resolution mode, unless otherwise noted.

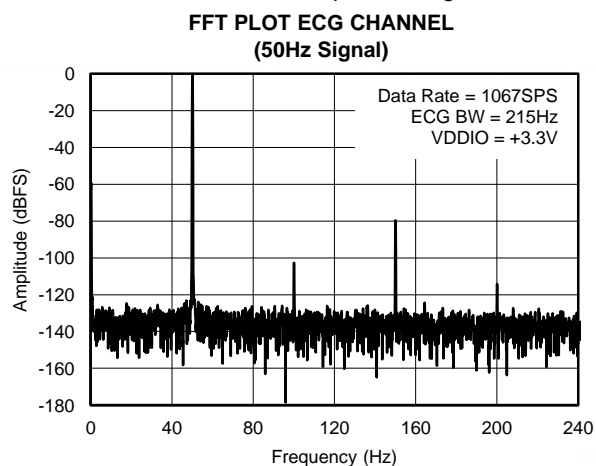


Figure 15.

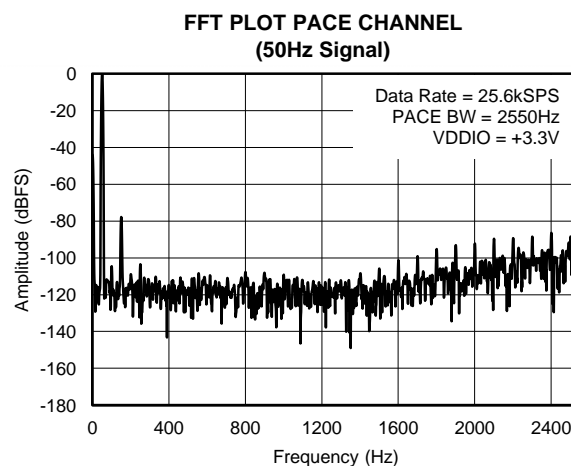


Figure 16.

## FUNCTIONAL DESCRIPTION

The ADS1293 is a fully integrated signal chain for ECG applications. It features three low-power, 24-bit resolution channels for ECG and pace monitoring and an auxiliary fourth channel for analog pace detection. In addition, the ADS1293 features AC and DC lead-off detection, right leg drive capability, and Wilson and Goldberger terminals.

Each of the three channels is synchronized and provides digital filtering with a cut-off frequency that is programmable from 5Hz to 1280Hz. Each channel filter can be set independently while maintaining synchronization. In addition, a lower resolution output is provided for each signal channel with a cut-off frequency programmable between 650Hz to 2.6kHz. These output signals are ideal for sensing a pace-maker signal. Each channel provides enough dynamic range to handle electrode offset and motion artifacts without sacrificing resolution. Each input has built-in EMI rejection that eliminates noise from RF transmitters.

## FLEXIBLE ROUTING SWITCH

The flexible routing switch can connect the inputs of the three analog front end channels as well as the inputs of the analog pace channel to any of the 6 input pins. This allows system flexibility and even on-the-fly reconfiguration of the ECG monitoring system. For test purposes, the flexible routing switch can short the differential input pins of a channel or connect a differential reference signal to the input of a channel. This reference voltage can be applied with both positive and negative polarity. This feature allows to measure relative mismatches between channels, such as offset and gain mismatches. Additionally, there is an option to route a fraction of the battery voltage (the voltage source connected to the VDD pin) to an input channel. This allows the ADS1293 to monitor the state of charge of the battery.

The switch path inside the flexible routing switch is illustrated in [Figure 17](#). The figure shows the switch path for a single channel. All channels are completely identical. The switches are controlled by the registers FLEX\_CH1\_CN, FLEX\_CH2\_CN, FLEX\_CH3\_CN, and FLEX\_VBAT\_CN, which are described in the [Input Channel Selection Registers](#).

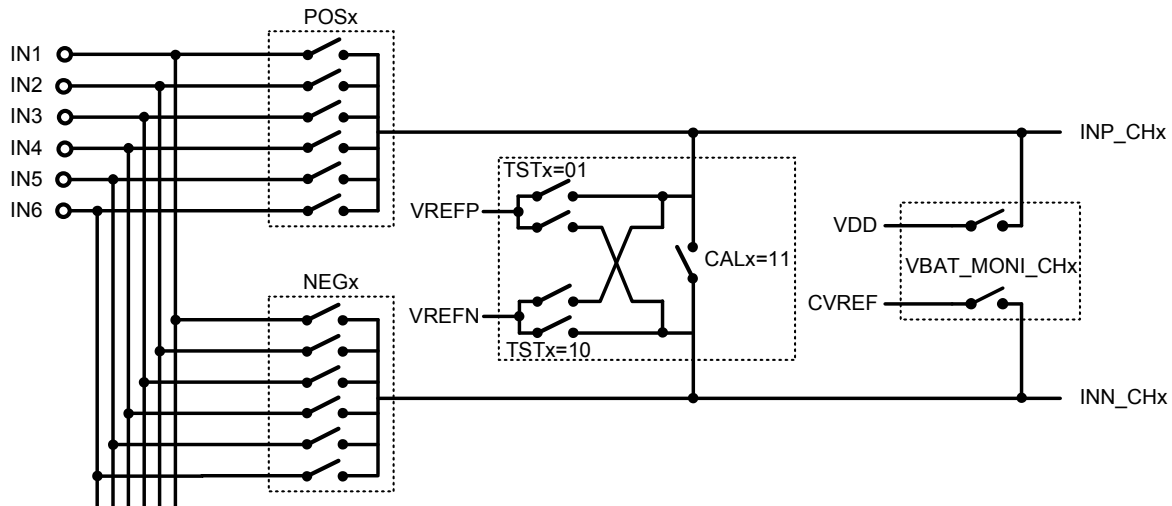


Figure 17. Flexible Routing Switch for Channel 1

It should be noted that the switches that control the input selection for the analog front end channels have a certain priority. If the battery voltage monitoring mode is enabled by programming the VBAT\_MONI\_CHx bit in the FLEX\_VBAT\_CN register, then the POSx and NEGx bits programmed in the FLEX\_CHx\_CN register no longer have any effect. The battery voltage monitoring mode thus takes priority; this is shown in the first row of [Table 3](#). Furthermore, the test features take second priority over the input pin selection. If the TSTx bit of the FLEX\_CHx\_CN register are not zero, then the POSx and NEGx bits are essentially ignored, and the test features will take priority as seen in [Table 3](#). The TSTx, POSx, and NEGx bits are described in the [Input Channel Selection Registers](#).

**Table 3. Channel 1 Switch Configuration**

VBAT_MONI_CHx	CALx	POSx	NEGx	Mode
1	X	X	X	CHx is in battery voltage monitoring mode
0	11	X	X	CHx input shorted
0	01	X	X	CHx input connected to positive reference
0	10	X	X	CHx input connected to negative reference
0	00	INx	INy	CHx positive input connected to pin INx and negative input connected to pin INy

### Battery Monitoring

The battery voltage monitoring mode is enabled by setting bit VBAT\_MONI\_CHx = 1 in the [FLEX\\_VBAT\\_CN](#) register. Also, the instrumentation amplifier of the selected channel must be shut down by setting SHDN\_INA\_CHx = 1 in the [AFE\\_SHDN\\_CN](#) register. In this mode, the positive input, POSx, of the sigma delta modulator will sample the voltage supplied on the VDD pin. At the same time, the negative input, NEGx, of the sigma delta modulator will sample the reference voltage, V<sub>REF</sub>, generated on or provided to the CVREF pin. As a result, the output signal of the sigma delta modulator is a measure for (V<sub>BAT</sub> - V<sub>REF</sub>). In this operation, the sigma delta modulator works with a modified gain factor, and the battery voltage, V<sub>BAT</sub>, can be calculated as follows:

$$V_{BAT} = V_{REF} \left[ 1 + 3.246 \left( \frac{ADC_{OUT}}{ADC_{MAX}} - \frac{1}{2} \right) \right] \quad (1)$$

In this equation, V<sub>REF</sub> equals 2.4V if the internal reference voltage generator is used, and ADC<sub>MAX</sub> represents the maximum output code of the ADC, which would correspond to a theoretical 2.4V signal at the input of the sigma delta modulator. The value of ADC<sub>MAX</sub> is dependent on the configuration of the digital filters, and the corresponding ADC<sub>MAX</sub> values are listed in [Table 5](#) through [Table 8](#).

The battery monitoring mode is targeted for battery operated systems within a voltage range of 2.4V to 4.8V. The battery monitoring mode cannot be used when the ADS1293 is powered from a regulated 5V supply because it risks saturating the sigma delta modulator. There is also a low battery alarm that is implemented independently from the battery monitoring mode, which will trigger a battery alarm when the supply voltage is below 2.7V (see the BATLOW description in [ALARM FUNCTIONS](#)).

### Test Mode

If the battery voltage monitoring function is not enabled, and if bit TSTx = 01 (see the [Input Channel Selection Registers](#) section), then a positive DC test signal is provided to the input of the instrumentation amplifier. If TSTx = 10, then that same test signal is provided but with negative polarity. The expected ADC output code can be calculated as follows:

$$ADC_{OUT} = \left[ \pm \frac{3.5 V_{TEST}}{2 V_{REF}} + \frac{1}{2} \right] ADC_{MAX} \quad (2)$$

In [Equation 2](#), the positive or negative DC test signal V<sub>TEST</sub> = V<sub>REF</sub>/12. Note that this test mode is not a gain calibration since V<sub>TEST</sub> and V<sub>REF</sub> are generated by the same reference; however, it can be used as a self-test or to measure gain mismatches between channels.

When TSTx = 11, the inputs of the instrumentation amplifier in the channel can be shorted to provide a zero test signal. The expected ADC output code equation can be simplified to:

$$ADC_{OUT} = \frac{1}{2} ADC_{MAX} \quad (3)$$

For both equations, the value of ADC<sub>MAX</sub> corresponding to a given decimation configuration can be obtained from [Table 5](#) through [Table 8](#).

## ANALOG FRONT END

The ADS1293 contains three analog front ends that convert a differential analog voltage into a digital signal. Each analog front end consists of an instrumentation amplifier (INA), a sigma-delta modulator (SDM), and a digital filter.

### Instrumentation Amplifier (INA)

The instrumentation amplifier provides a high input impedance to interface with signal sources that may have relatively high output impedance, such as ECG electrodes. The maximum differential input voltage range of the Sigma-Delta Modulator (SDM) behind the INA is  $\pm 1.4\text{V}$ , and the gain of the INA is 3.5x. Therefore, the maximum differential input voltage of the INA is  $\pm 400\text{mV}$ .

The input common-mode voltage range (CMVR) of the INA is  $0.95\text{V}$  to  $\text{VDD}-0.95\text{V}$ . If the input differential voltage range is limited to smaller values, then the CMVR can be somewhat extended. If the differential input signal is limited to  $\text{VIN}_{\text{MAX}}$ , the CMVR range can be defined as:

$$(1.75 * \text{VIN}_{\text{MAX}} + 0.25) \leq \text{CMVR} \leq (\text{VDD} - 0.25 - 1.75 * \text{VIN}_{\text{MAX}}) \quad (4)$$

The INA can be configured to operate in a low-power mode or in a high-resolution mode. The low-power mode consumes about 3 times less power than the high-resolution mode. However, the high-resolution mode has less noise than the low-power mode. Switching between these two modes is controlled by the `EN_HIRES_CHx` bits in the `AFE_RES` register.

When a channel is not in use, its INA can be shut down by programming the `SHDN_INA_CHx` bit in the `AFE_SHDN_CN` register, and its SDM can also be shut down by programming the `SHDN_SDM_CHx` bit in the `AFE_SHDN_CN` register.

### Instrumentation Amplifier Fault Detection

The output signal of the instrumentation amplifier can be monitored to ensure its output signal is within an appropriate range. The out-of-range error flags for the INAs can be observed in the `ERROR_RANGE1`, `ERROR_RANGE2` and `ERROR_RANGE3` registers.

The output signal is present at two points: `OUTP` and `OUTN`. If the input common-mode voltage or differential voltage is such that the instrumentation amplifier would have to drive the voltages at these points above the positive or below the negative supply rail, then the signal accuracy would be lost. These two points are monitored and a warning flag is raised if the voltage on these pins approaches the supply rails. If the `OUTP_HIGH` flag is raised, then the voltage at `OUTP` is close to the positive rail. This indicates the differential input signal is too large or the input common-mode voltage is too high. If the `OUTP_LOW` flag is raised, then the voltage at `OUTP` is close to the negative rail. This happens at low input common-mode voltages and large negative differential input voltages. Similar reasoning holds for the `OUTN_HIGH` and `OUTN_LOW` flags.

The differential output voltage of the INA is monitored and reported to the `DIF_HIGH` bit. This error flag indicates that the differential signal is out-of-range and is no longer an accurate representation of the input signal. The `DIF_HIGH` error flag is raised if the differential output voltage of the INA exceeds  $\pm 1.4\text{V}$ , which is the input range of the Delta-Sigma Modulator. When this happens, the SDM will no longer sample the output of the INA, but instead will sample  $0\text{V}$ . The sign of the input signal can still be observed in the `SIGN` bit of the `ERROR_RANGEx` registers.

The fault detection circuitry for `OUTP_HIGH`, `OUTP_LOW`, `OUTN_HIGH` and `OUTN_LOW` can be shut down by programming the `SHDN_FAULTDET_CHx` bits in the `AFE_FAULT_CN` register. These shutdown bits do not affect the operation of `DIF_HIGH` and `SIGN` because the instrumentation amplifier should always provide these signals to the sigma delta modulator. The circuitry that generates `DIF_HIGH` and `SIGN` only gets shut down when the corresponding INA is shut down.

### Sigma Delta Modulator (SDM)

The Sigma Delta Modulator (SDM) takes the output signal of the INA and converts this signal into a high resolution bit stream that is further processed by the digital filters.

The SDM can operate at clock frequencies of  $102.4\text{kHz}$  or  $204.8\text{kHz}$ ; these frequencies are generated internally. Running the SDM at  $204.8\text{kHz}$  results in a larger oversampling ratio, which improves the resolution of the signal recovered by the digital filters behind the SDM. However, running the SDM at a higher clock frequency will increase its power consumption, resulting in a trade-off between resolution and power consumption.

The 102.4kHz or 204.8kHz clock frequency can be selected for each channel individually by programming the FS\_HIGH\_CHx bits in the [AFE\\_RES](#) register.

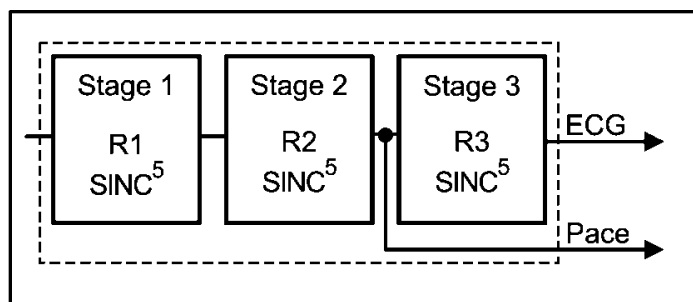
The SDM also features dithering to reduce tones in the system, a known by-product of Sigma Delta converters. The dithering circuit is active by default and is automatically turned OFF when the input signal is larger than 40mV.

### **Sigma Delta Modulator Fault Detection**

The state of the integrators in the Sigma Delta Modulator (SDM) are monitored to detect over-range signals that cause the SDM to become unstable. When an over-range event is detected in the SDM, the state of its integrators is reset, and the over-range error is reported to the SDM\_OR\_CHx bits of the [ERROR\\_RANGE1](#), [ERROR\\_RANGE2](#) and [ERROR\\_RANGE3](#) registers.

### **Programmable Digital Filters**

A programmable digital filter behind the Sigma Delta Modulator (SDM) reconstructs the signal from the SDM output bit stream. The filter consist of three programmable SINC filters as shown in [Figure 18](#). Each stage is a fifth order SINC filter.



**Figure 18. SINC Filters**

The decimation rates (R1, R2, and R3) of the SINC filters are programmable as described in [Table 4](#). Each of the three stages further filters and decimates the bit stream so that the output data rate (ODR) and bandwidth (BW) of the signal is reduced, and at the same time, the resolution is enhanced. A 16-bit digital signal with relatively high ODR and BW, but with somewhat limited resolution, is available after the second stage; this signal can be used for PACE pulse detection. That signal is further decimated by the third stage and results in a very high resolution filtered 24-bit digital signal that is an accurate representation of the ECG signal.

**Table 4. Programmable Digital Filter Coefficients**

Stage 1 (R1)	Stage 2 (R2)	Stage 3 (R3)
4 (Standard PACE Data Rate), 2 (Double PACE Data Rate)	4,5,6,8	4,6,8,12,16,32,64,128

The first stage sets the Standard PACE Data Rate (where the decimation rate R1 = 4) or the Double PACE Data Rate (where R1 = 2). Operating the device in the Double PACE Data Rate will double the ODR for the first stage (and therefore also for the subsequent stages). However, the BW of the first stage does not change in this mode; only the ODR is affected. By operating the device in the Double PACE Data Rate, the ODR of the PACE data is doubled, and thus, more accurate PACE pulse detection is possible. However, operating the device in the Double PACE Data Rate will increase its power consumption. The R1 decimation rate can be programmed for each of the three channels separately by using the [R1\\_RATE](#) register.

Programming the second stage (R2) to a low decimation rate sets a relatively high ODR and BW, but doing so will also increase the noise level. For digital PACE pulse detection, smaller values for R2 are recommended. The R2 decimation rate can be programmed using the [R2\\_RATE](#) register.

As the third stage decimation (R3) increases, the ODR and BW of the ECG decreases. When detecting an ECG signal, higher values of R3 are recommended. The R3 decimation rate for each channel can be individually programmed using the [R3\\_RATE\\_CH1](#), [R3\\_RATE\\_CH2](#), and [R3\\_RATE\\_CH3](#) registers.



Table 5, Table 6, Table 7, and Table 8 illustrate how these decimation rates R1, R2, and R3 affect the ODR, BW, and RMS Noise of the PACE and ECG signals. In addition, the ODR and BW also depend on whether the SDM is running at a low (102.4kHz) or high (204.8kHz) clock frequency (set by the FS\_HIGH\_CHx bits in the AFE\_RES register). The RMS Noise of the PACE and ECG channels also depend on whether the instrumentation amplifier is running in low power or high resolution mode (set by the EN\_HIRES bits in the AFE\_RES register).

In summary, the output data rate of an ECG channel can be calculated as follows:

$$\text{ODR}_{\text{ECG}} = \frac{f_s}{R1 R2 R3} \quad (5)$$

And the output data rate of a PACE channel can be calculated as follows:

$$\text{ODR}_{\text{PACE}} = \frac{f_s}{R1 R2} \quad (6)$$

Where  $f_s$  is the clock frequency of the modulator: 102.4kHz, or 204.8kHz.

### Filter Settling Time

The low-pass filter frequency responses of the ECG and Pace SINC filters result in a settling time associated with their outputs as a response to a step input signal. This settling time is determined by the order of the filter, N, its differential delay, M, and the channel output data rate, ODR:

$$t_s = N \times M / \text{ODR} \quad (7)$$

The ODR of the filter is a function of the sigma-delta's sampling frequency,  $f_s$ , and the filter decimation rates. The value of the ODR can be calculated using Equation 5 and Equation 6. For an ECG channel, the value of  $N \times M = 5$ . For a Pace channel  $N \times M = 5$  when operated in the Standard Pace Data Rate ( $R1 = 4$ ), and  $N \times M = 10$  when operated in the Double Pace Data Rate ( $R1 = 2$ ).

As a result, an unclamped pace signal applied to the filter input results in an ECG channel minimum settling time of:

$$t_{s\text{-ECG}} = 5 \times R1 \times R2 \times R3 / f_s \quad (8)$$

A Standard Pace Data Rate operated Pace channel will go through a minimum settling time of:

$$t_{s\text{-PACE}} = 5 \times R1 \times R2 / f_s \quad (9)$$

And a Double Pace Data Rate operated Pace channel will go through a minimum settling time of:

$$t_{s\text{-PACE}} = 10 \times R1 \times R2 / f_s \quad (10)$$

### Output Code (ADC<sub>OUT</sub>)

The ADC<sub>OUT</sub> of the ADS1293 is due to a differential voltage applied between the positive and negative input terminals of the instrumentation amplifier and can be calculated with Equation 11:

$$\text{ADC}_{\text{OUT}} = \left[ \frac{3.5 V_{\text{INP}} - V_{\text{INM}}}{2 V_{\text{REF}}} + \frac{1}{2} \right] \text{ADC}_{\text{MAX}} \quad (11)$$

The reference voltage  $V_{\text{REF}}$ , equals to 2.4V if the on-chip voltage reference is used. ADC<sub>MAX</sub> represents the maximum output code of the ADC, which corresponds to a theoretical 2.4V signal at the input of the SDM. The value of ADC<sub>MAX</sub> changes with the configuration of the digital filters, and the corresponding value can be found in Table 5, Table 6, Table 7, and Table 8. Note that ADC<sub>OUT</sub> equals ADC<sub>MAX</sub>/2 for a 0V differential input.

## Output Data Rate, Bandwidth and Noise Tables

Table 5. Channel Parameters with SDM running at 102.4kHz and at Standard PACE Data Rate (R1 = 4)<sup>(1)</sup>

R2	R3	PACE CHANNEL				ECG CHANNEL				
		ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS Noise [mV]	ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise	
									Low Pwr [μV]	High Res [μV]
4	4	0x8000	6400	1300	1.612	0x800000	1600	325	4.47	4.16
	6					0xF30000	1067	215	3.42	3.05
	8					0x800000	800	160	2.92	2.57
	12					0xF30000	533	105	2.37	2.07
	16					0x800000	400	80	2.06	1.81
	32					0x800000	200	40	1.50	1.29
	64					0x800000	100	20	1.12	0.94
	128					0x800000	50	10	0.85	0.70
5	4	0xC350	5120	1040	0.572	0xC35000	1280	260	3.82	3.42
	6					0xB964F0	853	175	3.02	2.67
	8					0xC35000	640	130	2.60	2.29
	12					0xB964F0	427	85	2.13	1.86
	16					0xC35000	320	65	1.86	1.62
	32					0xC35000	160	32	1.36	1.16
	64					0xC35000	80	16	1.02	0.85
	128					0xC35000	40	8	0.79	0.64
6	4	0xF300	4267	870	0.238	0xF30000	1067	215	3.41	3.04
	6					0xE6A900	711	145	2.74	2.42
	8					0xF30000	533	110	2.38	2.07
	12					0xE6A900	356	70	1.96	1.70
	16					0xF30000	267	55	1.71	1.48
	32					0xF30000	133	27	1.25	1.07
	64					0xF30000	67	13	0.94	0.79
	128					0xF30000	33	7	0.74	0.60
8	4	0x8000	3200	650	0.060	0x800000	800	160	2.91	2.58
	6					0xF30000	533	110	2.37	2.08
	8					0x800000	400	80	2.08	1.79
	12					0xF30000	267	55	1.71	1.48
	16					0x800000	200	40	1.50	1.29
	32					0x800000	100	20	1.12	0.94
	64					0x800000	50	10	0.85	0.70
	128					0x800000	25	5	0.68	0.54

(1) 10000 consecutive readings were used to calculate the RMS noise values in this table.

**Table 6. Channel Parameters with SDM running at 102.4kHz and at Double PACE Data Rate (R1 = 2)<sup>(1)</sup>**

R2	R3	PACE CHANNEL				ECG CHANNEL				
		ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise [mV]	ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise	
									Low Pwr [μV]	High Res [μV]
4	4	0x8000	12800	1280	1.479	0x800000	3200	640	38.17	37.92
	6					0xF30000	2133	430	7.04	6.72
	8					0x800000	1600	320	4.35	3.93
	12					0xF30000	1067	215	3.40	3.02
	16					0x800000	800	160	2.92	2.57
	32					0x800000	400	80	2.08	1.79
	64					0x800000	200	40	1.49	1.29
	128					0x800000	100	20	1.11	0.93
5	4	0xC350	10240	1030	0.540	0xC35000	2560	510	12.64	12.38
	6					0xB964F0	1707	340	4.53	4.12
	8					0xC35000	1280	255	3.74	3.35
	12					0xB964F0	853	170	3.01	2.65
	16					0xC35000	640	130	2.59	2.28
	32					0xC35000	320	65	1.86	1.62
	64					0xC35000	160	32	1.36	1.16
	128					0xC35000	80	16	1.02	0.85
6	4	0xF300	8533	860	0.228	0xF30000	2133	420	6.20	5.88
	6					0xE6A900	1422	285	3.94	3.57
	8					0xF30000	1067	210	3.38	3.02
	12					0xE6A900	711	140	2.74	2.42
	16					0xF30000	533	105	2.37	2.07
	32					0xF30000	267	55	1.70	1.47
	64					0xF30000	133	26	1.26	1.07
	128					0xF30000	67	13	0.95	0.78
8	4	0x8000	6400	650	0.058	0x800000	1600	320	4.14	3.73
	6					0xF30000	1067	215	3.35	2.96
	8					0x800000	800	160	2.89	2.54
	12					0xF30000	533	110	2.37	2.07
	16					0x800000	400	80	2.06	1.79
	32					0x800000	200	40	1.50	1.29
	64					0x800000	100	20	1.11	0.94
	128					0x800000	50	10	0.85	0.70

(1) 10000 consecutive readings were used to calculat the RMS noise values in this table.

**Table 7. Channel Parameters with SDM running at 204.8kHz and at Standard PACE Data Rate (R1 = 4)<sup>(1)</sup>**

R2	R3	PACE CHANNEL				ECG CHANNEL				
		ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise [mV]	ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise	
									Low Pwr [μV]	High Res [μV]
4	4	0x8000	12800	2600	1.738	0x800000	3200	640	5.20	4.59
	6					0xF30000	2133	430	3.92	3.38
	8					0x800000	1600	325	3.32	2.86
	12					0xF30000	1067	215	2.69	2.31
	16					0x800000	800	160	2.34	1.99
	32					0x800000	400	80	1.68	1.43
	64					0x800000	200	40	1.25	1.04
	128					0x800000	100	20	0.95	0.78
5	4	0xC350	10240	2080	0.613	0xC35000	2560	520	4.36	3.81
	6					0xB964F0	1707	350	3.44	2.96
	8					0xC35000	1280	260	2.95	2.54
	12					0xB964F0	853	170	2.41	2.06
	16					0xC35000	640	130	2.10	1.79
	32					0xC35000	320	65	1.53	1.29
	64					0xC35000	160	32	1.14	0.95
	128					0xC35000	80	15	0.88	0.72
6	4	0xF300	8533	1740	0.256	0xF30000	2133	430	3.91	3.38
	6					0xE6A900	1422	290	3.12	2.68
	8					0xF30000	1067	215	2.68	2.30
	12					0xE6A900	711	140	2.21	1.88
	16					0xF30000	533	110	1.93	1.64
	32					0xF30000	267	55	1.41	1.18
	64					0xF30000	133	27	1.06	0.88
	128					0xF30000	67	13	0.83	0.68
8	4	0x8000	6400	1300	0.064	0x800000	1600	325	3.32	2.86
	6					0xF30000	1067	215	2.69	2.31
	8					0x800000	800	160	2.34	2.00
	12					0xF30000	533	105	1.93	1.64
	16					0x800000	400	80	1.69	1.44
	32					0x800000	200	40	1.25	1.04
	64					0x800000	100	20	0.96	0.78
	128					0x800000	50	10	0.76	0.61

(1) 10000 consecutive readings were used to calculate the RMS noise values in this table.

**Table 8. Channel Parameters with SDM running at 204.8kHz and at Double PACE Data Rate (R1 = 2)<sup>(1)</sup>**

R2	R3	PACE CHANNEL				ECG CHANNEL				
		ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise [mV]	ADC <sub>MAX</sub>	ODR [Hz]	BW [Hz]	RMS noise	
									Low Pwr [μV]	High Res [μV]
4	4	0x8000	25600	2550	1.592	0x800000	6400	1280	41.27	40.81
	6					0xF30000	4267	850	7.79	7.32
	8					0x800000	3200	640	4.97	4.35
	12					0xF30000	2133	430	3.88	3.36
	16					0x800000	1600	325	3.32	2.85
	32					0x800000	800	160	2.34	1.98
	64					0x800000	400	80	1.69	1.43
	128					0x800000	200	40	1.25	1.04
5	4	0xC350	20480	2050	0.580	0xC35000	5120	1020	13.57	13.38
	6					0xB964F0	3413	680	5.18	4.56
	8					0xC35000	2560	510	4.30	3.73
	12					0xB964F0	1707	340	3.41	2.94
	16					0xC35000	1280	260	2.94	2.53
	32					0xC35000	640	130	2.10	1.79
	64					0xC35000	320	65	1.53	1.29
	128					0xC35000	160	32	1.14	0.95
6	4	0xF300	17067	1720	0.245	0xF30000	4267	850	6.99	6.43
	6					0xE6A900	2844	570	4.53	3.94
	8					0xF30000	2133	420	3.86	3.33
	12					0xE6A900	1422	285	3.11	2.67
	16					0xF30000	1067	215	2.69	2.29
	32					0xF30000	533	110	1.93	1.64
	64					0xF30000	267	55	1.41	1.18
	128					0xF30000	133	26	1.06	0.88
8	4	0x8000	12800	1300	0.062	0x800000	3200	640	4.74	4.15
	6					0xF30000	2133	425	3.82	3.28
	8					0x800000	1600	320	3.29	2.83
	12					0xF30000	1067	215	2.68	2.30
	16					0x800000	800	160	2.34	2.00
	32					0x800000	400	80	1.69	1.42
	64					0x800000	200	40	1.25	1.05
	128					0x800000	100	20	0.95	0.79

(1) 10000 consecutive readings were used to calculat the RMS noise values in this table.

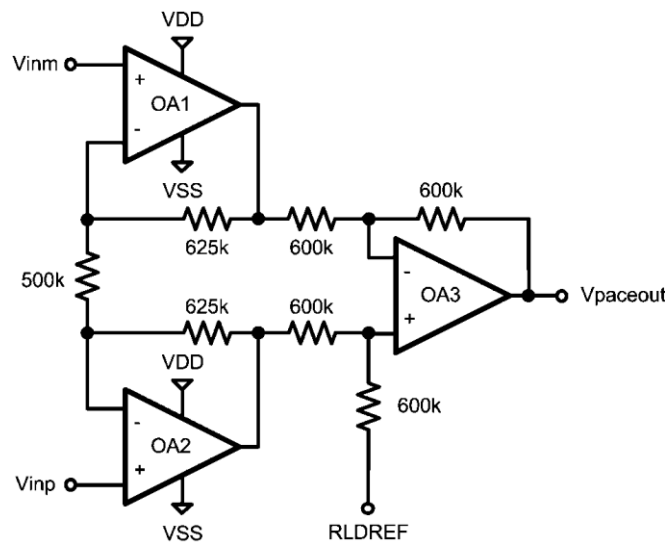
## ANALOG PACE CHANNEL

The ADS1293 features an additional analog pace channel to process pulses from a pace maker. The analog pace channel is suitable for low power applications where the device can be configured for low data rates in ECG mode only, while an analog channel detects PACE pulses. This channel consists of a traditional three opamp instrumentation amplifier and is designed to amplify an ECG signal in a typical bandwidth, as specified in the [ELECTRICAL CHARACTERISTICS](#) table, allowing for external circuitry to detect the PACE pulses. The analog pace implementation inside the ADS1293 is depicted in [Figure 19](#). The analog pace channel is not limited to PACE detection; it is a full analog channel that could be used to pre-amplify signals, for instance, from a respiration sensor.

The output voltage of the analog pace channel is:

$$V_{paceout} = 3.5 \times (V_{inp} - V_{inm}) + RLDREF \quad (12)$$

Where  $V_{inp}$  and  $V_{inm}$  are the positive and negative inputs of the analog pace channel. The input pins of this channel can be selected in the [FLEX\\_PACE\\_CN](#) register and can connect to any of the IN1 through IN6 pins. Note there is no battery monitoring option available through this channel. There is, however, the reference voltage test mode available as described in [Test Mode](#).



**Figure 19. Analog Pace Channel Instrumentation Amplifier**

The output of the analog pace channel can be multiplexed to the WCT or RLDIN pin using the [AFE\\_PACE\\_CN](#) register. When  $PACE2RLDIN = 1$ , the output is routed to the RLDIN terminal, while internally the positive input of the Right Leg Drive amplifier is connected to the RLDREF pin. When  $PACE2WCT = 1$ , the output is routed to the WCT terminal, and the WCT terminal is disconnected from the Wilson output. In this case, the Wilson output can still be connected internally to the IN6 pin using the [WILSON\\_CN](#) register. The analog pace channel is disabled when  $SHDN\_PACE = 1$  to save power when it is not used.

The analog pace channel is designed to drive a high pass filter and can directly drive a capacitive load of 100pF.

For analog pace detection, it is recommended to have a band pass filter at the output of the analog pace channel, amplify the resulting signal with a relatively high bandwidth amplifier, and compare the amplified pulses with a relatively high speed window comparator. The bandwidth of the band pass filter, gain of the amplification, and the thresholds of the window comparator should be tuned so the comparators trigger on pacemaker pulses, but not to other signals present in the ECG environment.

## WILSON REFERENCE

The ADS1293 features a Wilson reference block consisting of three buffer amplifiers and resistors that can generate the voltages for the Wilson Central Terminal or Goldberger terminals. Each of the three buffer amplifiers can be connected to any input pin, IN1 through IN6, by programming the [WILSON\\_EN1](#), [WILSON\\_EN2](#), and [WILSON\\_EN3](#) registers. A buffer that is not connected to an input pin is automatically disabled. When disabled, the buffers have a high output impedance.

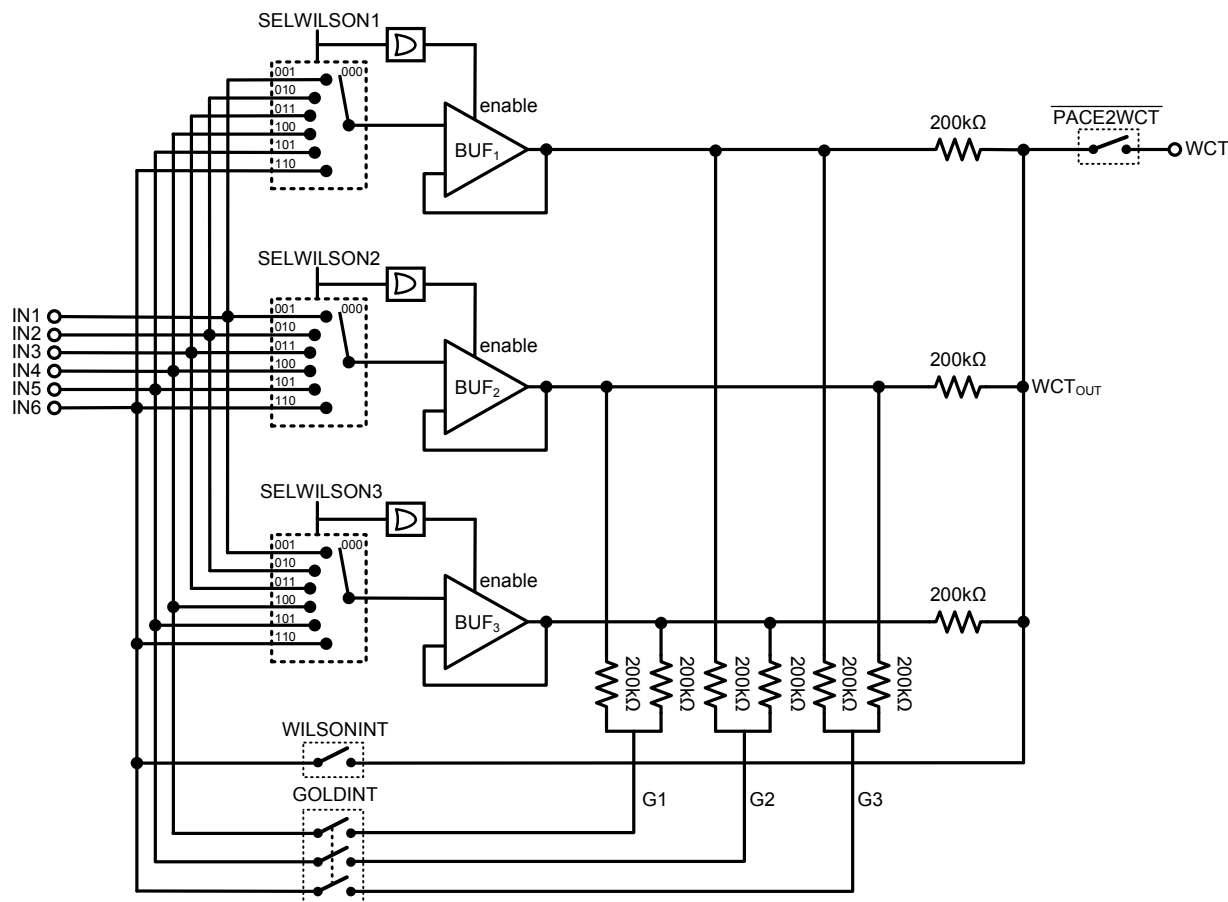


Figure 20. Wilson Reference Generator Circuit

The output of the Wilson Reference can be routed internally to IN6, and the outputs of the Goldberger reference can be routed internally to IN4, IN5 and IN6. This is configured in the [WILSON\\_CN](#) register. If routed externally, it is strongly recommended to shield these connections, which due to their high output impedance, are prone to pick up external interference.

### Wilson Central Terminal

There are three main ECG leads that are measured differentially:

- Lead I: I = LA - RA
- Lead II: II = LL - RA
- Lead III: III = LL - LA

Where LA is the left arm electrode, LL is the left leg electrode, and RA is the right arm electrode.

In a standard 5-lead or 12-lead ECG, the Wilson Central Terminal is used as the reference voltage for the chest electrodes, which are measured differentially against this reference. The Wilson Central Terminal is defined as the average of the three limb electrodes, RA, LA and LL:

$$\text{Wilson Central Terminal} = (RA + LA + LL)/3$$

The output of Wilson Central Terminal generated by the ADS1293, as seen in [Figure 20](#), is defined as:

$$WCT_{OUT} = (BUF_1 + BUF_2 + BUF_3)/3$$

The user could program the [WILSON\\_EN1](#) register to connect the RA electrode to BUF<sub>1</sub>, program the [WILSON\\_EN2](#) register to connect the LA electrode to BUF<sub>2</sub>, and program the [WILSON\\_EN3](#) register to connect the LL electrode to BUF<sub>3</sub>.

When the Wilson reference is enabled, its output is present at the WCT pin, except when the analog pace channel is routed to the WCT pin (see [ANALOG PACE CHANNEL](#)). In such a configuration, the Wilson terminal can still be made available at an external pin by programming the WILSONINT bit to 1. Setting this bit connects the output of the Wilson reference internally to the IN6 pin.

### Goldberger Terminals

Augmented leads in 3-lead, 5-lead or 12-lead ECG are typically calculated digitally based on the measurement results of Lead I and Lead II. The augmented leads are defined as:

- $aVR = -(I + II)/2 = RA - (LA + LL)/2 = RA - G1$
- $aVL = I - II/2 = LA - (RA + LL)/2 = LA - G2$
- $aVF = II - I/2 = LL - (RA + LA)/2 = LL - G3$

Augmented leads can also be measured directly with the Goldberger terminals to give the best SNR. The Goldberger terminals generated by the ADS1293, as seen in [Figure 20](#), are defined as:

- $G1 = (BUF_2 + BUF_3)/2$
- $G2 = (BUF_1 + BUF_3)/2$
- $G3 = (BUF_1 + BUF_2)/2$

In this case, the user must program the [WILSON\\_EN1](#) register to connect the RA electrode to BUF<sub>1</sub>, program the [WILSON\\_EN2](#) register to connect the LA electrode to BUF<sub>2</sub>, and program the [WILSON\\_EN3](#) register to connect the LL electrode to BUF<sub>3</sub>.

The Goldberger output terminals, G1, G2 and G3 can be made available on external pins programming the GOLDINT bit to 1. Setting this bit connects the Goldberger terminals internally to the IN4, IN5 and IN6 pins.

- IN4 = G1
- IN5 = G2
- IN6 = G3

Note that multiple ADS1293 chips are required if both the augmented leads and the three basic leads need to be converted directly.

The WILSONINT and GOLDINT bits must not be programmed to 1 simultaneously because it will short-circuit the Wilson output terminal and the third Goldberger output terminal. The options described in these sections are summarized in [Table 9](#).

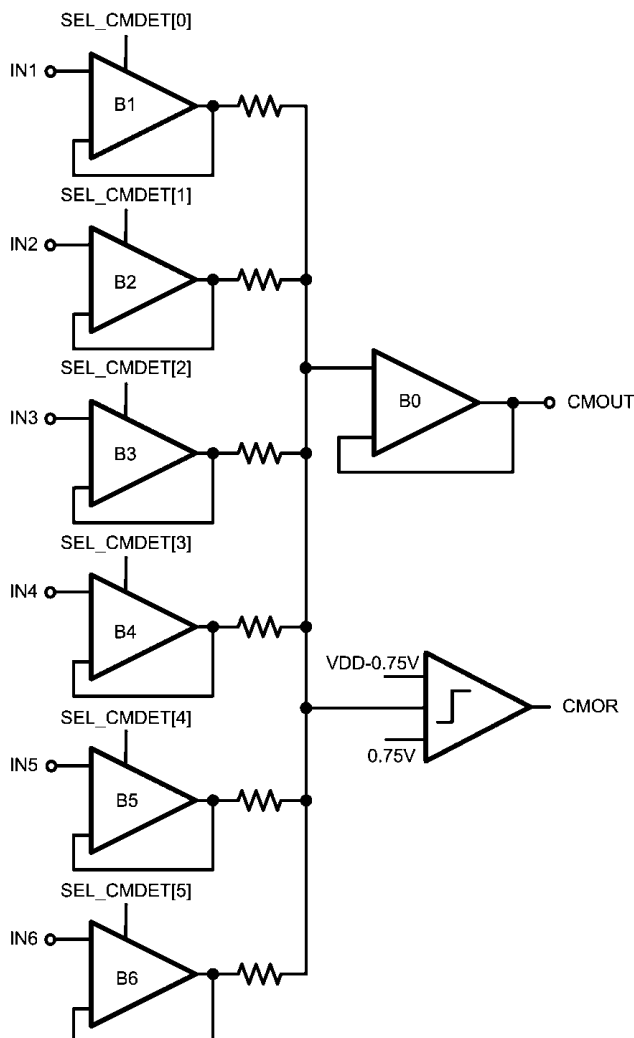
**Table 9. Wilson and Goldberger Reference control**

GOLDINT	WILSONINT	PACE2WCT	TERMINAL OUTPUTS			
			WCT PIN	IN4 PIN	IN5 PIN	IN6 PIN
0	0	0	WCT <sub>OUT</sub>	General input	General input	General input
0	1	0	WCT <sub>OUT</sub>	General input	General input	WCT <sub>OUT</sub>
1	0	0	WCT <sub>OUT</sub>	(BUF <sub>2</sub> +BUF <sub>3</sub> )/2	(BUF <sub>1</sub> +BUF <sub>3</sub> )/2	(BUF <sub>1</sub> +BUF <sub>2</sub> )/2
1	1	X	Illegal	Illegal	Illegal	Illegal
0	0	1	Vpaceout	General input	General input	General input
0	1	1	Vpaceout	General input	General input	WCT <sub>OUT</sub>
1	0	1	Vpaceout	(BUF <sub>2</sub> +BUF <sub>3</sub> )/2	(BUF <sub>1</sub> +BUF <sub>3</sub> )/2	(BUF <sub>1</sub> +BUF <sub>2</sub> )/2



## COMMON-MODE (CM) DETECTOR

The Common-Mode Detector averages the voltage of up to six input pins. Its output can be used in a right leg drive feedback circuit. The selection of the input pins that contribute to the average is configured in the **CMDDET\_EN** register. The Common-Mode Detector is automatically disabled when no input pin is selected.



**Figure 21. Common-Mode Detector Circuit**

### Cable Shield Driving

The Common-Mode Detector also has a programmable capacitive load driving capability of up to 8nF that allows it to drive a cable shield to reduce the common-mode signal current through a cable. This effectively increases the bandwidth of the filter formed by the electrode impedance and the cable capacitance, reducing the amount of common-mode to differential mode crosstalk. As a result, the CMRR of the overall ECG system is improved.

The bandwidth and capacitive load driving capability of the Common-Mode Detector can be configured in the **CMDDET\_CN** register to achieve an optimal tradeoff with power consumption. [Table 10](#) lists the power consumption corresponding to different configuration scenarios given that all inputs are enabled by setting the **CMDDET\_EN** register = 0x3F.

The lowest current consumption setting can be used when the Common-Mode Detector is only used to drive the Right Leg Driver, and no cable shield is driven. If a cable shield needs to be driven, the power can be increased to drive the cable capacitance depending on the number and type of the driven cable shields. Note that the capacitive driving capability is reduced in the higher bandwidth mode.

**Table 10. Typical Common-Mode Detector Bandwidth, Capacitive Drive and Power Consumption**

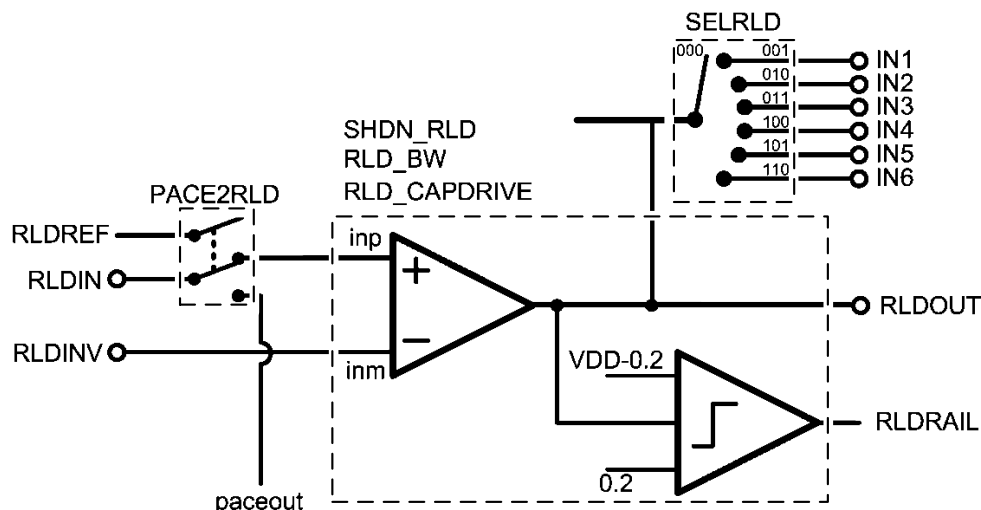
CMDDET_BW	CMDDET_CAPDRIVE	BW (kHz)	C <sub>LOAD</sub> (nF)	CMDDET I <sub>SUPPLY</sub> (μA)
0: Low BW mode	00: Low Cap Drive	50	2	39
0: Low BW mode	01: Medium Low Cap Drive	50	3.3	45
0: Low BW mode	10: Medium High Cap Drive	50	4.5	56
0: Low BW mode	11: High Cap Drive	50	8	75
1: High BW mode	00: Low Cap Drive	150	0.4	43
1: High BW mode	01: Medium Low Cap Drive	150	0.65	49
1: High BW mode	10: Medium High Cap Drive	150	1	60
1: High BW mode	11: High Cap Drive	150	1.6	79

### Common-Mode Output Range (CMOR)

The Common-Mode Detector incorporates an out-of-range alarm to sense if the common-mode voltage is outside of the common-mode voltage range of the ADS1293. A Common-Mode Out-of-Range Alarm is created in the CMOR bit of the [ERROR\\_STATUS](#) register when the common-mode drops below 0.75V or exceeds VDD-0.75V. System alarms are filtered by the digital circuitry (see [ERROR FILTERING](#)), and for this reason, the master clock must be active in order to capture an alarm.

### RIGHT LEG DRIVE (RLD)

The RLD is a programmable operational amplifier that is intended to control the common-mode level of the patient connected through electrodes to the ADS1293 and thereby improving the AC CMRR of the overall ECG system. In a typical ADS1293 application, the common-mode level of the patient's body is measured by the Common-Mode Detector described in the previous section. The CMOUT is compared by the RLD to the reference voltage present on the RLDREF pin. When used in an inverting amplifier topology, the right leg electrode is driven by the RLD to counter any differences between the reference voltage and the detected common-mode level. This reduces the amount of power-line common-mode interference.

**Figure 22. Right Leg-Drive Circuit**

The negative input terminal of the RLD op-amp is always connected to the RLDINV pin. By default, the positive input terminal of the RLD op-amp is routed to the RLDIN pin. However, when bit PACE2RLDIN = 1 in the [AFE\\_PACE\\_CN](#) register, the positive input terminal is routed internally to the RLD reference. This will allow connecting the output of the analog pace instrumentation amplifier to the RLDIN pin. The output of the RLD op-amp is always connected to the SELRLDOUT pin, and in addition, can be connected to one of the IN1-IN6 terminals by programming the SELRLD bit in the [RLD\\_CN](#) register. The RLD circuit can be shut down in the same register by setting bit SHDN\_RLD = 1.

## Capacitive Load Driving

The bandwidth and capacitive load driving capability of the RLD can be configured in the [RLD\\_CN](#) register to achieve an optimal tradeoff of power consumption. [Table 11](#) lists the power consumption corresponding to different configuration scenarios.

**Table 11. Typical Right Leg Drive Bandwidth, Capacitive Drive and Power Consumption**

RLD_BW	RLD_CAPDRIVE	GBW (kHz)	C <sub>LOAD</sub> (nF)	RLD I <sub>SUPPLY</sub> (μA)
0: Low BW mode	00: Low Cap Drive	50	2	20
0: Low BW mode	01: Medium Low Cap Drive	50	3.3	25
0: Low BW mode	10: Medium High Cap Drive	50	4.5	36
0: Low BW mode	11: High Cap Drive	50	8	55
1: High BW mode	00: Low Cap Drive	200	0.4	23
1: High BW mode	01: Medium Low Cap Drive	200	0.65	29
1: High BW mode	10: Medium High Cap Drive	200	1	39
1: High BW mode	11: High Cap Drive	200	1.6	60

## Error Status: RLD Rail

The RLD amplifier incorporates a near to rail alarm function that is triggered when the output of the op-amp is below 0.2V or above VDD-0.2V. The alarm is reported to the RLDRAIL bit in the [ERROR\\_STATUS](#) register and indicates that the RLD's feedback loop has difficulty maintaining a constant voltage on the patient's body. In this case, the common-mode on the patient's body may drift away from its target value, but it may still be within the proper input common-mode voltage range of the ADS1293, and the ECG signal data acquisition can continue. When the common-mode on the patient's body is outside the operation range of the ADS1293, the CMOR error will be raised, as described in the previous section. System alarms are filtered by the digital circuitry (see [ERROR FILTERING](#)), and for this reason, the master clock must be active in order to capture an alarm.

## LEAD-OFF DETECTION (LOD)

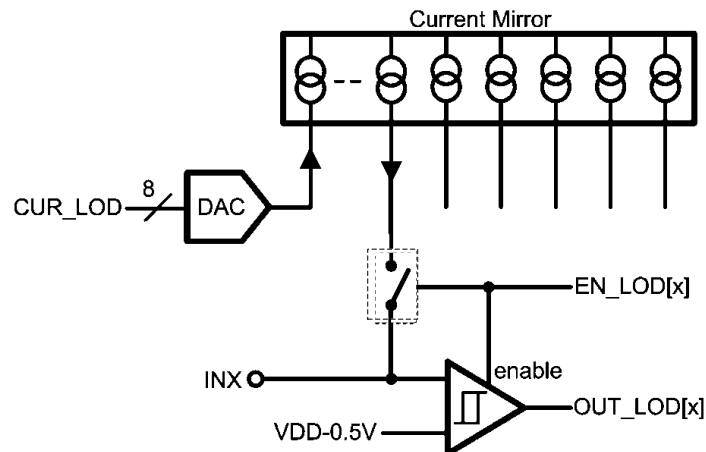
The lead-off detect (LOD) block of the ADS1293 can be used to monitor the connectivity of the 6 input pins to electrodes. The LOD block injects a programmable DC or AC excitation current into selected input pins and detects the voltages that appear on the input pins in response to that current. If a lead is not making a proper contact, then the electrode impedance will be high, and as a result, the voltage in response to a small test current will be relatively large, while the voltage for a well-connected lead will be small.

The LOD block can work in one of the three following modes: 1) DC lead-off detect, 2) analog AC lead-off detect or 3) digital AC lead-off detect. All three LOD modes use a common DAC that provides a programmable reference current. This reference current is used to set the magnitude of the test current for lead-off detection. The amplitude of the excitation current used for lead-off detection can be programmed in the [LOD\\_CURRENT](#) register, where codes 0 to 255 result in currents ranging from 0 to 2.040μA in steps of 8nA.

The complete LOD block can be shut down by programming the SHDN\_LOD bit to 1 in the [LOD\\_CN](#) register.

### DC Lead-Off Detect

The LOD block can be configured for DC LOD mode by programming a 0 in the SELAC\_LOD bit of the [LOD\\_CN](#) register. In the DC LOD mode, a DC test current can be injected into any of the six input pins by setting the corresponding bit EN\_LOD[x] of the [LOD\\_EN](#) register. Programming a bit to 1 in this register enables a switch that allows a copy of the current programmed into the DAC to be injected into the desired input pins, as shown in the simplified block diagram of [Figure 23](#).



**Figure 23. Simplified DC Lead-off Detect Block Diagram**

For the selected input pins, a Schmitt-trigger comparator then compares the voltage that appears on the pin to (VDD-0.5V). The result of this comparison can be accessed through the corresponding OUT\_LOD[x] bit of the [ERROR\\_LOD](#) register. If a lead is off, then the injected current has no return path to ground, and as a result, the voltage on the associated input pin will rise towards VDD. This is detected by the comparator and is used as a signal to indicate the lead is not properly connected.

It is important to note that the lead-off detection circuit requires a low impedance return path from the right leg electrode to ground, such as a voltage reference or the RLD amplifier output. Without a proper low impedance return path for the LOD currents, all enabled LOD pins will report a lead disconnected.

### Analog AC Lead-Off Detect

DC lead-off detection cannot be used when using capacitively coupled electrodes, such as dry electrodes, because they have a high DC impedance that will block DC test currents. In this case, the analog AC LOD block can be used. Contrary to the DC LOD, the AC LOD injects AC excitation currents with programmable amplitudes and frequencies into the desired lead.

To operate the LOD in analog AC LOD mode, the SELAC\_LOD and the ACAD\_LOD bits of the [LOD\\_CN](#) register must be set to 1.

A simplified block diagram of the analog AC LOD block is shown in [Figure 25](#). The AC excitation frequency can be programmed by a 7-bit number, ACDIV\_LOD, and a division factor, ACDIV\_FACTOR, in the [LOD\\_AC\\_CN](#) register. The register sets the output frequency of the divider to a rate of:

$$\Phi = 50 / (4 \times K \times (\text{ACDIV\_LOD} + 1)) \text{ kHz} \quad (13)$$

Where K is 1 if the ACDIV\_FACTOR bit equals 0, and K is 16 if the ACDIV\_FACTOR bit equals 1. For instance, ACDIV\_LOD = 0 and ACDIV\_FACTOR = 0 result in an excitation frequency of 12.5kHz, which is the maximum excitation frequency.

Complimentary driven switches, enabled by the EN\_LOD[x] bits of the [LOD\\_EN](#) register, sink and source the AC excitation currents into the desired input pins. The resulting AC current has a frequency  $\Phi$  and a peak-to-peak amplitude equal to the current programmed into the DAC. An AC coupled synchronous detector detects the amplitude of the AC voltage appearing on the lead. The detected amplitude is compared to a reference voltage by means of a Schmitt-trigger comparator. The comparator's reference voltage level, as shown in [Figure 24](#), is determined by a 2-bit reference DAC configured in the ACLVL\_LOD bits of the [LOD\\_CN](#) register.

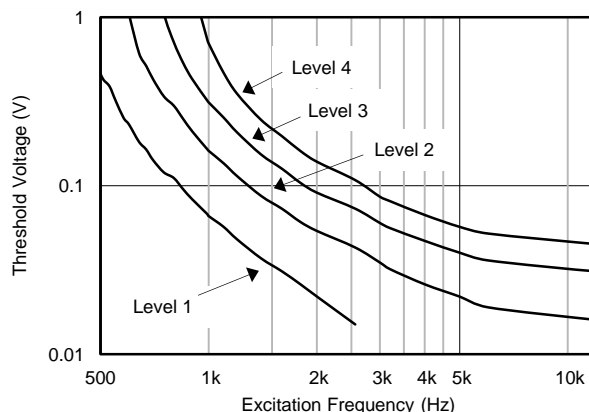


Figure 24. Analog AC Lead-Off reference levels

The comparator outputs can be accessed at the OUT\_LOD[x] bit of the [ERROR\\_LOD](#) register. A high comparator output signal indicates that the AC voltage at the excitation frequency is larger than the programmed threshold, which indicates that the lead is not well connected.

The lead-off detection circuit requires a low impedance return path from the right leg electrode to ground, such as a voltage reference or the RLD amplifier output. Without a proper low impedance return path for the LOD currents, all enabled LOD pins will report a lead disconnected.

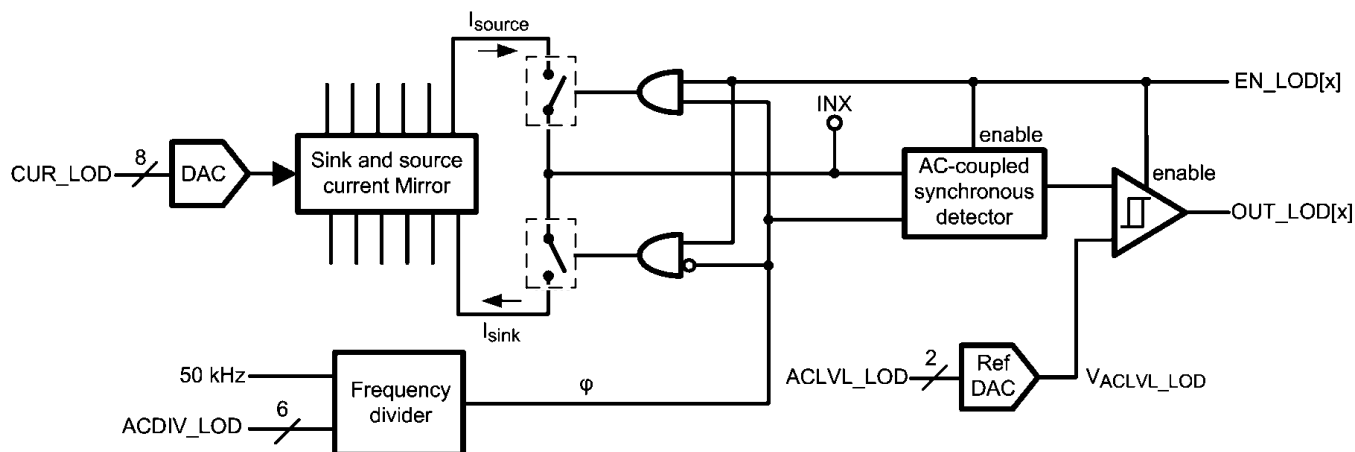
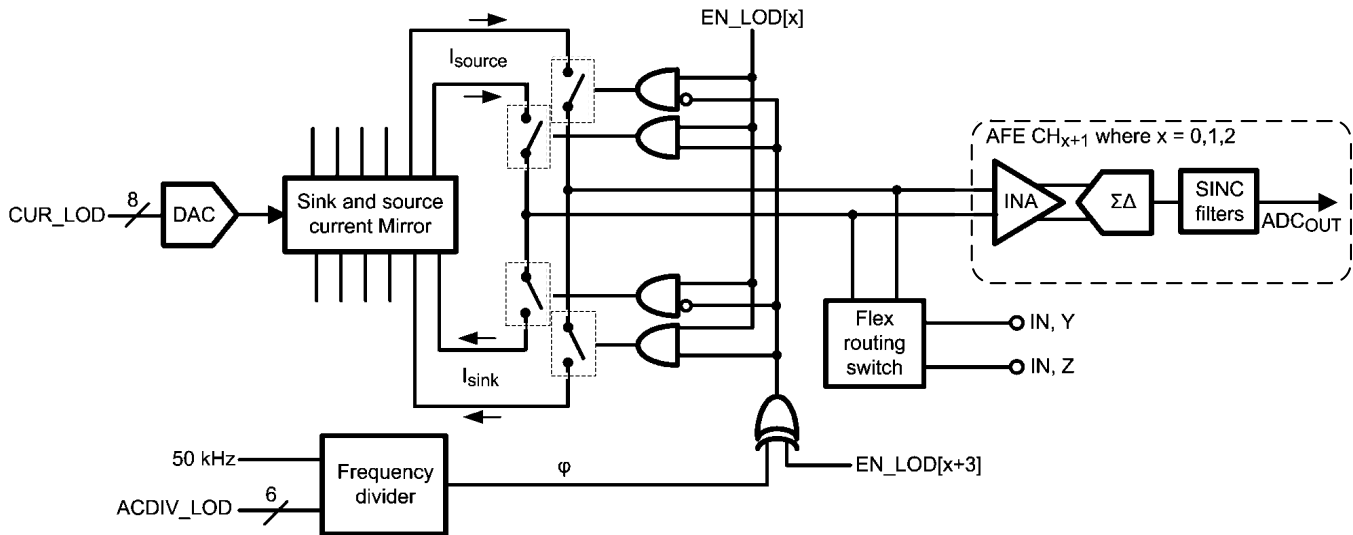


Figure 25. Simplified Analog AC Lead-off Detect Block Diagram

### Digital AC Lead-Off Detect

The digital AC lead-off detect (LOD) allows for measurement of the impedance of the two electrodes connected to an AFE channel by measuring a signal through the AFE. In this mode, the lead-off detect current is injected in a balanced manner at the inputs of the AFE behind the flex routing switch. The AC test current is injected into the positive input of the AFE behind the flex routing switch; while at the same time, a similar test current with opposite sign is injected into the negative input of the AFE. Since the AFE has a very high input impedance, the current injected into the positive input pin cannot flow into the AFE. Instead, it will flow through the flex routing switch, via the positive input electrode into the patient, and then back through the negative input electrode and via another path in the flex routing switch towards the negative input of the AFE, where it is cancelled by the current injected at that point. As a result of this test current, an additional AC voltage input will occur at the input of the AFE with a frequency equal to the frequency of the AC LOD test signal frequency. The magnitude of this voltage equals the magnitude of the AC LOD test current (programmed into the CUR\_LOD bit in the [LOD\\_CURRENT](#) register) multiplied by the impedances of the two electrodes routed to the AFE input in series.

This AC voltage will be digitized by the AFE, and the result is available in the digital AFE output signals. The lead connectivity can be determined in the digital domain by applying an FFT to the digital data and by measuring the amplitude of the tone at the AC LOD excitation frequency. It should be noted that the digital AC LOD can only determine the series connectivity of the two leads attached to the inputs of a differential channel, and hence the connectivity of the individual input pins can only be determined by the DC or the analog AC LOD.



**Figure 26. Simplified Digital Analog AC Lead-off Detect Block Diagram**

Figure 26 shows a simplified block diagram of the digital AC LOD. Follow the procedures below to activate the Digital AC LOD:

1. Select the Digital AC lead-off mode by setting bit SELAC\_LOD = 1 and ACAD\_LOD = 0 in the [LOD\\_CN](#) register.
2. Program the excitation frequency  $\Phi$  by using the ACDIV\_LOD and ACDIV\_FACTOR bits in the [LOD\\_AC\\_CN](#) register. See equation in [Analog AC Lead-Off Detect](#)
3. Enable which channel the digital AC LOD will be applied to by selecting the EN\_LOD[2:0] bits in the [LOD\\_EN](#) register. These bits correspond to the AFE channels CH3 to CH1 from MSB to LSB, respectively.
4. Determine the phase of the injected current to the AFE channels by programming the EN\_LOD[5:3] bits in the [LOD\\_EN](#) register.

The EN\_LOD[5:3] bits determine the phase of the injected current to the AFE channels CH3 to CH1 from MSB to LSB, respectively. A bit set to 1 means that the corresponding channel will receive an anti-phase excitation current in respect to the frequency divider's phase. In some applications, it may be necessary to invert the sign of the digital AC lead-off test current on a channel. Consider an example where the first AFE is configured through the flexible routing switch to measure the voltage between IN1 and IN2, and the second AFE is configured through the flexible routing switch to measure the voltage between IN2 and IN3.

In this configuration, if digital AC LOD test currents are applied to the inputs of both AFEs, the test current that is applied to the negative input of the first AFE and the test current that is applied to the positive input of the second AFE are both flowing through IN2. Depending on the sign of the test current in the second AFE, these currents can add up or cancel each other. If the currents add up, the system will correctly measure the differential input impedance on both AFE channels. If the currents on IN2 cancel, the test current will only flow through IN1 and IN3, and the impedance of the electrode connected to IN2 cannot be measured. To apply the digital AC LOD to CH3 and CH2, set EN\_LOD[2] = 1 and EN\_LOD[1] = 1. Then, by programming EN\_LOD[5] = 0 and EN\_LOD[4] = 1, CH3 and CH2 will receive excitation currents in-phase and anti-phase, respectively.

## CLOCK OSCILLATOR

The ADS1293 is designed to operate from a 409.6kHz clock. This clock can be generated by an on-chip crystal oscillator or provided externally on the bidirectional CLK. The high-accuracy low-power on-chip crystal oscillator will work with an external 4.096MHz crystal connected between the XTAL1 and XTAL2 pins, each of which must be loaded with a 20pF capacitor to get an accurate oscillation frequency. The output frequency of the on-chip crystal oscillator is divided by 10 to generate the required 409.6kHz clock frequency as shown in Figure 27.

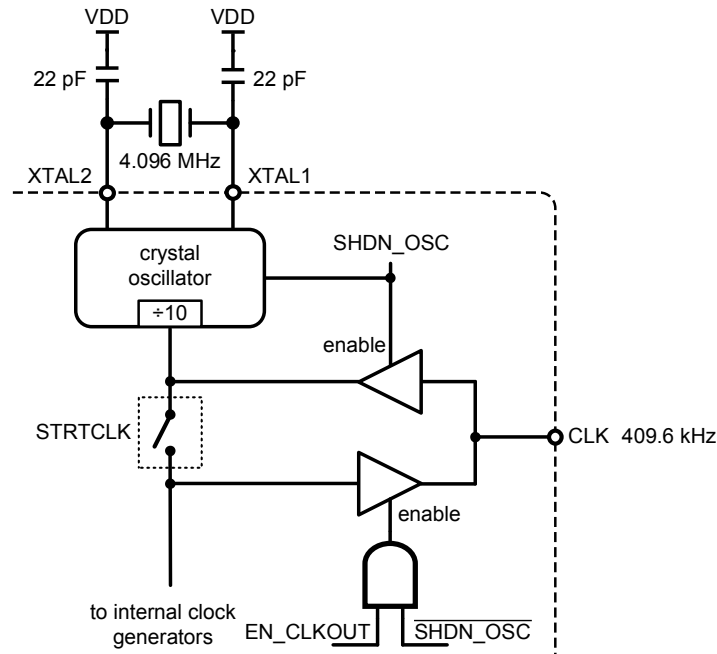


Figure 27. Block Diagram of the CLOCK

Even though the required oscillation frequency of the external crystal is rated at 4.096MHz, both the oscillator and the chip can tolerate a wider crystal oscillation frequency (3.7MHz to 4.5MHz). Note though that the output data rate and bandwidth of the SINC filters given in Table 5 through Table 8 will scale according to the crystal oscillation frequency.

When the internal clock is used, the generated clock can be brought off chip through the CLK pin. Its output driver is enabled by configuring bit EN\_CLKOUT = 1 in the OSC\_CN register, allowing a multi-chip system to operate synchronously from a single crystal oscillator. Setting bit STRTCLK = 1 allows the internal 409.6kHz clock to propagate to the digital circuitry and to the output driver of the CLK pin.

The internal crystal oscillator can be shut down to save power or when the clock of the device is provided externally. Configuring bit SHDN\_OSC = 1 powers down the internal crystal oscillator and enables the input driver of the CLK pin. The external clock should have a frequency of 409.6kHz with a duty cycle of 50% to get the SINC filter bandwidth given in Table 5 through Table 8. The chip can tolerate a wider frequency range and clock duty cycle on this pin (see the External Clock Frequency and the External Clock Duty Cycle parameters in the Clock section of the ELECTRICAL CHARACTERISTICS table) in exchange of scaling up or down the bandwidth of the SINC filters. Setting bit STRTCLK = 1 allows the external 409.6kHz clock to propagate to the digital circuitry.

The STRTCLK bit is designed to ensure all critical blocks of the chip get a clean clock start. The clock source should first be configured and allowed to start up using the SHDN\_OSC and EN\_CLKOUT bits, and subsequently, the STRTCLK bit can be set high.

The oscillator control register bits are summarized in Table 12. In a multi-chip system, the CLK pins of the master and slaves should be connected together. The master should be configured to generate a clock on the CLK pin while the slaves should use the CLK pin as a clock input source.



**Table 12. Clock Oscillator Configuration Bits**

STRTCLK	SHDN_OSC	EN_CLKOUT	CLOCK PROPAGATION
0	X	X	No clock
1	0	0	Internal clock to digital circuitry
1	0	1	Internal clock to digital circuitry and CLK pin
1	1	X	External clock to digital circuitry

## SERIAL DIGITAL INTERFACE

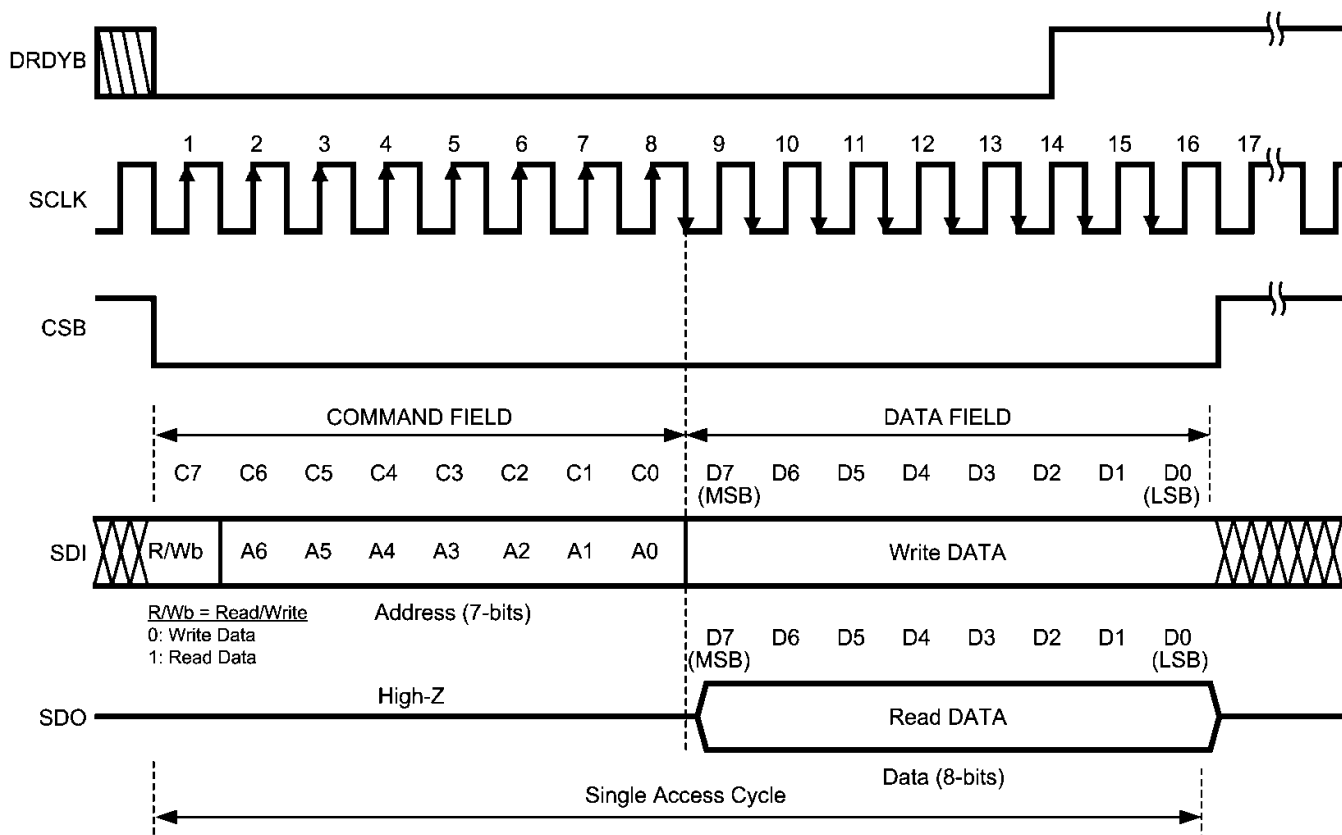
A serial peripheral interface (SPI) allows access to the control registers of the ADS1293. The serial interface is a generic 4-wire synchronous interface compatible with SPI type interfaces used on many microcontrollers and DSP controllers.

### Digital Output Drive Strength

The strength of the transistors driving the serial data out pin (SDO) can be programmed to four levels in the [DIGO\\_STRENGTH](#) register. The drive strength will affect the slope of the digital output signal edges, and the optimal drive strength will depend on the capacitive loading on the SDO pin, where larger capacitive loads require larger drive strength. The output drive strength configurability may help reduce interference from the SPI communication into the AFE signal path. In this sense, it is advised to use the lowest drive strength that works for a particular system.

### SPI Protocol

A typical serial interface access cycle is exactly 16 bits long, which includes an 8-bit command field (R/WB + 7-bit address) to provide for a maximum of 128 direct access addresses, and an 8-bit data field. [Figure 28](#) shows the access protocol used by this interface. Extended access cycles are possible and they are described in the [Auto-incrementing Address](#) and [Streaming](#) sections.

**Figure 28. Serial Interface Protocol**



Each assertion of chip select bar (CSB) starts a new register access. The R/Wb bit in the command field configures the direction of the access operation; a value of 0 indicates a write operation and a value of 1 indicates a read operation. All output data is driven on the falling edge of the serial clock (SCLK), and for the 16-bit protocol, SDO read data is driven on the falling edge of clocks 8 through 15. All input data on the serial data in (SDI) pin is sampled on the rising edge of SCLK and is written into the register on the rising edge of the 16th clock. The user is required to deassert CSB after the 16th clock; if CSB is deasserted before the 16th clock, no data write will occur.

### Random Register Access Protocol

The 16-bit protocol is useful for random address access. CSB must be asserted during 16 clock cycles of SCLK.

### Auto-incrementing Address

An access cycle may be extended to multiple registers by simply keeping the CSB asserted beyond the stated 16 clocks of the standard 16-bit protocol. In this mode, CSB must be asserted during  $8 \times (1+N)$  clock cycles of SCLK, where N is the amount of bytes to write or read during the access cycle. The auto-incrementing address mode is useful to access a block of registers of incrementing addresses.

For example, to read the pace and ECG data registers located from address 0x30 to address 0x3F and worth 16 bytes of data, follow the next steps:

1. Execute a read command to address 0x30.
2. Extend the CSB assertion during 136 clock cycles ( $8+8 \times 16$ ).

During an auto-incrementing read access, SDO outputs the register contents every 8 clock cycles after the initial 8 clocks of the command field. During an auto-incrementing write access, the data is written to the registers every 8 clock cycles after the initial 8 clocks of the command field.

Automatic address increment stops at address 0x4F for both write and read operations.

### Streaming

A read access cycle can operate in streaming mode, also referred to as loop read back mode, by performing a read operation from the [DATA\\_LOOP](#) register and extending the CSB assertion beyond the standard 16 clocks. The streaming mode is supported for the [DATA\\_STATUS](#), [DATA\\_CH1\\_PACE](#), [DATA\\_CH2\\_PACE](#), [DATA\\_CH3\\_PACE](#), [DATA\\_CH1\\_ECG](#), [DATA\\_CH2\\_ECG](#) and [DATA\\_CH3\\_ECG](#) registers described in [Pace and ECG Data Read Back Registers](#). The streaming mode is useful to access the block of pace and ECG data registers when not all data needs to be read. The channels to read in this mode are selected in the [CH\\_CNFG](#) register. In this mode, CSB must be asserted during  $8 \times (1+N)$  clock cycles, where N is the number source bytes enabled in [CH\\_CNFG](#). The source for pace data is 2 bytes long; the source for ECG data is 3 bytes long, and the source for data status is 1 byte long.

For example, to read the [DATA\\_STATUS](#), [DATA\\_CH3\\_PACE](#) and [DATA\\_CH3\\_ECG](#) registers located at address 0x30, 0x35 and 0x3D and worth 6 bytes of data, follow the next steps:

1. Write a value of 0x49 to the [CH\\_CNFG](#) register (address 0x2F).
2. Read from the [DATA\\_LOOP](#) register (address 0x50).
3. Extend the CSB assertion for 56 clock cycles ( $8+8 \times 6$ ).

## DRDYB DATA READY BAR

Data ready bar (DRDYB) is an active low output signal and is asserted when new data is ready to be read. After DRDYB is asserted and an SPI read of ECG or PACE data occurs, DRDYB will be deasserted at the 14th rising edge of SCLK.

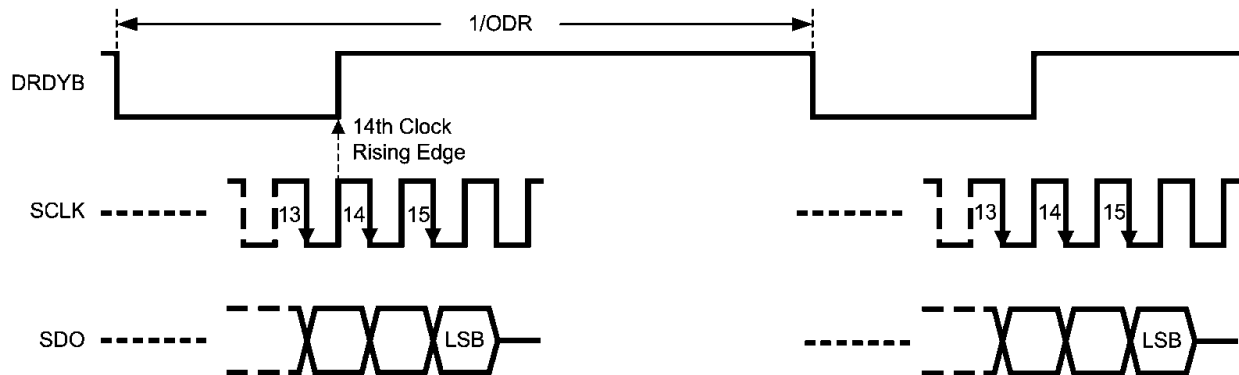


Figure 29. DRDYB Behavior for a Complete Read Operation

New data is available regardless of the serial interface being ready to read the data or not, and therefore, the data is lost if it is not read before the next DRDYB assertion. If DRDYB is asserted and the data is not read, DRDYB is automatically deasserted at least  $t_{\text{DRDYB}}$  seconds before the next DRDYB assertion. The value for  $t_{\text{DRDYB}}$  can be found in the [TIMING DIAGRAMS](#).

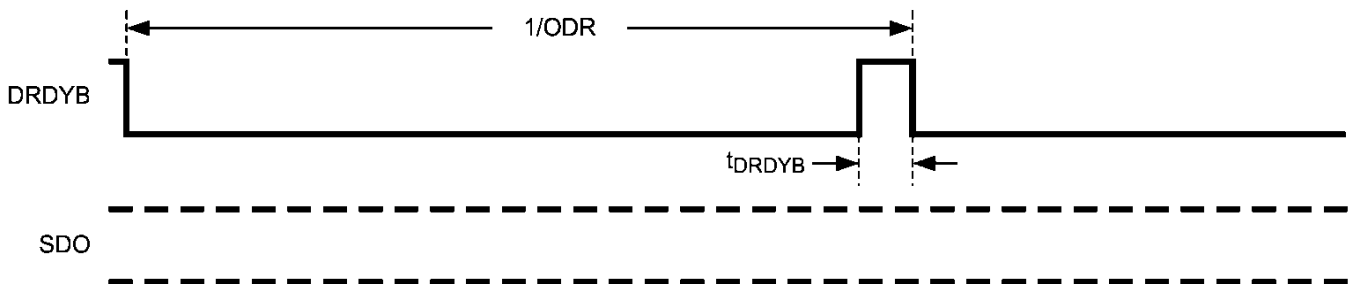


Figure 30. DRDYB Behavior for an Incomplete Read Operation

The source channel driving the assertion of the DRDYB signal can be configured in the [DRDYB\\_SRC](#) register. In order to see the DRDYB output pin asserted, one bit of this register must be set to 1 to select the digital channel to drive it. Multiple channels should not be selected to drive the DRDYB output pin, otherwise, it will result in unexpected behavior. The selected channel should not be shut down in the [AFE\\_SHDN\\_CN](#) register, and if the source is an ECG channel, its filter should not be disabled in the [DIS\\_EFILTER](#) register. It is strongly recommended to select the channel with the fastest data rate as the source for the DRDYB signal to avoid loss of data.

By default, the DRDYB signal is masked during the first few data samples after the start of a conversion or when a synchronization error is detected. If any ECG channel is enabled, DRDYB is masked during the first six data samples of the slowest enabled ECG channel. If all ECG channels are disabled, DRDYB is masked for the first six data samples of the slowest enabled pace channel when the data rate is 1xODR, and for the first eleven data samples of the slowest enabled pace channel when the data rate is 2xODR. Masking can be disabled in the [MASK\\_DRDYB](#) register.

## SYNCHRONIZATION

There are three filter timing generators implemented to support independent filter settings. Under normal conditions, the filters always start synchronized when the START\_CON bit in the [CONFIG](#) register is set to 1, and will remain synchronized. Synchronization can also be continually enforced for the eventuality of a channel losing synchronization, and it can be used in single-chip and multiple-chip systems.

## Single-chip Multi-Channel Synchronization

The filter channels are synchronized when DRDYB assertion is at a fixed frequency and new data from each source is available at some integer multiple of DRDYB. This synchronization mode requires that the fastest output data source is selected to drive DRDYB in the [DRDYB\\_SRC](#) register.

The filter channels will start synchronized if the output data rates in all channels are the same or integer multiples of each other. Synchronization between channels will be continuously enforced as long as the slowest output source is selected as the synchronization source in the [SYNCB\\_CN](#) register. The SYNCB pin output driver can be disabled in a single-chip system, regardless of the synchronization source selected, and synchronization will continue to be enforced between channels. The SYNCB output driver is disabled programming bit DIS\_SYNCBOUT=1 in the [SYNCB\\_CN](#) register.

## Multi-chip Synchronization

Synchronization in a multiple ADS1293 system is achieved when all the devices share a common clock and synchronization source. The common clock source,  $f_{OSC}$ , can be driven from the CLK pin of an ADS1293 when its CLK pin output driver is enabled in the [OSC\\_CN](#) register. The common synchronization source can be driven from the SYNCB pin of the device with the slowest data rate in the system. An ADS1293 is configured as a synchronization source by enabling its SYNCB output driver and selecting the slowest data rate channel to drive the line in the [SYNCB\\_CN](#) register. The [SYNCB\\_CN](#) register of the other devices should be programmed to 0x40 to configure their SYNCB pins as inputs. When configured as an output, SYNCB is driven on the falling edge of  $f_{OSC}$  and when configured as an input, SYNCB is sampled on the rising edge of  $f_{OSC}$ .

## Synchronization Errors

Detected synchronization events are reported to the [ERROR\\_SYNC](#) register. A phase error is generated when the phase of divided clocks of the timing generator has been adjusted to comply with the SYNCB input signal. A timing error is generated when the timing of the indicated channel has been updated to comply with the timing of the synchronization source, internal or external. By default, a synchronization error will propagate to the ALARMB output pin. Reporting of a synchronization error can be disabled in the [MASK\\_ERR](#) register.

## ALARM FUNCTIONS

The ADS1293 has multiple warning flags to diagnose possible fault conditions in the ECG monitoring application. The warning flags can be read in the [Error Status Registers](#). The system errors are filtered by the digital circuitry (see [ERROR FILTERING](#)), and for this reason, the master clock must be active for the alarms to be reflected in the error registers.

1. **ERROR\_LOD**: Indicates which input has a lead-off error. The lead-off detection was described in [LEAD-OFF DETECTION \(LOD\)](#).
2. **ERROR\_STATUS**: Contains the following error flags:
  - **SYNCEDGEERR**: This flag is raised when a synchronization error occurs, as described in [Synchronization Errors](#).
  - **CH3ERR**: This flag is raised when one of the 5 LSBs or bit 6 of the [ERROR\\_RANGE3](#) register is a logic 1. It indicates an out-of-range condition at the AFE in channel 3. These error conditions are described in [Instrumentation Amplifier Fault Detection](#) and in [Sigma Delta Modulator Fault Detection](#).
  - **CH2ERR**: See above, but for channel 2.
  - **CH1ERR**: See above, but for channel 1.
  - **LEADOFF**: This error flag is raised when one of the OUT\_LOD bits in the [ERROR\\_LOD](#) register is a logic 1.
  - **BATLOW**: This error flag is raised when the supply voltage of the ADS1293 drops below 2.7V. This can be used as a warning sign to the microcontroller that the state of charge of a supply battery is almost below levels of operation. The ADS1293 is designed to function within specification for supplies larger than 2.7V but communication the digital communication interface will work down to 2.4V so that this alarm condition can still be communicated to the microcontroller. A low battery error propagates to the ALARMB pin unless the MASK\_BATLOW bit in the [MASK\\_ERR](#) register is set to 1. System alarms are filtered by the digital circuitry (see [ERROR FILTERING](#)), and for this reason, the master clock must be active in order to capture an alarm. There is also a battery voltage monitoring feature that can be used to monitor the state of charge of the battery during normal operation described in [Battery Monitoring](#).
  - **RLDRAIL**: This error flag is raised when the output voltage of the right leg drive amplifier is approaching

the supply rails. The flag goes high when the output voltage of the common-mode detector is 200mV away from either supply rail. This condition would occur if the common-mode on the patient's body is far away from the target value and as a result the right leg drive amplifier needs to deliver a lot of charge to the patient's body to restore the common-mode voltage. In this scenario, the common-mode may still be inside the range of the instrumentation amplifier and the ECG signal may still be accurately acquired.

- **CMOR:** The CMOR error flag is raised when the output voltage of the common-mode detector is 750mV away from either supply rail. In this case, the common-mode voltage detected on the patient's body is outside of the input CMVR where the instrumentation amplifier can process the full differential input signal (see [Instrumentation Amplifier \(INA\)](#)). When this flag is raised, the ECG signal accuracy may be lost.
- 3. **ERROR\_RANGE1, ERROR\_RANGE2, ERROR\_RANGE3:** These registers contain the out-of-range error signals of the AFEs in the three channels. The flags in these registers are described in [Instrumentation Amplifier Fault Detection](#) and in [Sigma Delta Modulator Fault Detection](#).
- 4. **ERROR\_SYNC:** This register contains flags that indicate certain synchronization errors have been detected. These errors have been described in [Synchronization Errors](#).
- 5. **ERROR\_MISC:** This register contains status flags for common-mode out-of-range, right leg drive near rail and low battery errors.

## ERROR FILTERING

The alarms that are generated by the analog circuitry inside the ADS1293 are filtered by digital logic. Alarms will only be accepted if they are active for a number of consecutive digital clock cycles, which toggle on the falling edge of the 409.6kHz oscillator clock. The number of digital clock cycles that an alarm will have to be active before it is accepted is programmable between 1 and 16 counts using the [ALARM\\_FILTER](#) register. This register contains two separate filter parameters. The 4 LSBs in this register program the filtering of the lead-off detect error bits. The 4 MSBs program the filtering of the instrumentation amplifier signal out-of-range errors, the sigma-delta input over range errors, and the CMOR, RLDRAIL and BATLOW errors.

## ALARMB PIN AND ERROR MASKING

The ADS1293 has an ALARMB output pin. This open drain output will go low when a new alarm condition occurs in the [ERROR\\_STATUS](#) register. The ALARMB pin can be used as an interrupt signal to a microcontroller to warn about error conditions that can potentially corrupt the data that is being collected so that the microcontroller can take appropriate preventive action. The functionality of the ALARMB pin is flexible and programmable using the [MASK\\_ERR](#) register. This register allows masking some of the errors in the [ERROR\\_STATUS](#) register so that certain alarm events will not trigger a high to low transition on the ALARMB pin.

## ERROR REGISTER AUTOMATIC CLEARING DESCRIPTION

All error bits in the registers 0x18 through 0x1E are latched in a high state when an error occurs and will only return to zero after being read. The error bits will remember an error until the user reads the error. The sign bits in the CH1ERR, CH2ERR and CHR3ERR registers are latched on low to high transition of the DIF\_HIGH transitions in the corresponding registers. In this way, when the differential signal goes out-of-range, the sign of the signal can also be detected when the alarm register is read. Upon read, the error bits will be cleared. If the error condition has disappeared before the error is read, the error bits will remain low after being read. For all error registers, except [ERROR\\_STATUS](#), the error bits will return to their high state within a few internal clock cycles if the error condition is still present after a register read. The bits in the [ERROR\\_STATUS](#) register only respond to new errors. If an error persists after the [ERROR\\_STATUS](#) register is read, the error condition will not be reflected in the error status register and the ALARMB pin will not pulse low again.

## ALARM PROPAGATION

[Figure 31](#) shows how the alarms propagate through the digital circuitry inside the ADS1293. The errors propagate from left to right. Synchronization errors are not filtered because they are generated synchronously inside the digital circuitry, and if they occur, they are latched in the [ERROR\\_SYNC](#) register. Lead-off detect errors are filtered by a counter programmed in the 4 LSBs of the [ALARM\\_FILTER](#) register and are latched in the [ERROR\\_LOD](#) register. The instrumentation amplifier out-of-range, sigma-delta over range, right leg drive amplifier out-of-range, common-mode amplifier out-of-range and low battery signals are also filtered by a counter programmed in the MSBs of the [ALARM\\_FILTER](#) register. The out-of-range signals for the 3 channels are latched in the [ERROR\\_RANGE1](#), [ERROR\\_RANGE2](#) and [ERROR\\_RANGE3](#) registers. The first 6 registers on the right hand side of the circuit latch errors until the error is being read. After being read, the error bit will be

reset, but it will return to a logic 1 if the internal alarm condition persists. After being filtered the alarms are all routed to a digital logic block that detects whether a new alarm has occurred. If this happens, the appropriate bit in the `ERROR_STATUS` register will be set and the `ALARMB` pin will be pulled down. The bits in the `ERROR_STATUS` register will be reset and the `ALARMB` pin will be released when the `ERROR_STATUS` register is read.

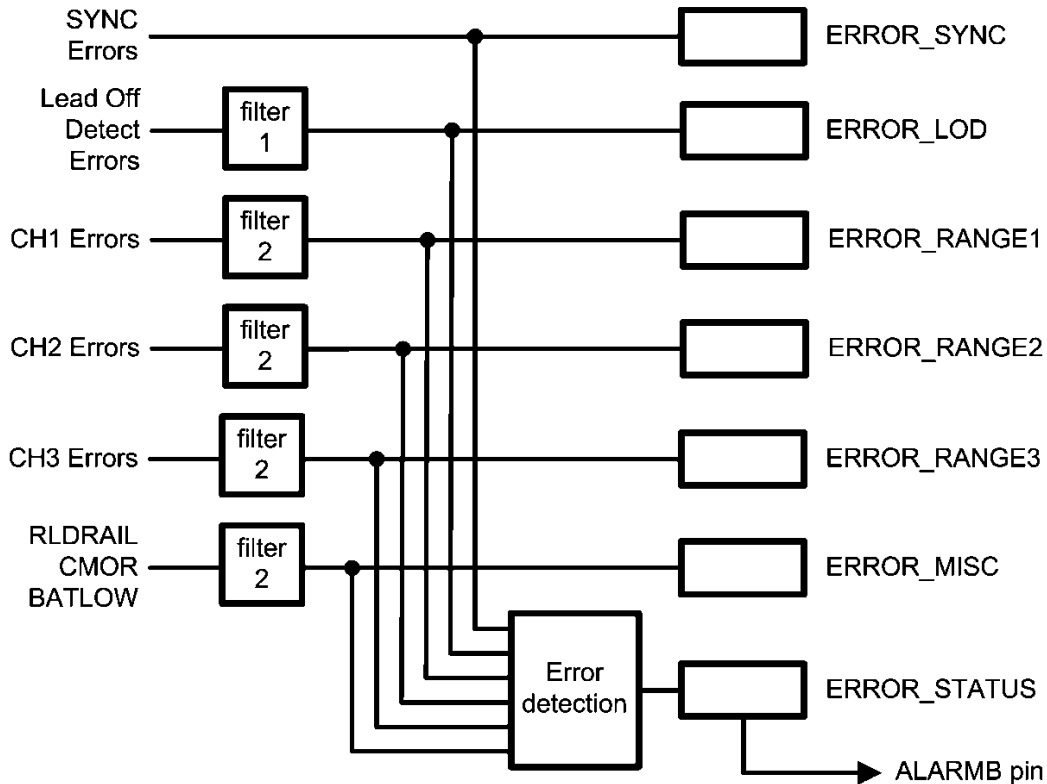


Figure 31. Graphical Illustration of Alarm Propagation

## REFERENCE VOLTAGE GENERATORS

The common-mode and right leg drive reference generates  $V_{DD}/2.2$  volts, which are present on the `RLDREF` pin. This reference is used as an internal common-mode reference, as the reference for the analog pace channel, and should be powered on at all times when a sigma delta modulator is running. It can be powered down by programming bit `SHDN_CMREF=1` in the `REF_CN` register. The `RLDREF` pin should have a  $0.1\mu\text{F}$  bypass capacitor to ground.

The internal reference,  $V_{REF}$ , generates 2.4V, which are present on the `CVREF` pin. The `CVREF` pin must have a  $1\mu\text{F}$  bypass capacitor to ground with low ESR and is not designed to be loaded with other circuitry. This reference should also be powered on at all times when a sigma delta modulator is running. It can be powered down programming bit `SHDN_REF=1` in the `REF_CN` register. It is possible to provide the reference voltage externally on this pin when the internal reference generator is shut down.

All three voltage generators require a somewhat larger start up time compared to the other circuit blocks inside the ADS1293, which is why they are treated differently in the global power down or standby states, as will be described in the next section.

## POWER MANAGEMENT

The ADS1293 has many features that allow the optimization of power consumption. The common-mode detector and right leg drive amplifier can be configured to achieve the optimum AC performance to power consumption ratio in a given application environment. Almost all internal circuit blocks can be powered down to reduce power consumption. [Table 13](#) lists the typical power consumption budget for all of the circuit blocks that can be individually powered down.

There are two master control bits, PWR\_DOWN and STANDBY, in addition to the power down control bits that are used to power down an individual circuit block, and they are located in the [CONFIG](#) register. In the power down mode, all circuits that can be powered down are powered down, irrespective of the state of their individual shutdown bits. With the PWR\_DOWN bit, the entire ADS1293 can be quickly placed in its minimal current consumption state without needing to do many individual configuration register writes. The STANDBY bit operates in a similar manner, but it does not affect the state of the three voltage generators and the crystal oscillator inside the ADS1293, which require a somewhat longer time to start up. When placing the ADS1293 in stand-by mode, the power consumption is somewhat higher than in the power down state but the ADS1293 can return to operation quicker. The difference between the current consumption in power-down and in stand-by depends on the logic state of the shutdown bits of the two reference voltage generators and the crystal oscillator, as described in [Table 13](#).

[Table 13](#) specifies the current consumption of the blocks that are always ON in the first row. The second group in the table specifies the current consumption of the two reference voltage generators and the crystal oscillator that are OFF in power-down mode but that remain active during stand-by mode. The last group of circuit blocks in the table specifies the current consumption of the other circuit blocks. The ADS1293 will need about 100ms to return to operation after being powered down. The time to recover from stand-by is limited by the time latency of the programmable logic filters in the AFE channels, as described in the [Filter Settling Time](#) section.

**Table 13. Typical Current Consumption per Block**

GLOBAL POWER CONTROL	BLOCK NAME	CONDITIONS / NOTES	CURRENT $\mu$ A
Always on	Supporting circuitry		80
Off in power down	Reference voltage generator		17
	Right leg drive reference		9
	Crystal oscillator		7
Off in standby	Instrumentation amplifier	low power, per channel	38
		high resolution, per channel	121
	Analog front end fault detect	Per channel	2
	Sigma delta modulator	102.4kHz, per channel	22
		204.8kHz, per channel	41
	Analog output channel		29
	Lead-off detect	Excluding excitation currents	25
	Wilson reference	per channel	7
	Common-mode detector	low speed, cap drive 1, 6 active leads	39
		high speed, cap drive 4, 6 active leads	79
	Right leg drive amplifier	low speed, cap drive 1	20
		high speed, cap drive 4	60



## APPLICATION INFORMATION

### EXAMPLE APPLICATIONS

#### 3-LEAD ECG APPLICATION

A 3-Lead ECG system can be implemented using two channels as shown in Figure 32. In this example, the right arm (RA), left arm (LA), left leg (LL) and right leg (RL) are connected to the IN1, IN2, IN3 and IN4 pins respectively. The ADS1293 uses the Common-Mode Detector block to measure the common-mode of the patient's body by averaging the voltage of input pins IN1, IN2 and IN3, and uses this signal in the right leg drive feedback circuit<sup>(1)</sup>. The output of the RLD amplifier is connected internally to the IN4 pin, which is connected to the right leg electrode, to drive the common-mode of the patient's body. The chip uses an external 4.096MHz crystal oscillator connected between the XTAL1 and XTAL2 pins to create the clock sources for the device.

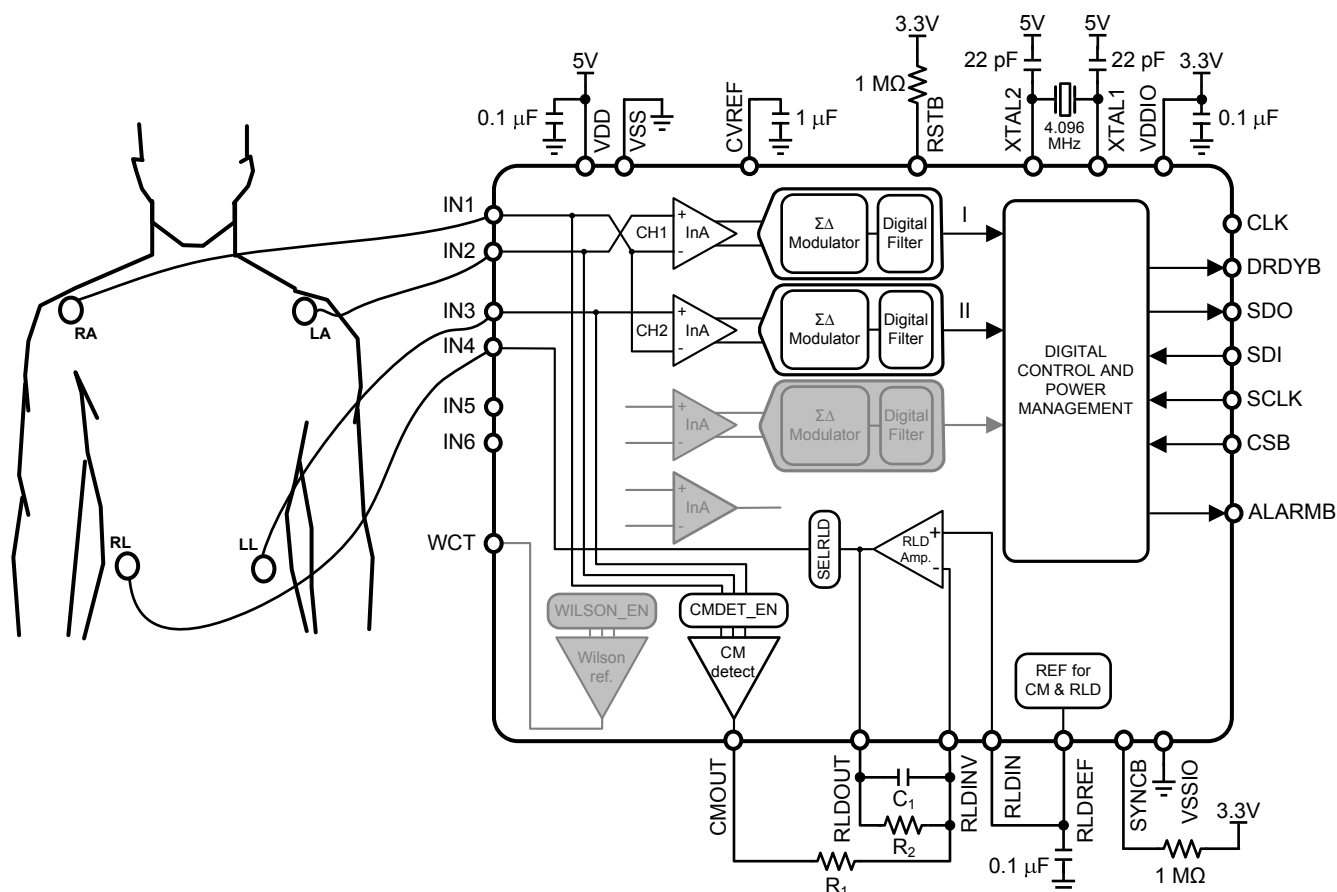


Figure 32. 3-Lead ECG Application

Follow the next steps to program the ADS1293 in a 3-lead application with an ECG bandwidth of 175Hz and an output data rate of 853Hz; it is assumed that the device registers contain their default power-up values.

1. **Set address 0x01 = 0x11:** Connects channel 1's INP to IN2 and INN to IN1.
2. **Set address 0x02 = 0x19:** Connects channel 2's INP to IN3 and INN to IN1.
3. **Set address 0x0A = 0x07:** Enables the common-mode detector on input pins IN1, IN2 and IN3.
4. **Set address 0x0C = 0x04:** Connects the output of the RLD amplifier internally to pin IN4.
5. **Set address 0x12 = 0x04:** Uses external crystal and feeds the output of the internal oscillator module to the digital.

(1) The ideal values of  $R_1$ ,  $R_2$  and  $C_1$  will vary per system/application; typical values for these components are:  $R_1 = 100k\Omega$ ,  $R_2 = 1M\Omega$  and  $C_1 = 1.5nF$ .

6. **Set address 0x14 = 0x24:** Shuts down unused channel 3's signal path.
7. **Set address 0x21 = 0x02:** Configures the R2 decimation rate as 5 for all channels.
8. **Set address 0x22 = 0x02:** Configures the R3 decimation rate as 6 for channel 1.
9. **Set address 0x23 = 0x02:** Configures the R3 decimation rate as 6 for channel 2.
10. **Set address 0x27 = 0x08:** Configures the DRDYB source to channel 1 ECG (or fastest channel).
11. **Set address 0x2F = 0x30:** Enables channel 1 ECG and channel 2 ECG for loop read-back mode.
12. **Set address 0x01 = 0x01:** Starts data conversion.

Follow the description in the [Streaming](#) section to read the data. The ADS1293 will measure lead I and lead II. Lead III can be calculated as follows:

- $\text{Lead III} = \text{Lead II} - \text{Lead I}$

Optionally, the third channel could be used to measure Lead III.



## 5-LEAD ECG APPLICATION

Figure 33 shows the ADS1293 in a 5-Lead ECG system setup. Similar to the 3-Lead application, the ADS1293 uses the Common-Mode Detector to measure the common-mode of the patient's body by averaging the voltage of input pins IN1, IN2 and IN3, and uses this signal in the right leg drive feedback circuit<sup>(2)</sup>. The output of the RLD amplifier is connected to the right leg electrode, which is IN4, to drive the common-mode of the patient's body. The Wilson Central Terminal is generated by the ADS1293 and is used as a reference to measure the chest electrode, V1. The chip uses an external 4.096MHz crystal oscillator connected between the XTAL1 and XTAL2 pins to create the clock sources for the device.

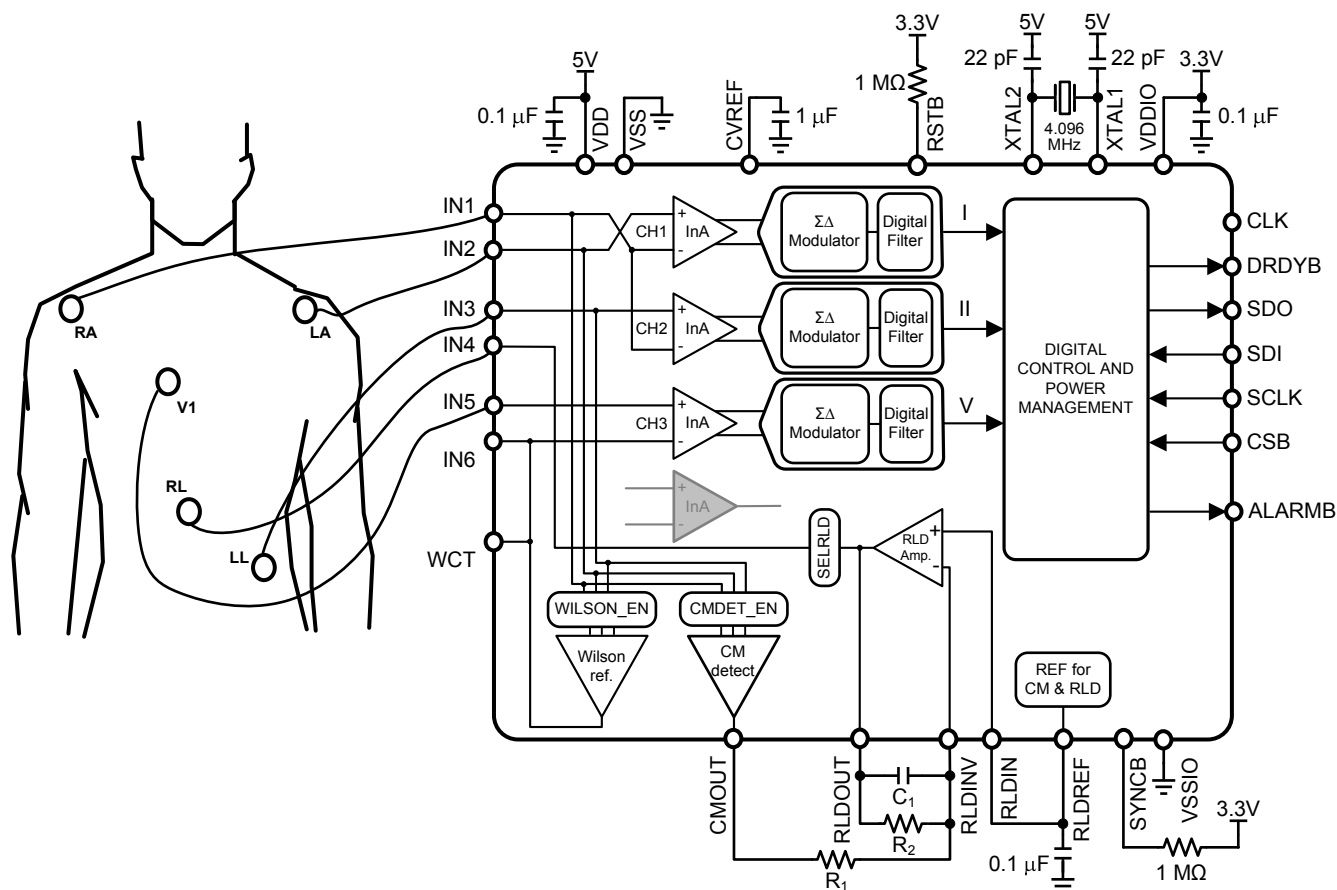


Figure 33. 5-Lead ECG Application

The following steps configure the ADS1293 for a 5-lead application with an ECG bandwidth of 175Hz and an output data rate of 853Hz; it is assumed that the device registers contain their default power-up values.

1. **Set address 0x01 = 0x11:** Connects channel 1's INP to IN2 and INN to IN1.
2. **Set address 0x02 = 0x19:** Connect channel 2's INP to IN3 and INN to IN1.
3. **Set address 0x03 = 0x2E:** Connects channel 3's INP to IN5 and INN to IN6.
4. **Set address 0x0A = 0x07:** Enables the common-mode detector on input pins IN1, IN2 and IN3.
5. **Set address 0x0C = 0x04:** Connects the output of the RLD amplifier internally to pin IN4.
6. **Set addresses 0x0D = 0x01, 0x0E = 0x02, 0x0F = 0x03:** Connects the first buffer of the Wilson reference to the IN1 pin, the second buffer to the IN2 pin, and the third buffer to the IN3 pin.
7. **Set address 0x10 = 0x01:** Connects the output of the Wilson reference internally to IN6.

(2) The ideal values of  $R_1$ ,  $R_2$  and  $C_1$  will vary per system/application; typical values for these components are:  $R_1 = 100\text{k}\Omega$ ,  $R_2 = 1\text{M}\Omega$  and  $C_1 = 1.5\text{nF}$ .

8. **Set address 0x12 = 0x04:** Uses external crystal and feeds the output of the internal oscillator module to the digital.
9. **Set address 0x21 = 0x02:** Configures the R2 decimation rate as 5 for all channels.
10. **Set address 0x22 = 0x02:** Configures the R3 decimation rate as 6 for channel 1.
11. **Set address 0x23 = 0x02:** Configures the R3 decimation rate as 6 for channel 2.
12. **Set address 0x24 = 0x02:** Configures the R3 decimation rate as 6 for channel 3.
13. **Set address 0x27 = 0x08:** Configures the DRDYB source to ECG channel 1 (or fastest channel).
14. **Set address 0x2F = 0x70:** Enables ECG channel 1, ECG channel 2, and ECG channel 3 for loop read-back mode.
15. **Set address 0x01 = 0x01:** Starts data conversion.

Follow the description in the [Streaming](#) section to read the data.

## 8/12-LEAD ECG APPLICATION

Figure 34 shows the ADS1293 master/slave setup for an 8-Lead to 12-Lead ECG system. The ADS1293 uses the Common-Mode Detector to measure the common-mode of the patient's body by averaging the voltage of input pins IN1, IN2 and IN3, and uses this signal in the right leg drive feedback circuit <sup>(3)</sup>. The output of the RLD amplifier is connected to the right leg electrode to drive the common-mode of the patient's body. The Wilson Central Terminal is generated by the ADS1293 and is used as a reference to measure the chest electrodes, V1-V6; it is strongly recommended to shield the external Wilson connections, which due to the high output impedance of the Wilson reference, is prone to pick up external interference. The master ADS1293 generates a synchronization pulse on the SYNCB pin (configured as an output). This drives the SYNCB pins (configured as inputs) of the two slave ADS1293. The master chip uses an external 4.096MHz crystal oscillator connected between the XTAL1 and XTAL2 pins to create the clock sources for the device and outputs this clock on the CLK pin.

The next steps will configure the master device; it is assumed that the device registers contain their default power-up values.

1. **Set address 0x01 = 0x11:** Connects channel 1's INP to IN2 and INN to IN1.
2. **Set address 0x02 = 0x19:** Connect channel 2's INP to IN3 and INN to IN1.
3. **Set address 0x0A = 0x07:** Enables the common-mode detector on input pins IN1, IN2 and IN3.
4. **Set address 0x0C = 0x04:** Connects the output of the RLD amplifier internally to pin IN4.
5. **Set addresses 0x0D = 0x01, 0x0E = 0x02, 0x0F = 0x03:** Connects the first buffer of the Wilson reference to the IN1 pin, the second buffer to the IN2 pin, and the third buffer to the IN3 pin.
6. **Set address 0x12 = 0x05:** Uses external crystal, feeds the output of the internal oscillator module to the digital, and enables the CLK pin output driver
7. **Set address 0x14 = 0x24:** Shuts down unused channel 3's signal path.
8. **Set address 0x21 = 0x02:** Configures the R2 decimation rate as 5 for all channels.
9. **Set address 0x22 = 0x02:** Configures the R3 decimation rate as 6 for channel 1.
10. **Set address 0x23 = 0x02:** Configures the R3 decimation rate as 6 for channel 2.
11. **Set address 0x27 = 0x08:** Configures the data-ready source to channel 1 ECG (or fastest channel).
12. **Set address 0x28 = 0x08:** Configures the synchronization source to channel 1 ECG (or slowest channel).
13. **Set address 0x2F = 0x30:** Enables ECG channel 1 and ECG channel 2 for loop read-back mode.

Next, configure the slave devices; it is assumed that the device registers contain their default power-up values. In this example, both devices will have the same configuration; therefore, they can potentially be configured in parallel by asserting the CSB signal of both chips.

14. **Set address 0x01 = 0x0C:** Connects channel 1's INP to IN1 and INN to IN4.
15. **Set address 0x02 = 0x14:** Connects channel 2's INP to IN2 and INN to IN4.
16. **Set address 0x03 = 0x1C:** Connects channel 3's INP to IN3 and INN to IN4.
17. **Set address 0x12 = 0x06:** Uses external clock signal on the CLK pin and feeds it to the digital.
18. **Set address 0x21 = 0x02:** Configures the R2 decimation rate as 5 for all channels.
19. **Set address 0x22 = 0x02:** Configures the R3 decimation rate as 6 for channel 1.
20. **Set address 0x23 = 0x02:** Configures the R3 decimation rate as 6 for channel 2.
21. **Set address 0x24 = 0x02:** Configures the R3 decimation rate as 6 for channel 3.
22. **Set address 0x27 = 0x00:** DRDYB pin not asserted by slave devices.
23. **Set address 0x28 = 0x40:** Disables SYNCB driver and configures pin as input.
24. **Set address 0x2F = 0x70:** Enables ECG channel 1, ECG channel 2, and ECG channel 3 for loop read-back mode.

(3) The ideal values of  $R_1$ ,  $R_2$  and  $C_1$  will vary per system/application; typical values for these components are:  $R_1 = 100k\Omega$ ,  $R_2 = 1M\Omega$  and  $C_1 = 1.5nF$ .

Finally, start the conversion. This should be written to all three chips.

25. **Set address 0x00 = 0x01:** Starts data conversion (repeat this step for every device).

The three devices will run synchronously using the SYNCB signal. Follow the description in the [Streaming](#) section to read the data. The ADS1293 measures lead I, lead II and leads V1-V6. For a 12-lead application, the remaining 4 leads can be calculated as follows:

- $\text{Lead III} = \text{Lead II} - \text{Lead I}$
- $\text{aVR} = - ( \text{I} + \text{II} ) / 2$
- $\text{aVL} = \text{I} - \text{II} / 2$
- $\text{aVF} = \text{II} - \text{I} / 2$



## Simultaneous ECG and PACE data read

Each of the three digital channels of the ADS1293 provides a high-performance path for ECG monitoring and a lower resolution path for monitoring of pace-maker signals. The digitized signals from these two paths can be read simultaneously from the [Pace and ECG Data Read Back Registers](#).

The ECG signal path achieves higher resolution than the PACE signal path by having one extra filtering stage (as shown in [Figure 18](#)). Due to the difference in filtering stages of the two paths, the PACE data is available for reading at a much higher rate than the ECG data. In this sense, the PACE channel must be selected as the driving source of the DRDYB signal.

In the [Streaming](#) mode, the data from the DATA\_LOOP register should be read after the DRDYB line is asserted; this means that new data is available. In order to read both ECG and PACE data from the DATA\_LOOP register, the channels of interest must be enabled in the [CH\\_CNFG](#) register.

As an example, the [3-LEAD ECG APPLICATION](#) can be reconfigured to perform simultaneous ECG and PACE data reads from channel 1:

1. **Set address 0x00 = 0x00:** Stops data conversion (if any).
2. **Set address 0x2F = 0x32:** Enables channel 1 PACE, channel 1 ECG, and channel 2 ECG for loop read-back mode
3. **Set address 0x27 = 0x01:** Reconfigures the DRDYB source to channel 1 PACE .
4. **Set address 0x00 = 0x01:** Starts data conversion.

In this case, new PACE data from channel 1 is available on every DRDYB assertion; ECG data from channel 1 and channel 2, on the other hand, is available every six DRDYB assertions (R3\_RATE\_CH1 = R3\_RATE\_CH2 = 6).

There are different approaches for handling simultaneous ECG and PACE data read. One approach is to read ECG data every time that PACE data is ready, over-sampling the ECG channel. This is possible because old conversion values are retained in the data registers until new data overwrites them.

A second approach is to also read the [DATA\\_STATUS](#) register. Continuing from the steps above:

5. **Set address 0x00 = 0x00:** Stops data conversion.
6. **Set address 0x2F = 0x33:** Enables data ready status, channel 1 PACE, channel 1 ECG, and channel 2. ECG for loop read-back mode
7. **Set address 0x00 = 0x01:** Starts data conversion.

The [DATA\\_STATUS](#) register indicates the channel(s) that are updated at a given DRDYB assertion; this information can potentially be used to discard irrelevant data.

A third and more complex approach is to continuously reprogram the [CH\\_CNFG](#) register based on the contents of [DATA\\_STATUS](#) register. The [CH\\_CNFG](#) register should be reprogrammed to read PACE+ECG data only when the [DATA\\_STATUS](#) register indicates ECG data is available. After reading the PACE+ECG data, the [CH\\_CNFG](#) register should be reprogrammed back to reading only the [DATA\\_STATUS](#) register and the PACE data. In this case, the ECG data is not oversampled and the SPI communication can be significantly reduced for cases where a decimation rate, R3\_RATE\_CHx, is large. The reconfiguration of the [CH\\_CNFG](#) register should be done before the next DRDYB assertion to avoid losing data.

## REGISTERS

1. If written to, RESERVED bits must be written to 0 unless otherwise indicated.
2. Read back value of RESERVED bits and registers is unspecified and should be discarded.
3. Recommended values must be programmed and forbidden values must be not be programmed where they are indicated in order to avoid unexpected results.
4. If written to, registers indicated as Reserved must have the indicated default value as shown in the register map. Any other value can cause unexpected results.

### Register map

REGISTER NAME	DESCRIPTION	ADDRESS	ACCESS	DEFAULT
<b>Operation Mode Registers</b>				
CONFIG	Main Configuration	0x00	R/W	0x02
<b>Input Channel Selection Registers</b>				
FLEX_CH1_CN	Flex Routing Switch Control for Channel 1	0x01	R/W	0x00
FLEX_CH2_CN	Flex Routing Switch Control for Channel 2	0x02	R/W	0x00
FLEX_CH3_CN	Flex Routing Switch Control for Channel 3	0x03	R/W	0x00
FLEX_PACE_CN	Flex Routing Switch Control for Pace Channel	0x04	R/W	0x00
FLEX_VBAT_CN	Flex Routing Switch for Battery Monitoring	0x05	R/W	0x00
<b>Lead-off Detect Control Registers</b>				
LOD_CN	Lead-Off Detect Control	0x06	R/W	0x08
LOD_EN	Lead-Off Detect Enable	0x07	R/W	0x00
LOD_CURRENT	Lead-Off Detect Current	0x08	R/W	0x00
LOD_AC_CN	AC Lead-Off Detect Control	0x09	R/W	0x00
<b>Common-Mode Detection and Right Leg Drive Feedback Control Registers</b>				
CMDT_EN	Common-Mode Detect Enable	0x0A	R/W	0x00
CMDT_CN	Common-Mode Detect Control	0x0B	R/W	0x00
RLD_CN	Right Leg Drive Control	0x0C	R/W	0x00
<b>Wilson Control Registers</b>				
WILSON_EN1	Wilson Reference Input one Selection	0x0D	R/W	0x00
WILSON_EN2	Wilson Reference Input two Selection	0x0E	R/W	0x00
WILSON_EN3	Wilson Reference Input three Selection	0x0F	R/W	0x00
WILSON_CN	Wilson Reference Control	0x10	R/W	0x00
<b>Reference Registers</b>				
REF_CN	Internal Reference Voltage Control	0x11	R/W	0x00
<b>OSC Control Registers</b>				
OSC_CN	Clock Source and Output Clock Control	0x12	R/W	0x00
<b>AFE Control Registers</b>				
AFE_RES	Analog Front-End Frequency and Resolution	0x13	R/W	0x00
AFE_SHDN_CN	Analog Front-End Shutdown Control	0x14	R/W	0x00
AFE_FAULT_CN	Analog Front-End Fault Detection Control	0x15	R/W	0x00
RESERVED	—	0x16	R/W	0x00
AFE_PACE_CN	Analog Pace Channel Output Routing Control	0x17	R/W	0x01
<b>Error Status Registers</b>				
ERROR_LOD	Lead-Off Detect Error Status	0x18	RO	—
ERROR_STATUS	Other Error Status	0x19	RO	—
ERROR_RANGE1	Channel 1 AFE Out-of-Range Status	0x1A	RO	—
ERROR_RANGE2	Channel 2 AFE Out-of-Range Status	0x1B	RO	—
ERROR_RANGE3	Channel 3 AFE Out-of-Range Status	0x1C	RO	—
ERROR_SYNC	Synchronization Error	0x1D	RO	—

REGISTER NAME	DESCRIPTION	ADDRESS	ACCESS	DEFAULT
ERROR_MISC	Miscellaneous Errors	0x1E	RO	0x00
<b>Digital Registers</b>				
DIGO_STRENGTH	Digital Output Drive Strength	0x1F	R/W	0x03
R2_RATE	R2 Decimation Rate	0x21	R/W	0x08
R3_RATE_CH1	R3 Decimation Rate for Channel 1	0x22	R/W	0x80
R3_RATE_CH2	R3 Decimation Rate for Channel 2	0x23	R/W	0x80
R3_RATE_CH3	R3 Decimation Rate for Channel 3	0x24	R/W	0x80
R1_RATE	R1 Decimation Rate	0x25	R/W	0x00
DIS_EFILTER	ECG Filter Disable	0x26	R/W	0x00
DRDYB_SRC	Data Ready Pin Source	0x27	R/W	0x00
SYNCB_CN	SYNCB In/Out Pin Control	0x28	R/W	0x40
MASK_DRDYB	Optional Mask Control for DRDYB Output	0x29	R/W	0x00
MASK_ERR	Mask Error on ALARMB Pin	0x2A	R/W	0x00
Reserved	—	0x2B	—	0x00
Reserved	—	0x2C	—	0x00
Reserved	—	0x2D	—	0x09
ALARM_FILTER	Digital Filter for Analog Alarm Signals	0x2E	R/W	0x33
CH_CNFG	Configure Channel for Loop Read Back Mode	0x2F	R/W	0x00
<b>Pace and ECG Data Read Back Registers</b>				
DATA_STATUS	ECG and Pace Data Ready Status	0x30	RO	—
DATA_CH1_PACE	Channel 1 Pace Data	0x31 0x32	RO	—
DATA_CH2_PACE	Channel 2 Pace Data	0x33 0x34	RO	—
DATA_CH3_PACE	Channel 3 Pace Data	0x35 0x36	RO	—
DATA_CH1_ECG	Channel 1 ECG Data	0x37 0x38 0x39	RO	—
DATA_CH2_ECG	Channel 2 ECG Data	0x3A 0x3B 0x3C	RO	—
DATA_CH3_ECG	Channel 3 ECG Data	0x3D 0x3E 0x3F	RO	—
REVID	Revision ID	0x40	RO	0x01
DATA_LOOP	Loop Read Back Address	0x50	RO	—



## Operation Mode Registers

**Table 14. CONFIG: Main Configuration**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x00						PWR_DOWN	STANDBY	START_CON

[7:3] RESERVED —

[2] **PWR\_DOWN** **Power-down mode**  
0: Disabled (default)  
1: Circuit powered down

[1] **STANDBY** **Stand-by mode**  
0: Disabled  
1: Most circuits powered down (default)

[0] **START\_CON** **Start conversion**  
0: Disabled (default)  
1: Conversion active  
Note: Programming START\_CON = 1 locks write access to registers 0x11, 0x12, 0x13 and 0x21–0x29.

## Input Channel Selection Registers

**Table 15. FLEX\_CH1\_CN: Flex Routing Switch Control for Channel 1**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x01	TST1		POS1			NEG1		

[7:6] **TST1** **Test signal selector**  
00: Test signal disconnected and CH1 inputs determined by POS1 and NEG1 (default)  
01: Connect channel one to positive test signal  
10: Connect channel one to negative test signal  
11: Connect channel one to zero test signal

[5:3] **POS1** **Positive terminal of channel 1**  
000: Positive terminal is disconnected (default)  
001: Positive terminal connected to input IN1  
010: Positive terminal connected to input IN2  
011: Positive terminal connected to input IN3  
100: Positive terminal connected to input IN4  
101: Positive terminal connected to input IN5  
110: Positive terminal connected to input IN6

[2:0] **NEG1** **Negative terminal of channel 1**  
000: Negative terminal is disconnected (default)  
001: Negative terminal connected to input IN1  
010: Negative terminal connected to input IN2  
011: Negative terminal connected to input IN3  
100: Negative terminal connected to input IN4  
101: Negative terminal connected to input IN5  
110: Negative terminal connected to input IN6

**Table 16. FLEX\_CH2\_CN: Flex Routing Switch Control for Channel 2**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x02	TST2		POS2			NEG2		

- [7:6] TST2 Test signal selector**  
 00: Test signal disconnected and CH2 inputs determined by POS2 and NEG2 (default)  
 01: Connect channel two to positive test signal  
 10: Connect channel two to negative test signal  
 11: Connect channel two to zero test signal
- [5:3] POS2 Positive terminal of channel 2**  
 000: Positive terminal is disconnected (default)  
 001: Positive terminal connected to input IN1  
 010: Positive terminal connected to input IN2  
 011: Positive terminal connected to input IN3  
 100: Positive terminal connected to input IN4  
 101: Positive terminal connected to input IN5  
 110: Positive terminal connected to input IN6
- [2:0] NEG2 Negative terminal of channel 2**  
 000: Negative terminal is disconnected (default)  
 001: Negative terminal connected to input IN1  
 010: Negative terminal connected to input IN2  
 011: Negative terminal connected to input IN3  
 100: Negative terminal connected to input IN4  
 101: Negative terminal connected to input IN5  
 110: Negative terminal connected to input IN6

**Table 17. FLEX\_CH3\_CN: Flex Routing Switch Control for Channel 3**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x03	TST3		POS3			NEG3		

- [7:6] TST3 Test signal selector**  
 00: Test signal disconnected and CH3 inputs determined by POS3 and NEG3 (default)  
 01: Connect channel three to positive test signal  
 10: Connect channel three to negative test signal  
 11: Connect channel three to zero test signal
- [5:3] POS3 Positive terminal of channel 3**  
 000: Positive terminal is disconnected (default)  
 001: Positive terminal connected to input IN1  
 010: Positive terminal connected to input IN2  
 011: Positive terminal connected to input IN3  
 100: Positive terminal connected to input IN4  
 101: Positive terminal connected to input IN5  
 110: Positive terminal connected to input IN6
- [2:0] NEG3 Negative terminal of channel 3**  
 000: Negative terminal is disconnected (default)  
 001: Negative terminal connected to input IN1  
 010: Negative terminal connected to input IN2  
 011: Negative terminal connected to input IN3  
 100: Negative terminal connected to input IN4  
 101: Negative terminal connected to input IN5  
 110: Negative terminal connected to input IN6

**Table 18. FLEX\_PACE\_CN: Flex Routing Switch Control for Pace Channel**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x04	TST4		POS4			NEG4		

- [7:6] TST4 Test signal selector**  
00: Test signal disconnected and PACE inputs determined by POS4 and NEG4 (default)  
01: Connect pace channel to positive test signal  
10: Connect pace channel to negative test signal  
11: Connect pace channel to zero test signal
- [5:3] POS4 Positive terminal of pace channel**  
000: Positive terminal is disconnected (default)  
001: Positive terminal connected to input IN1  
010: Positive terminal connected to input IN2  
011: Positive terminal connected to input IN3  
100: Positive terminal connected to input IN4  
101: Positive terminal connected to input IN5  
110: Positive terminal connected to input IN6
- [2:0] NEG4 Negative terminal of pace channel**  
000: Negative terminal is disconnected (default)  
001: Negative terminal connected to input IN1  
010: Negative terminal connected to input IN2  
011: Negative terminal connected to input IN3  
100: Negative terminal connected to input IN4  
101: Negative terminal connected to input IN5  
110: Negative terminal connected to input IN6

**Table 19. FLEX\_VBAT\_CN: Flex Routing Switch for Battery Monitoring**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x05						VBAT_ MONI_CH3	VBAT_ MONI_CH2	VBAT_ MONI_CH1

- [7:3] RESERVED —**
- [2] VBAT\_MONI\_CH3 Battery monitor configuration for channel 3**  
0: Battery voltage monitor disabled (default)  
1: Battery voltage monitor enabled and overrides FLEX\_CH3\_CN register
- [1] VBAT\_MONI\_CH2 Battery monitor configuration for channel 2**  
0: Battery voltage monitor disabled (default)  
1: Battery voltage monitor enabled and overrides FLEX\_CH2\_CN register
- [0] VBAT\_MONI\_CH1 Battery monitor configuration for channel 1**  
0: Battery voltage monitor disabled (default)  
1: Battery voltage monitor enabled and overrides FLEX\_CH1\_CN register

Note: The INA of the corresponding monitoring channel must be shut down in 0x14.

## Lead-Off Detect Control Registers

**Table 20. LOD\_CN: Lead-Off Detect Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x06				ACAD_LOD	SHDN_LOD	SELAC_LOD	ACLVL_LOD	

[7:5] RESERVED —

[4] ACAD\_LOD **AC analog/digital lead-off mode select**

0: Digital AC lead-off detect (default)

1: Analog AC lead-off detect

[3] SHDN\_LOD **Shut down lead-off detection**

0: Lead-off detection circuitry is active

1: Lead-off detection circuitry is shut down (default)

[2] SELAC\_LOD **Lead-off detect operation mode**

0: DC lead-off mode (default)

1: AC lead-off mode

[1:0] ACLVL\_LOD **Programmable comparator trigger level for AC lead-off detection**

00: Level 1 (default)

01: Level 2

10: Level 3

11: Level 4

**Table 21. LOD\_EN: Lead-Off Detect Enable**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x07								EN_LOD

[7:6] **RESERVED** —

- [5] **EN\_LOD\_6** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN6.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled  
**Digital AC Lead-off-Detection:**  
 These bits configure the phase of the current injected into channel CH3.  
 0: In-phase (default)  
 1: Anti-phase
- [4] **EN\_LOD\_5** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN5.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled  
**Digital AC Lead-off-Detection:**  
 These bits configure the phase of the current injected into channel CH2.  
 0: In-phase (default)  
 1: Anti-phase
- [3] **EN\_LOD\_4** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN4.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled  
**Digital AC Lead-off-Detection:**  
 These bits configure the phase of the current injected into channel CH1.  
 0: In-phase (default)  
 1: Anti-phase
- [2] **EN\_LOD\_3** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN3.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled  
**Digital AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for channel CH3.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled
- [1] **EN\_LOD\_2** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN2.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enable  
**Digital AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for channel CH2.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled
- [0] **EN\_LOD\_1** **DC or Analog AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for input IN1.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enable  
**Digital AC Lead-off-Detection:**  
 These bits enable the lead-off-detection for channel CH1.  
 0: Lead-off detection disabled (default)  
 1: Lead-off detection enabled

**Table 22. LOD\_CURRENT: Lead-Off Detect Current**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x08	CUR_LOD							

**[7:0] CUR\_LOD Lead-off detect current select**

The lead-off detect current is programmable in a range of 2.04μA with steps of 8nA.

00000000: 0.000 μA (default)

00000001: 0.008 μA

..

..

11111110: 2.032 μA

11111111: 2.040 μA

**Table 23. LOD\_AC\_CN: AC Lead-Off Detect Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x09	ACDIV_FACTOR	ACDIV_LOD						

**[7] ACDIV\_FACTOR AC lead off test frequency division factor**

0: Clock divider factor K = 1 (default)

1: Clock divider factor K = 16

**[6:0] ACDIV\_LOD Clock divider ratio for AC lead off**

There are 7 bits available to program the clock divider that generates the AC lead off test frequency.

**Common-Mode Detection and Right Leg Drive Common-Mode Feedback Control Registers****Table 24. CMDET\_EN: Common-Mode Detect Enable**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0A			CMDET_EN_IN6	CMDET_EN_IN5	CMDET_EN_IN4	CMDET_EN_IN3	CMDET_EN_IN2	CMDET_EN_IN1

**[7:6] RESERVED —****[5:0] CMDET\_EN\_INx Common-mode detect input enable**

There is one bit available per input pin, where the MSB corresponds to input pin IN6 and the LSB corresponds to input pin IN1.

0: Disable (default)

1: Enable the corresponding pin's voltage to contribute to the average voltage of the common-mode detect block.

**Table 25. CMDET\_CN: Common-Mode Detect Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0B						CMDET_BW	CMDET_CAPDRIVE	

**[7:6] RESERVED —****[2] CMDET\_BW Common-mode detect bandwidth mode**

0: Low bandwidth mode (default)

1: High bandwidth mode

**[1:0] CMDET\_CAPDRIVE Common-mode detect capacitive load drive capability**

00: Low cap-drive mode (default)

01: Medium low cap-drive mode

10: Medium high cap-drive mode

11: High cap-drive mode

**Table 26. RLD\_CN: Right Leg Drive Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0C		RLD_BW		RLD_CAPDRIVE	SHDN_RLD		SELRLD	

[7]	RESERVED	—
[6]	RLD_BW	<b>Right leg drive bandwidth mode</b> 0: Low bandwidth mode (default) 1: High bandwidth mode
[5:4]	RLD_CAPDRIVE	<b>Right leg drive capacitive load drive capability</b> 00: Low cap-drive mode (default) 01: Medium low cap-drive mode 10: Medium high cap-drive mode 11: High cap-drive mode
[3]	SHDN_RLD	<b>Shut down right leg drive amplifier</b> 0: RLD amplifier powered up (default) 1: RLD amplifier powered down
[2:0]	SELRLD	<b>Right leg drive multiplexer</b> 000: Right leg drive output disconnected (default) 001: Right leg drive output connected to IN1 010: Right leg drive output connected to IN2 011: Right leg drive output connected to IN3 100: Right leg drive output connected to IN4 101: Right leg drive output connected to IN5 110: Right leg drive output connected to IN6

## Wilson Control Registers

**Table 27. WILSON\_EN1: Wilson Reference Input one Selection**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0D							SELWILSON1	

[7]	RESERVED	—
[2:0]	SELWILSON1	<b>Wilson reference routing for the first buffer amplifier</b> 000: No connection to the first buffer amplifier (default) 001: First buffer amplifier connected to input IN1 010: First buffer amplifier connected to input IN2 011: First buffer amplifier connected to input IN3 100: First buffer amplifier connected to input IN4 101: First buffer amplifier connected to input IN5 110: First buffer amplifier connected to input IN6

**Table 28. WILSON\_EN2: Wilson Reference Input two Selection**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0E							SELWILSON2	

[7:3]	RESERVED	—
[2:0]	SELWILSON2	<b>Wilson reference routing for the second buffer amplifier</b> 000: No connection to the second buffer amplifier (default) 001: Second buffer amplifier connected to input IN1 010: Second buffer amplifier connected to input IN2 011: Second buffer amplifier connected to input IN3 100: Second buffer amplifier connected to input IN4 101: Second buffer amplifier connected to input IN5 110: Second buffer amplifier connected to input IN6

**Table 29. WILSON\_EN3: Wilson Reference Input three Selection**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x0F							SELWILSON3	

[7:3] RESERVED —

[2:0] SELWILSON3 **Wilson reference routing for the third buffer amplifier**

000: No connection to the third buffer amplifier (default)

001: Third buffer amplifier connected to input IN1

010: Third buffer amplifier connected to input IN2

011: Third buffer amplifier connected to input IN3

100: Third buffer amplifier connected to input IN4

101: Third buffer amplifier connected to input IN5

110: Third buffer amplifier connected to input IN6

**Table 30. WILSON\_CN: Wilson Reference Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x10							GOLDINT	WILSONINT

[7:2] RESERVED —

[1] GOLDINT **Goldberger reference routing**

0: Goldberger reference disabled (default)

1: Goldberger reference outputs internally connected to IN4, IN5 and IN6

Note: GOLDINT bit can not be 1 when WILSONINT is 1.

[0] WILSONINT **Wilson reference routing**

0: Wilson reference output internally disconnected from IN6 (default)

1: Wilson reference output internally connected to IN6

Note: WILSONINT bit can not be 1 when GOLDINT is 1.

## Reference Registers

**Table 31. REF\_CN: Internal Reference Voltage Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x11							SHDN_CMREF	SHDN_REF

[7:2] RESERVED —

[1] SHDN\_CMREF **Shut down the common-mode and right leg drive reference voltage circuitry**

0: CM and RLD reference voltage is on (default)

1: Shut down CM and RLD reference voltage

Note: Enable this bit to save power when the analog block is shut down (SHDN\_REF = 1).

Power-down mode automatically shuts down the common-mode and right leg drive reference.

[0] SHDN\_REF **Shut down internal 2.4V reference voltage**

0: Internal reference voltage is on (default)

1: Shut down internal reference voltage

Note: Enabling this bit allows driving the IC with an external reference voltage on the CVREF pin. Power-down mode automatically shuts down the internal 2.4V reference.



## OSC Control Registers

**Table 32. OSC\_CN: Clock Source and Output Clock Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x12						STRTCLK	SHDN_OSC	EN_CLKOUT

[7:3]	RESERVED	—
[2]	STRTCLK	<b>Start the clock</b> 0: Clock to digital disabled (default) 1: Enable clock to digital Note: Set this bit high only after the oscillator has started up or after the oscillator has shut down and the external clock has started up.
[1]	SHDN_OSC	<b>Select clock source</b> 0: Use internal clock with external crystal on XTAL1 and XTAL2 pins (default) 1: Shut down internal oscillator and use external clock from CLK pin Note: STRTCLK bit should be low at the time this bit is reconfigured.
[0]	EN_CLKOUT	<b>Enable CLK pin output driver</b> 0: Clock output driver disabled (default) 1: Clock output driver enabled

## AFE Control Registers

**Table 33. AFE\_RES: Analog Front-End Frequency and Resolution**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x13			FS_HIGH_CH3	FS_HIGH_CH2	FS_HIGH_CH1	EN_HIRES_CH3	EN_HIRES_CH2	EN_HIRES_CH1

[7:6]	RESERVED	—
[5]	FS_HIGH_CH3	<b>Clock frequency for channel 3</b> 0: 102400Hz (default) 1: 204800Hz
[4]	FS_HIGH_CH2	<b>Clock frequency for channel 2</b> 0: 102400Hz (default) 1: 204800Hz
[3]	FS_HIGH_CH1	<b>Clock frequency for channel 1</b> 0: 102400Hz (default) 1: 204800Hz
[2]	EN_HIRES_CH3	<b>High resolution mode for channel 3 instrumentation amplifier</b> 0: Disabled (default) 1: Enabled
[1]	EN_HIRES_CH2	<b>High resolution mode for channel 2 instrumentation amplifier</b> 0: Disabled (default) 1: Enabled
[0]	EN_HIRES_CH1	<b>High resolution mode for channel 1 instrumentation amplifier</b> 0: Disabled (default) 1: Enabled

**Table 34. AFE\_SHDN\_CN: Analog Front-End Shutdown Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x14			SHDN_ SDM_CH3	SHDN_ SDM_CH2	SHDN_ SDM_CH1	SHDN_ INA_CH3	SHDN_ INA_CH2	SHDN_ INA_CH1

[7:6]	RESERVED	—
[5]	SHDN_SDM_CH3	<b>Shut down the sigma-delta modulator for channel 3</b> 0: Active (default) 1: Shut down
[4]	SHDN_SDM_CH2	<b>Shut down the sigma-delta modulator for channel 2</b> 0: Active (default) 1: Shut down
[3]	SHDN_SDM_CH1	<b>Shut down the sigma-delta modulator for channel 1</b> 0: Active (default) 1: Shut down
[2]	SHDN_INA_CH3	<b>Shut down the instrumentation amplifier for channel 3</b> 0: Active (default) 1: Shut down
[1]	SHDN_INA_CH2	<b>Shut down the instrumentation amplifier for channel 2</b> 0: Active (default) 1: Shut down
[0]	SHDN_INA_CH1	<b>Shut down the instrumentation amplifier for channel 1</b> 0: Active (default) 1: Shut down

**Table 35. AFE\_FAULT\_CN: Analog Front-End Fault Detection Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x15						SHDN_ FAULTDET_ CH3	SHDN_ FAULTDET_ CH2	SHDN_ FAULTDET_ CH1

[7:3]	RESERVED	—
[2]	SHDN_ FAULTDET_CH3	<b>Disable the instrumentation amplifier fault detection for channel 3</b> 0: Fault detection active (default) 1: Disable the fault detection
[1]	SHDN_ FAULTDET_CH2	<b>Disable the instrumentation amplifier fault detection for channel 2</b> 0: Active (default) 1: Disable the fault detection
[0]	SHDN_ FAULTDET_CH1	<b>Disable the instrumentation amplifier fault detection for channel 1</b> 0: Active (default) 1: Disable the fault detection

**Table 36. AFE\_PACE\_CN: Analog Pace Channel Output Routing Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x17						PACE2RLDIN	PACE2WCT	SHDN_PACE

[7:3] **RESERVED** —

[2] **PACE2RLDIN** **Connect the analog pace channel output to RLDIN pin**  
0: Analog pace channel output is disconnected from the RLDIN pin (default)  
1: Connect the analog pace channel output to the RLDIN pin.  
Note: The right leg drive amplifier is disconnected from the RLDIN pin and connected internally to the RLDREF pin when this bit is 1.

[1] **PACE2WCT** **Connect the analog pace channel output to WCT pin**  
0: Analog pace channel output is disconnected from the WCT pin (default)  
1: Connect the analog pace channel output to the WCT pin.  
Note: The Wilson reference output is disconnected from the WCT pin when this bit is 1. The Wilson output can be connected internally to IN6 pin with the *WILSON\_CN* register.

[0] **SHDN\_PACE** **Shut down analog pace channel**  
0: Analog pace channel is powered up  
1: Analog pace channel is shut down (default)

## Error Status Registers

**Table 37. ERROR\_LOD: Lead Off Detect Error Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x18								OUT_LOD

[7:6] **RESERVED** —

[5:0] **OUT\_LOD** **Lead Off Detect Status**  
There is one bit available per input pin, where the MSB corresponds to input pin IN6 and the LSB corresponds to input pin IN1.  
1: Indicates a lead off error detected on the corresponding input pin.

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

**Table 38. ERROR\_STATUS: Other Error Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x19	SYNC_EDGEERR	CH3ERR	CH2ERR	CH1ERR	LEADOFF	BATLOW	RLDRAIL	CMOR

[7]	<b>SYNCEDGEERR</b>	<b>Digital synchronization error</b> 1: Indicates a digital synchronization error occurred
[6]	<b>CH3ERR</b>	<b>Channel 3 out-of-range error</b> 1: Indicates an out-of-range error detected on channel 3
[5]	<b>CH2ERR</b>	<b>Channel 2 out-of-range error</b> 1: Indicates an out-of-range error detected on channel 2
[4]	<b>CH1ERR</b>	<b>Channel 1 out-of-range error</b> 1: Indicates an out-of-range error detected on channel 1
[3]	<b>LEADOFF</b>	<b>Lead off detected</b> 1: Indicates a lead off was detected on at least one input pin
[2]	<b>BATLOW</b>	<b>Low battery</b> 1: Indicates the battery voltage has dropped below 2.7 V
[1]	<b>RLDRAIL</b>	<b>Right leg drive near rail</b> 1: Indicates the right leg drive amplifier output is approaching the supply rails
[0]	<b>CMOR</b>	<b>Common-mode level out-of-range</b> 1: Indicates the level detected by the common-mode detect block is outside of the input common-mode range of the amplifiers in the analog front-end

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

**Table 39. ERROR\_RANGE1: Channel 1 AFE Out-of-Range Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1A		SDM_OR_CH1	SIGN_CH1	OUTN_LOW_CH1	OUTN_HIGH_CH1	OUTP_LOW_CH1	OUTP_HIGH_CH1	DIF_HIGH_CH1

[7]	<b>RESERVED</b>	—
[6]	<b>SDM_OR_CH1</b>	<b>Channel 1 sigma-delta modulator over range</b> 1: Indicates an over range detected for channel 1 SDM
[5]	<b>SIGN_CH1</b>	<b>Channel 1 instrumentation amplifier output sign</b> This bit specifies the sign of the output signal of the instrumentation amplifier for channel 1. 0: Positive output of INA larger than negative output 1: Positive output of INA smaller than negative output
[4]	<b>OUTN_LOW_CH1</b>	<b>Channel 1 instrumentation amplifier negative output near negative rail</b> 1: Indicates the negative output of the INA is close to the negative rail for channel 1
[3]	<b>OUTN_HIGH_CH1</b>	<b>Channel 1 instrumentation amplifier negative output near positive rail</b> 1: Indicates the negative output of the INA is close to the positive rail for channel 1
[2]	<b>OUTP_LOW_CH1</b>	<b>Channel 1 instrumentation amplifier positive output near negative rail</b> 1: Indicates the positive output of the INA is close to the negative rail for channel 1
[1]	<b>OUTP_HIGH_CH1</b>	<b>Channel 1 instrumentation amplifier positive output near positive rail</b> 1: Indicates the positive output of the INA is close to the positive rail for channel 1
[0]	<b>DIF_HIGH_CH1</b>	<b>Channel 1 instrumentation amplifier output out-of-range</b> 1: Indicates the differential output voltage of the INA is out-of-range for channel 1

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

**Table 40. ERROR\_RANGE2: Channel 2 AFE Out-of-Range Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1B		SDM_OR_CH2	SIGN_CH2	OUTN_LOW_CH2	OUTN_HIGH_CH2	OUTP_LOW_CH2	OUTP_HIGH_CH2	DIF_HIGH_CH2

- [7] **RESERVED** —
- [6] **SDM\_OR\_CH2** **Channel 2 sigma-delta modulator over range**  
1: Indicates an over range detected for channel 2 SDM
- [5] **SIGN\_CH2** **Channel 2 instrumentation amplifier output sign**  
This bit specifies the sign of the output signal of the instrumentation amplifier for channel 2.  
0: Positive output of INA larger than negative output  
1: Positive output of INA smaller than negative output
- [4] **OUTN\_LOW\_CH2** **Channel 2 instrumentation amplifier negative output near negative rail**  
1: Indicates the negative output of the INA is close to the negative rail for channel 2
- [3] **OUTN\_HIGH\_CH2** **Channel 2 instrumentation amplifier negative output near positive rail**  
1: Indicates the negative output of the INA is close to the positive rail for channel 2
- [2] **OUTP\_LOW\_CH2** **Channel 2 instrumentation amplifier positive output near negative rail**  
1: Indicates the positive output of the INA is close to the negative rail for channel 2
- [1] **OUTP\_HIGH\_CH2** **Channel 2 instrumentation amplifier positive output near positive rail**  
1: Indicates the positive output of the INA is close to the positive rail for channel 2
- [0] **DIF\_HIGH\_CH2** **Channel 2 instrumentation amplifier output out-of-range**  
1: Indicates the differential output voltage of the INA is out-of-range for channel 2

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

**Table 41. ERROR\_RANGE3: Channel 3 AFE Out-of-Range Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1C		SDM_OR_CH3	SIGN_CH3	OUTN_LOW_CH3	OUTN_HIGH_CH3	OUTP_LOW_CH3	OUTP_HIGH_CH3	DIF_HIGH_CH3

[7]	RESERVED	—
[6]	SDM_OR_CH3	<b>Channel 3 sigma-delta modulator over range</b> 1: Indicates an over range detected for channel 3 SDM
[5]	SIGN_CH3	<b>Channel 3 instrumentation amplifier output sign</b> This bit specifies the sign of the output signal of the instrumentation amplifier for channel 3. 0: Positive output of INA larger than negative output 1: Positive output of INA smaller than negative output
[4]	OUTN_LOW_CH3	<b>Channel 3 instrumentation amplifier negative output near negative rail</b> 1: Indicates the negative output of the INA is close to the negative rail for channel 3
[3]	OUTN_HIGH_CH3	<b>Channel 3 instrumentation amplifier negative output near positive rail</b> 1: Indicates the negative output of the INA is close to the positive rail for channel 3
[2]	OUTP_LOW_CH3	<b>Channel 3 instrumentation amplifier positive output near negative rail</b> 1: Indicates the positive output of the INA is close to the negative rail for channel 3
[1]	OUTP_HIGH_CH3	<b>Channel 3 instrumentation amplifier positive output near positive rail</b> 1: Indicates the positive output of the INA is close to the positive rail for channel 3
[0]	DIF_HIGH_CH3	<b>Channel 3 instrumentation amplifier output out-of-range</b> 1: Indicates the differential output voltage of the INA is out-of-range for channel 3

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

**Table 42. ERROR\_SYNC: Synchronization Error**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1D					SYNC_PHASEERR	SYNC_CH3ERR	SYNC_CH2ERR	SYNC_CH1ERR

- [7:4] **RESERVED** —
- [3] **SYNC\_PHASEERR** **Clock timing generator phase error**  
1: Timing generator phase adjusted to comply with SYNCB signal
- [2] **SYNC\_CH3ERR** **Channel 3 synchronization error**  
1: Channel's filter timing updated to comply with synchronization source
- [1] **SYNC\_CH2ERR** **Channel 2 synchronization error**  
1: Channel's filter timing updated to comply with synchronization source
- [0] **SYNC\_CH1ERR** **Channel 1 synchronization error**  
1: Channel's filter timing updated to comply with synchronization source

**Table 43. ERROR\_MISC: Miscellaneous Error**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1E						BATLOW_STATUS	RLDRAIL_STATUS	CMOR_STATUS

- [7:3] **RESERVED** —
- [2] **BATLOW\_STATUS** **Low battery error status**  
1: Indicates the battery voltage has dropped below 2.7 V
- [1] **RLDRAIL\_STATUS** **Right leg drive near rail error status**  
1: Indicates the right leg drive amplifier output is approaching the supply rails
- [0] **CMOR\_STATUS** **Common-mode level out-of-range error status**  
1: Indicates the level detected by the common-mode detect block is outside of the input common-mode range of the amplifiers in the analog front-end

Note: The clock to digital (internal or external) must be enabled in 0x12[2] for this error register to update.

## Digital Registers

**Table 44. DIGO\_STRENGTH: Digital Output Drive Strength**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x1F								DIGO_STRENGTH

[7:2] RESERVED —

[1:0] DIGO\_STRENGTH Digital Output Drive Strength

00: Low drive mode

01: Mid-low drive mode

10: Mid-high drive mode

11: High drive mode (Default)

**Table 45. R2\_RATE: R2 Decimation Rate**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x21								R2_RATE

[7:2] RESERVED —

[1:0] R2\_RATE R2 decimation rate

0001: 4

0010: 5

0100: 6

1000: 8 (default)

Note: The register sets to its default value if none or more than one bit are enabled.

**Table 46. R3\_RATE\_CH1: R3 Decimation Rate for Channel 1**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x22								R3_RATE_CH1

[7:0] R3\_RATE\_CH1 R3 decimation rate for channel 1

00000001: 4

00000010: 6

00000100: 8

00001000: 12

00010000: 16

00100000: 32

01000000: 64

10000000: 128 (default)

Note: The register sets to its default value if none or more than one bit are enabled.

**Table 47. R3\_RATE\_CH2: R3 Decimation Rate for Channel 2**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x23								R3_RATE_CH2

[7:0] R3\_RATE\_CH2 R3 decimation rate for channel 2

00000001: 4

00000010: 6

00000100: 8

00001000: 12

00010000: 16

00100000: 32

01000000: 64

10000000: 128 (default)

Note: The register sets to its default value if none or more than one bit are enabled.



**Table 48. R3\_RATE\_CH3: R3 Decimation Rate for Channel 3**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x24	R3_RATE_CH3							

**[7:0] R3\_RATE\_CH3 R3 decimation rate for channel 3**

00000001: 4  
00000010: 6  
00000100: 8  
00001000: 12  
00010000: 16  
00100000: 32  
01000000: 64  
10000000: 128 (default)

Note: The register sets to its default value if none or more than one bit are enabled.

**Table 49. R1\_RATE: R1 Decimation Rate**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x25						R1_RATE_ CH3	R1_RATE_ CH2	R1_RATE_ CH1

**[7:3] RESERVED —**

**[2] R1\_RATE\_CH3 Pace data rate for channel 3**

0: R1 = 4: Standard PACE Data Rate (default)  
1: R1 = 2: Double PACE Data Rate

**[1] R1\_RATE\_CH2 Pace data rate for channel 2**

0: R1 = 4: Standard PACE Data Rate (default)  
1: R1 = 2: Double PACE Data Rate

**[0] R1\_RATE\_CH1 Pace data rate for channel 1**

0: R1 = 4: Standard PACE Data Rate (default)  
1: R1 = 2: Double PACE Data Rate

**Table 50. DIS\_EFILTER: ECG Filter Disable**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x26						DIS_E3	DIS_E2	DIS_E1

**[7:3] RESERVED —**

**[2] DIS\_E3 Disable the ECG filter for channel 3**

0: ECG filter enabled (default)  
1: ECG filter disabled

**[1] DIS\_E2 Disable the ECG filter for channel 2**

0: ECG filter enabled (default)  
1: ECG filter disabled

**[0] DIS\_E1 Disable the ECG filter for channel 1**

0: ECG filter enabled (default)  
1: ECG filter disabled

**Table 51. DRDYB\_SRC: Data Ready Pin Source**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x27								

DRDYB\_SRC

[7:6] RESERVED —

[6:0] DRDYB\_SRC

**Select channel to drive the DRDYB pin**

000000: DRDYB pin not asserted (default)

000001: Driven by channel 1 pace

000010: Driven by channel 2 pace

000100: Driven by channel 3 pace

001000: Driven by channel 1 ECG

010000: Driven by channel 2 ECG

100000: Driven by channel 3 ECG

**Table 52. SYNCB\_CN: SYNCB In/Out Pin Control**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x28		DIS_SYNCB OUT						

SYNCB\_SRC

[7] RESERVED —

[6] DIS\_SYNCBOUT

**Disable the SYNCB pin output driver**

0: Driver enabled and pin configured as output

1: Driver disabled and pin configured as input (default)

Note: Bit should be set to 1 for slave devices.

[5:0] SYNCB\_SRC

**Select channel to drive the SYNCB pin**

000000: No source selected (default)

000001: Driven by channel 1 pace

000010: Driven by channel 2 pace

000100: Driven by channel 3 pace

001000: Driven by channel 1 ECG

010000: Driven by channel 2 ECG

100000: Driven by channel 3 ECG

Note: Choose the slowest pace or ECG channel as source. Bits[5:0] must be cleared to 0 for slave devices.

**Table 53. MASK\_DRDYB: Optional Mask Control for DRDYB Output**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x29							DRDYB MASK_CTL1	DRDYB MASK_CTL0

[7:2] RESERVED —

[1] DRDYBMASK\_CTL1

**START\_CON mask control for DRDYB output**

0: DRDYB signal is masked when START\_CON is set (default)

1: Disable initial DRDYB masking when START\_CON is set

[0] DRDYBMASK\_CTL0

**Optional mask control for DRDYB output**

0: DRDYB signal is masked after out of sync is detected (default)

1: Disable DRDYB masking after out of sync is detected

Note: If an ECG channel is enabled, DRDYB is masked during 6 ECG output data periods.

If all ECG channels are disabled, DRDYB is masked during 6 or 11 pace output data periods, for 1x pace or 2x pace mode respectively.

**Table 54. MASK\_ERR: Mask Error on ALARMB Pin**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x2A	MASK_SYNC EDGEERR	MASK_ CH3ERR	MASK_ CH2ERR	MASK_ CH1ERR	MASK_ OUTLOD	MASK_ BATLOW	MASK_ RLDRAIL	MASK_ CMOR

- [7] **MASK\_SYNCEDGEERR** **Mask alarm condition when SYNCEDGEERR=1**  
0: Alarm condition is active (default)  
1: Alarm condition is masked
- [6] **MASK\_CH3ERR** **Mask alarm condition for CH3ERR=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [5] **MASK\_CH2ERR** **Mask alarm condition for CH2ERR=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [4] **MASK\_CH1ERR** **Mask alarm condition for CH1ERR=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [3] **MASK\_LEADOFF** **Mask alarm condition for LEADOFF=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [2] **MASK\_BATLOW** **Mask alarm condition for BATLOW=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [1] **MASK\_RLDRAIL** **Mask alarm condition for RLDRAIL=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked
- [0] **MASK\_CMOR** **Mask alarm condition for CMOR=1**  
0: Alarm condition active (default)  
1: Alarm condition is masked

**Table 55. ALARM\_FILTER: Digital Filter for Analog Alarm Signals**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x2E	AFILTER_OTHER				AFILTER_LOD			

- [7:4] **AFILTER\_OTHER** **Filter for all other alarms count**  
Number of consecutive analog alarm signal counts+1 before ALARMB is asserted.  
0011: (default)
- [3:0] **AFILTER\_LOD** **Filter for OUT\_LOD[5:0] alarm count**  
Number of consecutive lead off alarm signal counts+1 before ALARMB is asserted.  
0011: (default)

**Table 56. CH\_CNFG: Configure Channel for Loop Read Back Mode**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x2F		E3_EN	E2_EN	E1_EN	P3_EN	P2_EN	P1_EN	STS_EN

[7]	RESERVED	—
[6]	E3_EN	<b>Enable DATA_CH3_ECG read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[5]	E2_EN	<b>Enable DATA_CH2_ECG read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[4]	E1_EN	<b>Enable DATA_CH1_ECG read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[3]	P3_EN	<b>Enable DATA_CH3_PACE read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[2]	P2_EN	<b>Enable DATA_CH2_PACE read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[1]	P1_EN	<b>Enable DATA_CH1_PACE read back</b> 0: Disable data read back for this channel (default) 1: Enable data read back for this channel
[0]	STS_EN	<b>Enable DATA_STATUS read back</b> 0: Disable data status read back (default) 1: Enable data status read back

## Pace and ECG Data Read Back Registers

**Table 57. DATA\_STATUS: ECG and Pace Data Ready Status**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x30	E3_DRDY	E2_DRDY	E1_DRDY	P3_DRDY	P2_DRDY	P1_DRDY	ALARMB	0

[7]	E3_DRDY	<b>Channel 3 ECG data ready</b> 1: Channel 3 ECG data ready
[6]	E2_DRDY	<b>Channel 2 ECG data ready</b> 1: Channel 2 ECG data ready
[5]	E1_DRDY	<b>Channel 1 ECG data ready</b> 1: Channel 1 ECG data ready
[4]	P3_DRDY	<b>Channel 3 pace data ready</b> 1: Channel 3 pace data ready
[3]	P2_DRDY	<b>Channel 2 pace data ready</b> 1: Channel 2 pace data ready
[2]	P1_DRDY	<b>Channel 1 pace data ready</b> 1: Channel 1 pace data ready
[1]	ALARMB	<b>ALARMB status</b> 1: Alarm active (ALARMB output pin driven low)
[0]	Reserved	— 0

**Table 58. DATA\_CH1\_PACE: Channel 1 Pace Data**

Addr	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x31	DATA_CH1_PACE							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x32	DATA_CH1_PACE							

- [15:8] **DATA\_CH1\_PACE** **Channel 1 pace data**  
Address 0x31 contains the upper byte
- [7:0] **DATA\_CH1\_PACE** **Channel 1 pace data**  
Address 0x32 contains the lower byte

**Table 59. DATA\_CH2\_PACE: Channel 2 Pace Data**

Addr	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x33	DATA_CH2_PACE							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x34	DATA_CH2_PACE							

- [15:8] **DATA\_CH2\_PACE** **Channel 2 pace data**  
Address 0x33 contains the upper byte
- [7:0] **DATA\_CH2\_PACE** **Channel 2 pace data**  
Address 0x34 contains the lower byte

**Table 60. DATA\_CH3\_PACE: Channel 3 Pace Data**

Addr	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x35	DATA_CH3_PACE							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x36	DATA_CH3_PACE							

- [15:8] **DATA\_CH3\_PACE** **Channel 3 pace data**  
Address 0x35 contains the upper byte
- [7:0] **DATA\_CH3\_PACE** **Channel 3 pace data**  
Address 0x36 contains the lower byte

**Table 61. DATA\_CH1\_ECG: Channel 1 ECG Data**

Addr	BIT23	BIT22	BIT21	BIT20	BIT19	BIT18	BIT7	BIT6
0x37	DATA_CH1_ECG							
	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x38	DATA_CH1_ECG							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x39	DATA_CH1_ECG							

- [23:16] **DATA\_CH1\_ECG** **Channel 1 ECG data**  
Address 0x37 contains the upper byte
- [15:8] **DATA\_CH1\_ECG** **Channel 1 ECG data**  
Address 0x38 contains the middle byte
- [7:0] **DATA\_CH1\_ECG** **Channel 1 ECG data**  
Address 0x39 contains the lower byte

**Table 62. DATA\_CH2\_ECG: Channel 2 ECG Data**

Addr	BIT23	BIT22	BIT21	BIT20	BIT19	BIT18	BIT7	BIT6
0x3A	DATA_CH2_ECG							
	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x3B	DATA_CH2_ECG							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x3C	DATA_CH2_ECG							

- [23:16] **DATA\_CH2\_ECG**      **Channel 2 ECG data**  
Address 0x3A contains the upper byte
- [15:8] **DATA\_CH2\_ECG**      **Channel 2 ECG data**  
Address 0x3B contains the middle byte
- [7:0] **DATA\_CH2\_ECG**      **Channel 2 ECG data**  
Address 0x3C contains the lower byte

**Table 63. DATA\_CH3\_ECG: Channel 3 ECG Data**

Addr	BIT23	BIT22	BIT21	BIT20	BIT19	BIT18	BIT7	BIT6
0x3D	DATA_CH3_ECG							
	BIT15	BIT14	BIT13	BIT12	BIT11	BIT10	BIT9	BIT8
0x3E	DATA_CH3_ECG							
	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x3F	DATA_CH3_ECG							

- [23:16] **DATA\_CH3\_ECG**      **Channel 3 ECG data**  
Address 0x3D contains the upper byte
- [15:8] **DATA\_CH3\_ECG**      **Channel 3 ECG data**  
Address 0x3E contains the middle byte
- [7:0] **DATA\_CH3\_ECG**      **Channel 3 ECG data**  
Address 0x3F contains the lower byte

**Table 64. REVID: Revision ID**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x40	REVID							

- [7:0] **REVID**      **Revision ID**  
00000001 (Default)

**Table 65. DATA\_LOOP: Loop Read Back Address**

Addr	BIT7	BIT6	BIT5	BIT4	BIT3	BIT2	BIT1	BIT0
0x50	PE_LPRD							

- [7:0] **PE\_LPRD**      **Loop read back address**  
Special address to read back the contents of registers 0x30 - 0x3F if they are enabled in CH\_CNFG.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
ADS1293CISQ/NOPB	ACTIVE	WQFN	RSG	28	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-20 to 85	ADS1293	<a href="#">Samples</a>
ADS1293CISQE/NOPB	ACTIVE	WQFN	RSG	28	250	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-20 to 85	ADS1293	<a href="#">Samples</a>
ADS1293CISQX/NOPB	ACTIVE	WQFN	RSG	28	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-20 to 85	ADS1293	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

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**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS1293CISQ/NOPB	WQFN	RSG	28	1000	178.0	12.4	5.3	5.3	1.3	8.0	12.0	Q1



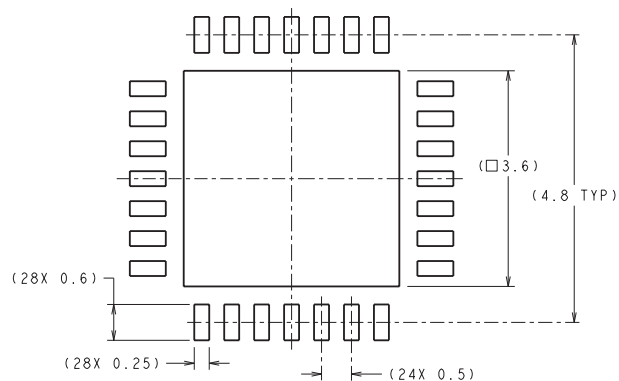
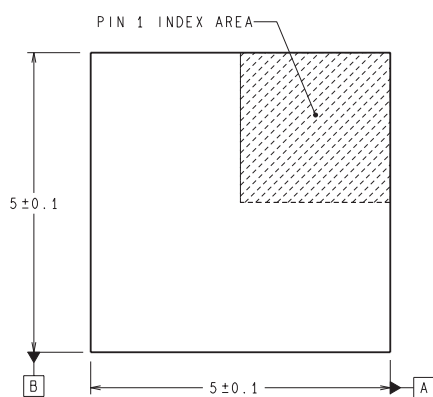
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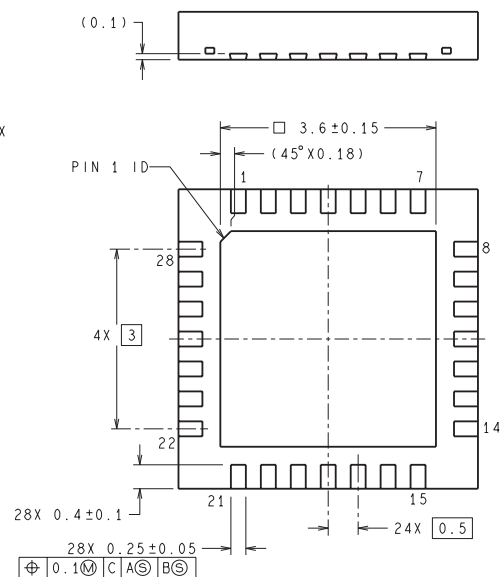
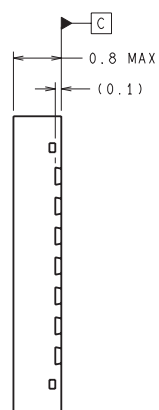
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ADS1293CISQ/NOPB	WQFN	RSG	28	1000	203.0	190.0	41.0

RSG0028A

**RECOMMENDED LAND PATTERN**

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SQA28A (Rev B)

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